Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp. Customer Support Dept. April 1, 2003



Description

The M30220 group of single-chip microcomputers are built using the high-performance silicon gate CMOS process using a M16C/60 Series CPU core. The M30220 group has LCD controller/driver. M30220 group is packaged in a 144-pin plastic molded QFP. These single-chip microcomputers operate using sophisticated instructions featuring a high level of instruction efficiency. With 1M bytes of address space, they are capable of executing instructions at high speed.

Features

Basic machine instructions	Compatible with the M16C/60 series
Memory capacity	See figure memory expansion
Shortest instruction execution time	
Supply voltage	
11 7 3	2.7V to 5.5V (f(XIN)=7MHz with software one-wait)
Interrupts	26 internal and 8 external interrupt sources, 4 software, 7 levels
·	(including key input interrupt)
Multifunction 16-bit timer	Timer A (output) x 8, timer B (input) x 6
Real time port outputs	8 bits X 4 lines
Serial I/O	3 channel for UART or clock synchronous
• DMAC	2 channels (trigger: 26 sources)
A-D converter	10 bits X 8 channels
D-A converter	8 bits X 3 channels
Watchdog timer	1 line
Programmable I/O	104 lines (32 lines are shared with LCD outputs)
Output port	16 lines (shared with LCD outputs)
• Input port	1 line (P77, shared with NMI pin)
LCD drive control circuit	1/2, 1/3 bias
	2, 3 and 4 time sharing
	4 common outputs
	48 segment outputs
	built-in Charge-pump
Key input interrupt	20 lines
Clock generating circuit	2 built-in clock generation circuits
	(built-in feedback resistor, and external ceramic or quartz oscillator)

Applications

Camera, Home appliances, Portable equipment, Drop meter, Audio, Office equipment, etc.

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Interrupt 30	D-A Converter	140
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Pin Configuration

Figure 1.1.1 shows the pin configurations (top view).

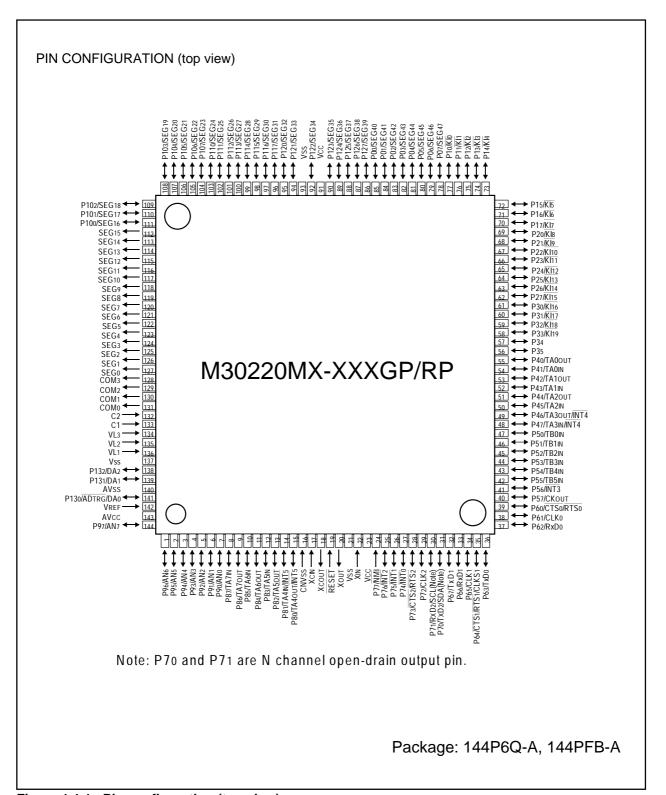


Figure 1.1.1. Pin configuration (top view)



Block Diagram

Figure 1.1.2 is a block diagram of the M30220 group.

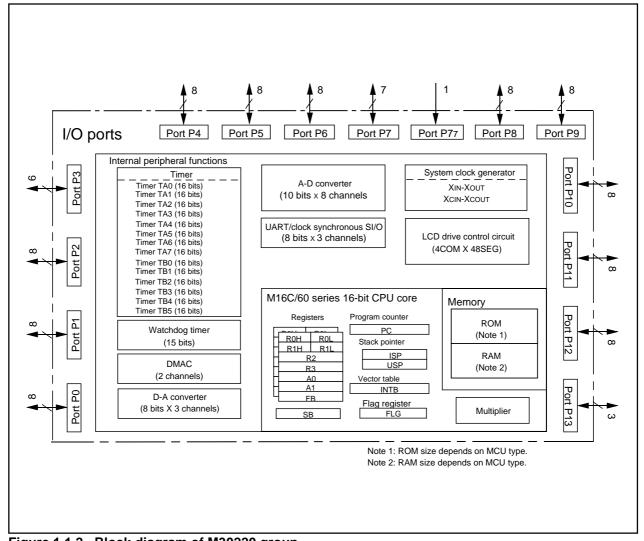


Figure 1.1.2. Block diagram of M30220 group

Performance Outline

Table 1.1.1 is performance outline of M30220 group.

Table 1.1.1. Performance outline of M30220 group

	Item		Performance		
Number of b	asic instructions	3	91 instructions		
Shortest inst	truction execution	on time	100ns (f(XIN)=10MHz		
Memory	ROM		96 Kbytes		
capacity	RAM		6 Kbytes		
I/O port	P0 to P13 (e	xcept P77)	8 bits x 11, 3 bits x 1, 6 bits x 1, 7 bits x 1		
Input port	P77		1 bit x 1		
Output port	SEG ₀ to SEC	3 15	2 bits x 8		
Multifunction	TA0 to TA7		16 bits x 8		
timer	TB0 to TB5		16 bits x 6		
Real time po	ort outputs		8 bits x 4 lines		
Serial I/O	UART0 to UA	ART2	(UART or clock synchronous) x 3		
A-D converte	er		10 bits x 8 channels		
D-A converte	er		8 bits x 3 channels		
DMAC			2 channel(trigger:26 sources)		
LCD	COM ₀ to CO	Мз	4 lines		
	SEG ₀ to SE ₀	G47	48 lines (32 lines are shared with I/O ports)		
Watchdog tir	mer		15 bits x 1 (with prescaler)		
Interrupt			26 internal and 8 external sources, 4 software sources		
Clock genera	ating circuit		2 built-in clock generation circuits		
			(built-in feedback resistor, and external ceramic or		
			quartz oscillator)		
Supply volta	ge		4.0V to 5.5V (f(XIN)=10MHz)		
			2.7V to 5.5V (f(XIN)=7MHz with software one-wait)		
Power consu	umption		18mW (Vcc=3V, f(XIN)=7MHz with software one-wait)		
I/O char-	I/O withstand vo	oltage (P0 to P13)	5 V		
acteristics	Output current	P1 to P9,P13	5 mA		
		P0, P10 to P12	0.1mA("H" output), 2.5mA("L" output)		
Device confi	guration		CMOS high-performance silicon gate		
Package			144-pin plastic mold QFP		



Mitsubishi plans to release the following products in the M30220 group:

- (1) Support for mask ROM version, flash memory version
- (2) ROM capacity
- (3) Package

144P6Q-A : Plastic molded QFP (mask ROM and flash memory versions)

144PFB-A : Plastic molded QFP(mask ROM and flash memory versions)

Figure 1.1.3 shows the ROM expansion and figure 1.1.4 shows the Type No., memory size, and package.

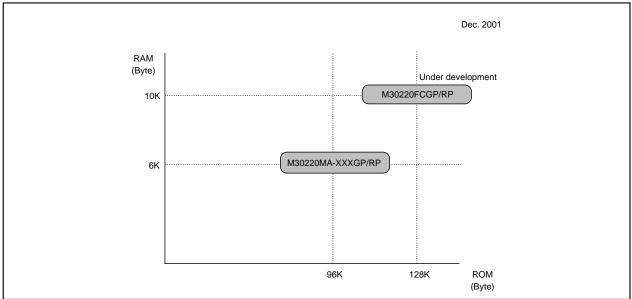


Figure 1.1.3. Memory expansion

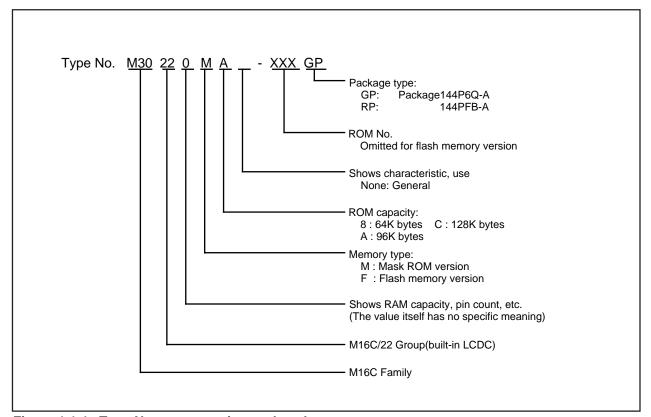


Figure 1.1.4. Type No., memory size, and package



Pin Description

Pin name	Signal name	I/O	Function
Vcc, Vss	Power supply input		Supply 2.7 to 5.5 V to the VCC pin. Supply 0 V to the Vss pin.
CNVss	CNVss	I	Connect it to the Vss pin via resistor.
RESET	Reset input	I	A "L" on this input resets the microcomputer.
XIN XOUT	Clock input Clock output	0	These pins are provided for the main clock generating circuit. Connect a ceramic resonator or crystal between the XIN and the XOUT pins. To use an externally derived clock, input it to the XIN pin and leave the XOUT pin open.
XCIN XCOUT	Clock input Clock output	0	These pins are provided for the sub clock generating circuit. Connect a ceramic resonator or crystal between the XCIN and the XCOUT pins. To use an externally derived clock, input it to the XCIN pin and leave the XCOUT pin open.
AVcc	Analog power supply input		This pin is a power supply input for the A-D converter. Connect it to Vcc.
AVss	Analog power supply input		This pin is a power supply input for the A-D converter. Connect it to Vss.
VREF	Reference voltage input	I	This pin is a reference voltage input for the A-D converter.
P00 to P07	I/O port P0	I/O	This is an 8-bit CMOS I/O port. It has an input/output port direction register that allows the user to set each pin for input or output individually. When set for input, the user can specify in units of four bits via software whether or not they are tied to a pull-up resistor. Pins in this port also use as LCD segment output and real time port output.
P10 to P17	I/O port P1	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as input pins for the key input interrupt function and real time port output.
P20 to P27	I/O port P2	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as input pins for the key input interrupt function and real time port output.
P30 to P35	I/O port P3	I/O	This is a 6-bit I/O port equivalent to P0. P30 to P33 also function as input pins for the key input interrupt function.
P40 to P47	I/O port P4	I/O	This is a 8-bit I/O port equivalent to Po. Pins in this port also function as timer A0 to A3 I/O pins, INT4 input pin as selected by software.
P50 to P57	I/O port P5	I/O	This is a 8-bit I/O port equivalent to P0. Pins in this port also function as timer B0 to B5 and INT3 input pins, CKout output pin as selected by software.
P60 to P67	I/O port P6	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as UART0 and UART1 I/O pins as selected by software.



Pin Description

Pin name	Signal name	I/O	Function
P70 to P76	I/O port P7	I/O	P70 to P76 are I/O ports equivalent to P0 (P70 and P71 are N channel open-drain output). Pins in this port also function as UART2 I/O pin, INT0 to INT2 input pins as selected by software. P77 is an input-only port that also functions for NMI.
P80 to P87	I/O port P8	I/O	This is a 8-bit I/O port equivalent to PO. Pins in this port also function as timer A4 to A7 I/O pins, INTs input pin as selected by software.
P90 to P97	I/O port P9	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as A-D converter analog input pins as selected by software.
P100 to P107	I/O port P10	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as SEG output for LCD as selected by software.
P110 to P117	I/O port P11	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as SEG output for LCD as selected by software.
P120 to P127	I/O port P12	I/O	This is an 8-bit I/O port equivalent to P0. Pins in this port also function as SEG output for LCD and real time port output.
P130 to P132	I/O port P13	I/O	This is an 3-bit I/O port equivalent to P0. Pins in this port also function as D-A converter analog output pins or start trigger for A-D input pins.
SEG0 to SEG15	Segment output	0	Pins in this port function as SEG output for LCD drive circuit.
COM ₀ to	Common output	0	Pins in this port function as common output for LCD drive circuit.
VL1 to VL3	Power supply input for LCD		Power supply input for LCD drive circuit.
C1, C2	Step-up condenser connect port		Pins in this port function as external pin for LCD step-up condenser. Connect a condenser between C1 and C2.



Operation of Functional Blocks

The M30220 group accommodates certain units in a single chip. These units include ROM and RAM to store instructions and data and the central processing unit (CPU) to execute arithmetic/logic operations. Also included are peripheral units such as timers, real time port, serial I/O, LCD drive control circuit, D-A converter, A-D converter, DMAC and I/O ports.

The following explains each unit.

Memory

Figure 1.4.1 is a memory map of the M30220 group. The address space extends the 1M bytes from address 0000016 to FFFFF16. From FFFFF16 down is ROM. For example, in the M30220MA-XXXGP, there is 96K bytes of internal ROM from E800016 to FFFFF16. The vector table for fixed interrupts such as the reset and $\overline{\text{NMI}}$ are mapped to FFFDC16 to FFFFF16. The starting address of the interrupt routine is stored here. The address of the vector table for timer interrupts, etc., can be set as desired using the internal register (INTB). See the section on interrupts for details.

From 0040016 up is RAM. For example, in the M30220MA-XXXGP, 6K bytes of internal RAM is mapped to the space from 0040016 to 01BFF16. In addition to storing data, the RAM also stores the stack used when calling subroutines and when interrupts are generated.

The SFR area is mapped to 0000016 to 003FF16. This area accommodates the control registers for peripheral devices such as I/O ports, A-D converter, serial I/O, timers, and LCD, etc. Figures 1.7.1 to 1.7.3 are location of peripheral unit control registers. Any part of the SFR area that is not occupied is reserved and cannot be used for other purposes.

The special page vector table is mapped to FFE0016 to FFFDB16. If the starting addresses of subroutines or the destination addresses of jumps are stored here, subroutine call instructions and jump instructions can be used as 2-byte instructions, reducing the number of program steps.

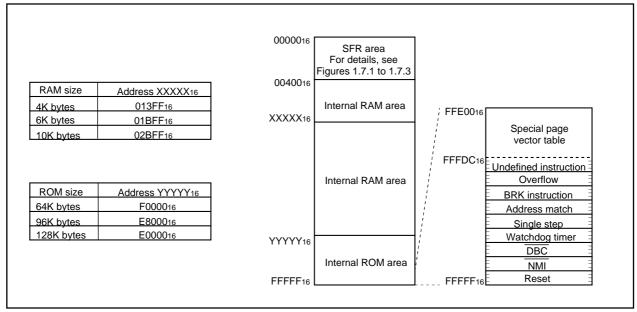


Figure 1.4.1. Memory map



Central Processing Unit (CPU)

The CPU has a total of 13 registers shown in Figure 1.5.1. Seven of these registers (R0, R1, R2, R3, A0, A1, and FB) come in two sets; therefore, these have two register banks.

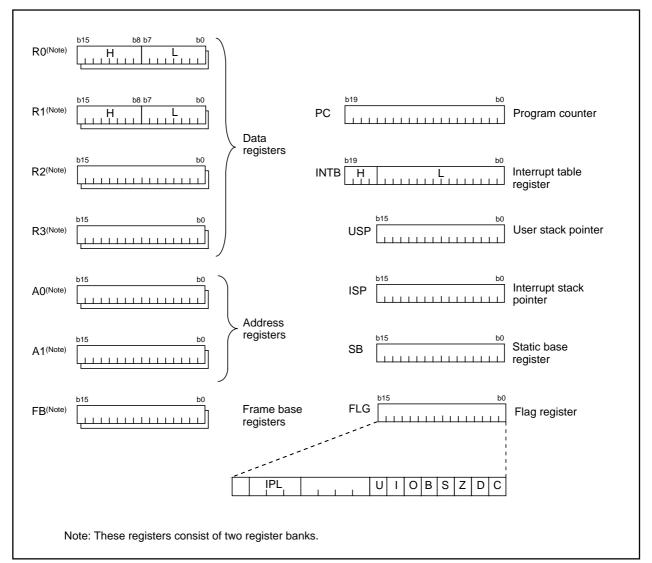


Figure 1.5.1. Central processing unit register

(1) Data registers (R0, R0H, R0L, R1, R1H, R1L, R2, and R3)

Data registers (R0, R1, R2, and R3) are configured with 16 bits, and are used primarily for transfer and arithmetic/logic operations.

Registers R0 and R1 each can be used as separate 8-bit data registers, high-order bits as (R0H/R1H), and low-order bits as (R0L/R1L). In some instructions, registers R2 and R0, as well as R3 and R1 can use as 32-bit data registers (R2R0/R3R1).

(2) Address registers (A0 and A1)

Address registers (A0 and A1) are configured with 16 bits, and have functions equivalent to those of data registers. These registers can also be used for address register indirect addressing and address register relative addressing.

In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).



(3) Frame base register (FB)

Frame base register (FB) is configured with 16 bits, and is used for FB relative addressing.

(4) Program counter (PC)

Program counter (PC) is configured with 20 bits, indicating the address of an instruction to be executed.

(5) Interrupt table register (INTB)

Interrupt table register (INTB) is configured with 20 bits, indicating the start address of an interrupt vector table.

(6) Stack pointer (USP/ISP)

Stack pointer comes in two types: user stack pointer (USP) and interrupt stack pointer (ISP), each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by a stack pointer select flag (U flag). This flag is located at the position of bit 7 in the flag register (FLG).

(7) Static base register (SB)

Static base register (SB) is configured with 16 bits, and is used for SB relative addressing.

(8) Flag register (FLG)

Flag register (FLG) is configured with 11 bits, each bit is used as a flag. Figure 1.5.2 shows the flag register (FLG). The following explains the function of each flag:

• Bit 0: Carry flag (C flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

• Bit 1: Debug flag (D flag)

This flag enables a single-step interrupt.

When this flag is "1", a single-step interrupt is generated after instruction execution. This flag is cleared to "0" when the interrupt is acknowledged.

• Bit 2: Zero flag (Z flag)

This flag is set to "1" when an arithmetic operation resulted in 0; otherwise, cleared to "0".

• Bit 3: Sign flag (S flag)

This flag is set to "1" when an arithmetic operation resulted in a negative value; otherwise, cleared to "0".

Bit 4: Register bank select flag (B flag)

This flag chooses a register bank. Register bank 0 is selected when this flag is "0"; register bank 1 is selected when this flag is "1".

• Bit 5: Overflow flag (O flag)

This flag is set to "1" when an arithmetic operation resulted in overflow; otherwise, cleared to "0".

• Bit 6: Interrupt enable flag (I flag)

This flag enables a maskable interrupt.

An interrupt is disabled when this flag is "0", and is enabled when this flag is "1". This flag is cleared to "0" when the interrupt is acknowledged.



• Bit 7: Stack pointer select flag (U flag)

Interrupt stack pointer (ISP) is selected when this flag is "0"; user stack pointer (USP) is selected when this flag is "1".

This flag is cleared to "0" when a hardware interrupt is acknowledged or an INT instruction of software interrupt Nos. 0 to 31 is executed.

• Bits 8 to 11: Reserved area

• Bits 12 to 14: Processor interrupt priority level (IPL)

Processor interrupt priority level (IPL) is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than the processor interrupt priority level (IPL), the interrupt is enabled.

• Bit 15: Reserved area

The C, Z, S, and O flags are changed when instructions are executed. See the software manual for details.

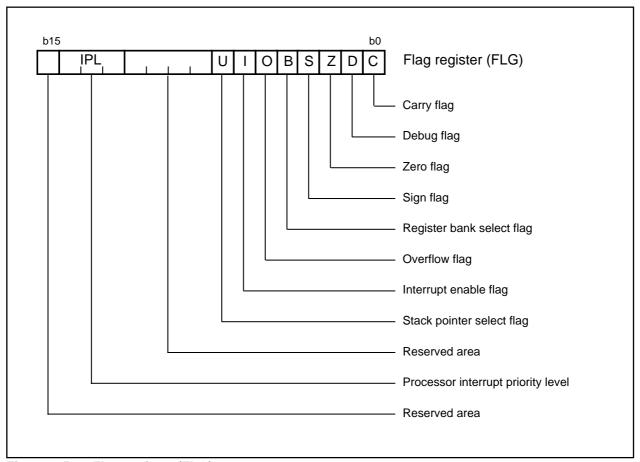


Figure 1.5.2. Flag register (FLG)

Reset

There are two kinds of resets; hardware and software. In both cases, operation is the same after the reset. (See "Software Reset" for details of software resets.) This section explains on hardware resets.

When the supply voltage is in the range where operation is guaranteed, a reset is effected by holding the reset pin level "L" (0.2Vcc max.) for at least 20 cycles. When the reset pin level is then returned to the "H" level while main clock is stable, the reset status is cancelled and program execution resumes from the address in the reset vector table.

Figure 1.6.1 shows the example reset circuit. Figure 1.6.2 shows the reset sequence.

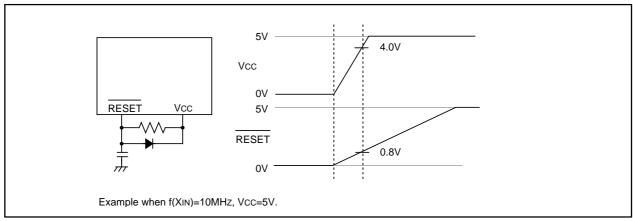


Figure 1.6.1. Example reset circuit

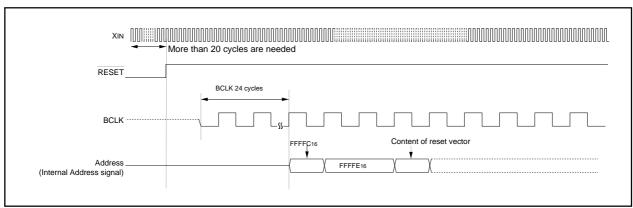


Figure 1.6.2. Reset sequence

Table 1.6.1 shows the statuses of the other pins while the RESET pin level is "L". Figures 1.6.3 and 1.6.4 show the internal status of the microcomputer immediately after the reset is cancelled.

Table 1.6.1. Pin status when RESET pin level is "L"

Pin name	Status
P0, P10 to P12	Input port(with a pull up resistor)
P1 to P9, P13	Input port (floating)
SEG0 to SEG15	"H" level is output
COM ₀ to COM ₃	"H" level is output



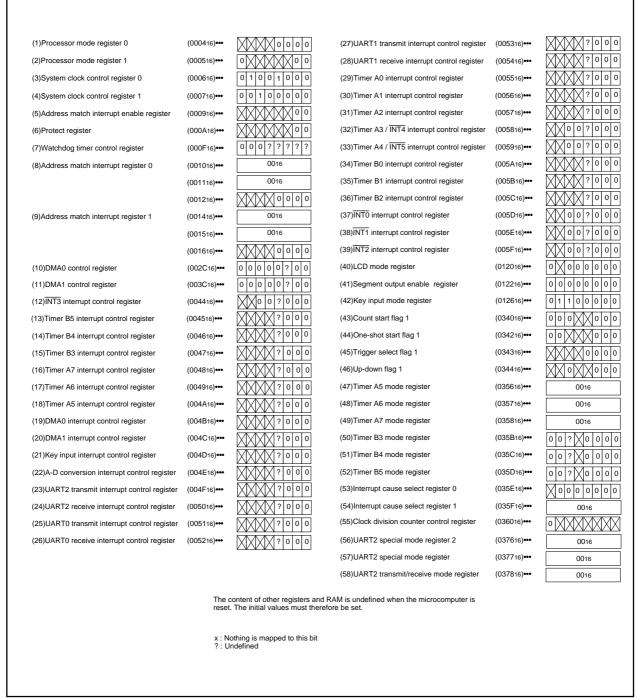


Figure 1.6.3. Device's internal status after a reset is cleared

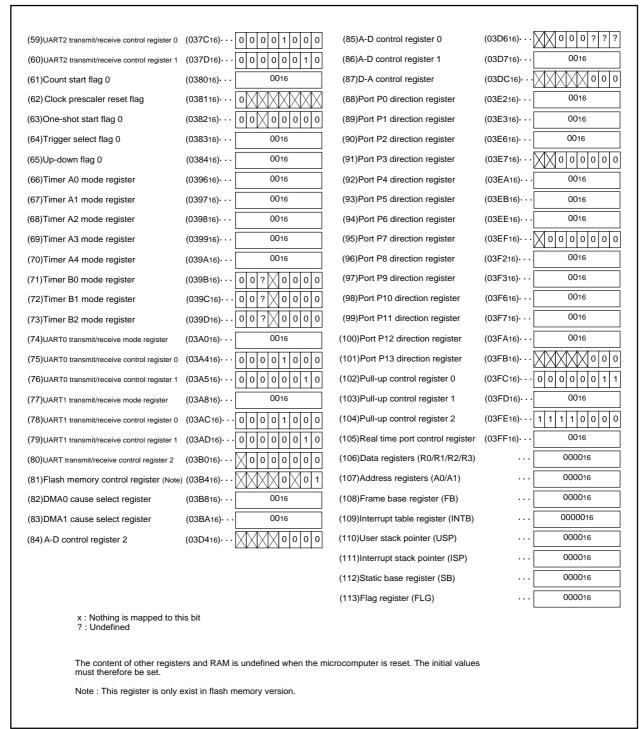


Figure 1.6.4. Device's internal status after a reset is cleared

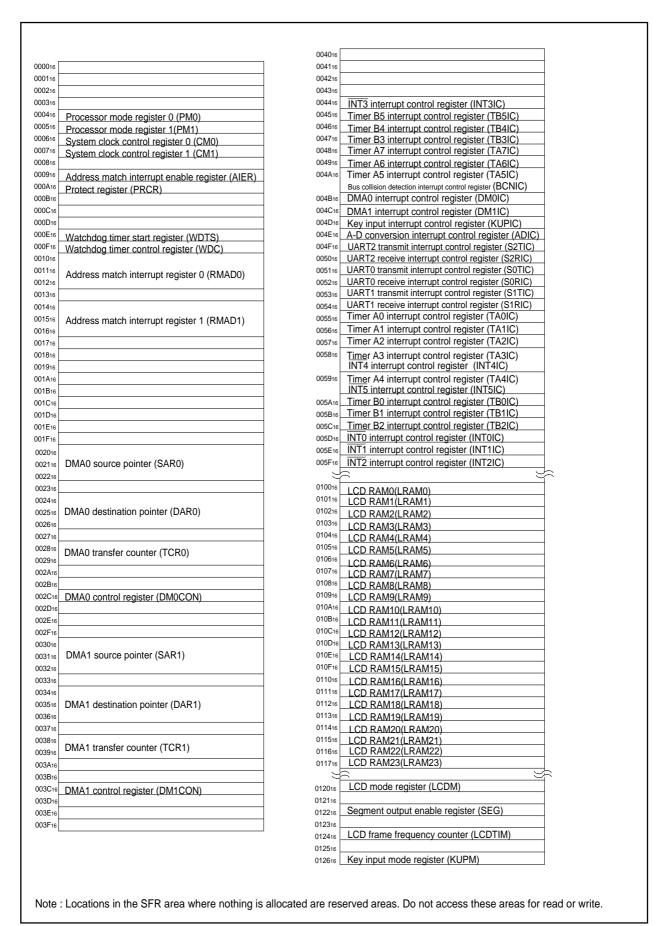


Figure 1.7.1. Location of peripheral unit control registers (1)



240 [0 ((((((((((((((((((([Count start (In a O (TARCRO)
34016	Count start flag 1 (TABSR1)	038016	Count start flag 0 (TABSR0)
34116		038116	Clock prescaler reset flag (CPSRF)
34216	One-shot start flag 1 (ONSF1)	038216	One-shot start flag 0 (ONSF0)
34316	Trigger select register 1 (TRGSR1)	038316	Trigger select register 0 (TRGSR0)
34416	Up-down flag 1(UDF1)	038416	Up-down flag 0 (UDF0)
34516	• • • • • • • • • • • • • • • • • • • •	038516	
34616	Times AF as sister (TAF)	038616	T: 40 : (TAO)
34716	Timer A5 register (TA5)	038716	Timer A0 register (TA0)
34816		038816	
34916	Timer A6 register (TA6)		Timer A1 register (TA1)
- +		038916	
34A16	Timer A7 register (TA7)	038A16	Timer A2 register (TA2)
34B16		038B ₁₆	
34C16		038C ₁₆	Timer A3 register (TA3)
34D16		038D16	e. 7.6 regions (17.6)
34E16		038E ₁₆	Timer A4 register (TA4)
34F16		038F16	Timer A4 register (TA4)
35016	Timor P2 register (TP2)	039016	
35116	Timer B3 register (TB3)	039116	Timer B0 register (TB0)
35216			
35316	Timer B4 register (TB4)	039216	Timer B1 register (TB1)
+		039316	
35416	Timer B5 register (TB5)	039416	Timer B2 register (TB2)
35516	, ,	039516	·····•· · · · · · · · · · · · · · · ·
35616	Timer A5 mode register (TA5MR)	039616	Timer A0 mode register (TA0MR)
35716	Timer A6 mode register (TA6MR)	039716	Timer A1 mode register (TA1MR)
35816	Timer A7 mode register (TA7MR)	039816	Timer A2 mode register (TA2MR)
35916	Time 7 tr Thodo Toglotor (17 tr Wirt)	039916	Timer A3 mode register (TA3MR)
35A16		039A ₁₆	Timer A4 mode register (TA4MR)
35B ₁₆	Timer B3 mode register (TB3MR)	039B ₁₆	Timer B0 mode register (TB0MR)
H			
35C16	Timer B4 mode register (TB4MR)	039C ₁₆	Timer B1 mode register (TB1MR)
35D16	Timer B5 mode register(TB5MR)	039D ₁₆	Timer B2 mode register (TB2MR)
35E16	Interrupt cause select register 0 (IFSR0)	039E ₁₆	
35F16	Interrupt cause select register 1 (IFSR1)	039F16	
36016	Clock division counter control register (CDCC)	03A016	UART0 transmit/receive mode register (U0MF
36116		03A1 ₁₆	UART0 bit rate generator (U0BRG)
36216		03A2 ₁₆	<u> </u>
36316		03A316	UART0 transmit buffer register (U0TB)
36416		Г	UART0 transmit/receive control register 0 (U0
36516		03A416	· · · · · · · · · · · · · · · · · · ·
H		03A516	UART0 transmit/receive control register 1 (U0
36616		03A616	UART0 receive buffer register (U0RB)
36716		03A7 ₁₆	
36816		03A816	UART1 transmit/receive mode register (U1MR
36916		03A916	UART1 bit rate generator (U1BRG)
36A16		03AA ₁₆	UART1 transmit buffer register (U1TB)
36B ₁₆		03AB ₁₆	OAKT Fuanomic bullet register (UTTB)
36C ₁₆		03AC16	UART1 transmit/receive control register 0 (U1
36D ₁₆		03AD16	UART1 transmit/receive control register 1 (U1
36E16	Clock division counter (CDC)	F	Cract i danomici eceive contion register 1 (01
- 1	Clock division counter (CDC)	03AE ₁₆	UART1 receive buffer register (U1RB)
36F16		03AF ₁₆	
37016		03B016	UART transmit/receive control register 2 (UCC
37116		03B1 ₁₆	
37216		03B216	
37316		03B3 ₁₆	
37416		03B4 ₁₆	Flash memory control register (FMCR)(Not
37516		03B516	,
37616	UART2 special mode register 2(U2SMR2)		
	UART2 special mode register (U2SMR)	03B616	
37716	,	03B7 ₁₆	D1440
37816	UART2 transmit/receive mode register (U2MR)	03B816	DMA0 request cause select register (DM05
37916	UART2 bit rate generator (U2BRG)	03B916	
37A16	UART2 transmit buffer register (U2TB)	03BA ₁₆	DMA1 request cause select register (DM15
	OANTE ITALISHIII DUITET TEGISTET (UZTE)	03BB ₁₆	,
37B16		002210	
- +	UART2 transmit/receive control register 0 (U2C0)	U3BC4e	
37C16	UART2 transmit/receive control register 0 (U2C0)	03BC16	
- +	UART2 transmit/receive control register 0 (U2C0) UART2 transmit/receive control register 1 (U2C1) UART2 receive buffer register (U2RB)	03BC16 03BD16 03BE16	

Figure 1.7.2. Location of peripheral unit control registers (2)



Note 1: This register is only exist in flash memory version.

Note 2: Locations in the SFR area where nothing is allocated are reserved areas. Do not access these areas for read or write.

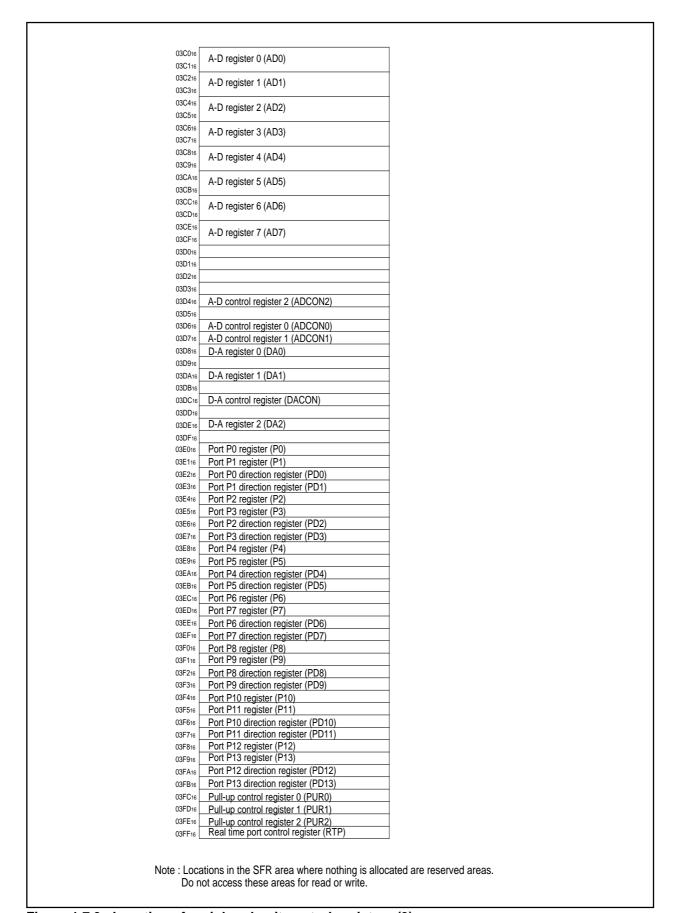


Figure 1.7.3. Location of peripheral unit control registers (3)



Software Reset

Writing "1" to bit 3 of the processor mode register 0 (address 000416) applies a (software) reset to the microcomputer. A software reset has the same effect as a hardware reset. The contents of internal RAM are preserved.

Figure 1.8.1 shows the processor mode register 0 and 1.

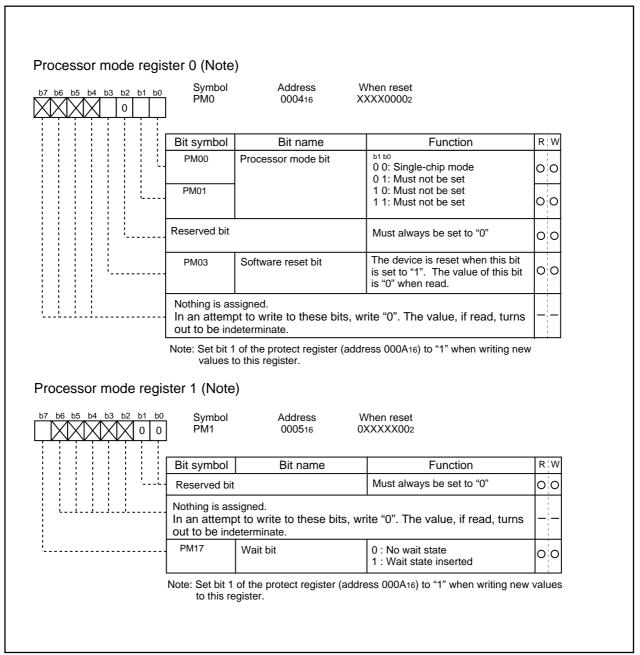


Figure 1.8.1. Processor mode register 0 and 1



Software wait

A software wait can be inserted by setting the wait bit (bit 7) of the processor mode register 1 (address 000516). (Note)

A software wait is inserted in the internal ROM/RAM area. When set to "0", each bus cycle is executed in one BCLK cycle. When set to "1", each bus cycle is executed in two BCLK cycles. After the microcomputer has been reset, this bit defaults to "0". Set this bit after referring to the recommended operating conditions (main clock input oscillation frequency) of the electric characteristics.

The SFR area is always accessed in two BCLK cycles regardless of the setting of this control bit.

Table 1.8.1 shows the software waits and bus cycles.

Note: Before attempting to change the contents of the processor mode register 1, set bit 1 of the protect register (address 000A₁₆) to "1".

Table 1.8.1. Software waits and bus cycles

Area	Wait bit	Bus cycle
SFR	Invalid	2 BCLK cycles
Internal	0	1 BCLK cycle
ROM/RAM	1	2 BCLK cycles

Clock Generating Circuit

The clock generating circuit contains two oscillator circuits that supply the operating clock sources to the CPU and internal peripheral units.

Table 1.9.1. Main clock and sub-clock generating circuits

	Main clock generating circuit	Sub-clock generating circuit
Use of clock	CPU's operating clock source	CPU's operating clock source
	Internal peripheral units'	Timer A/B's count clock
	operating clock source	source
		Intermittent pullup operation
		clock source of key input
		LCD operation clock source
Usable oscillator	Ceramic or crystal oscillator	Crystal oscillator
Pins to connect oscillator	XIN, XOUT	XCIN, XCOUT
Oscillation stop/restart function	Available	Available
Oscillator status immediately after reset	Oscillating	Stopped
Other	Externally derived clock can be inp	out

Example of oscillator circuit

Figure 1.9.1 shows some examples of the main clock circuit, one using an oscillator connected to the circuit, and the other one using an externally derived clock for input. Figure 1.9.2 shows some examples of sub-clock circuits, one using an oscillator connected to the circuit, and the other one using an externally derived clock for input. Circuit constants in Figures 1.9.1 and 1.9.2 vary with each oscillator used. Use the values recommended by the manufacturer of your oscillator.

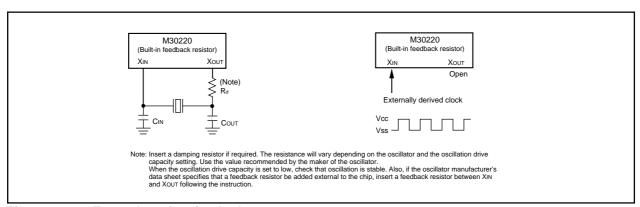


Figure 1.9.1. Examples of main clock

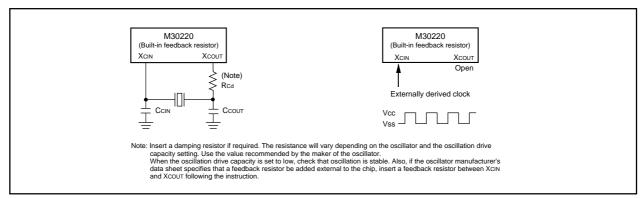


Figure 1.9.2. Examples of sub-clock



Clock Control

Figure 1.9.3 shows the block diagram of the clock generating circuit.

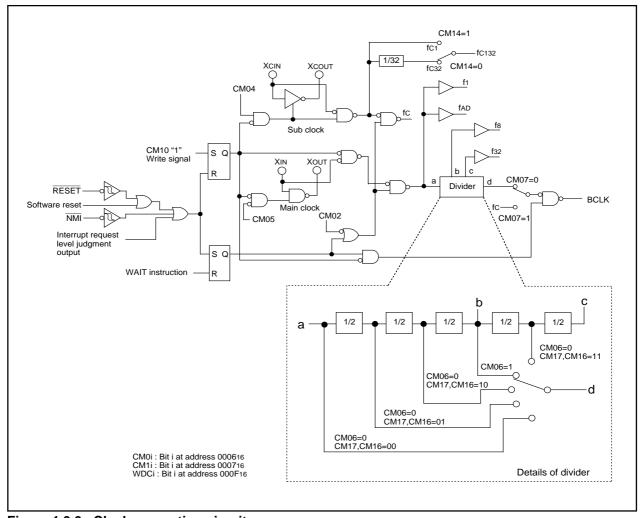


Figure 1.9.3. Clock generating circuit

The following paragraphs describes the clocks generated by the clock generating circuit.

(1) Main clock

The main clock is generated by the main clock oscillation circuit. After a reset, the clock is divided by 8 to the BCLK. The clock can be stopped using the main clock stop bit (bit 5 at address 000616). Stopping the clock, after switching the operating clock source of CPU to the sub-clock, reduces the power dissipation. After the oscillation of the main clock oscillation circuit has stabilized, the drive capacity of the main clock oscillation circuit can be reduced using the XIN-XOUT drive capacity select bit (bit 5 at address 000716). Reducing the drive capacity of the main clock oscillation circuit reduces the power dissipation. This bit changes to "1" when shifting from high-speed/medium-speed mode to stop mode and at a reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

(2) Sub-clock

The sub-clock is generated by the sub-clock oscillation circuit. No sub-clock is generated after a reset. After oscillation is started using the port Xc select bit (bit 4 at address 000616), the sub-clock can be selected as the BCLK by using the system clock select bit (bit 7 at address 000616). However, be sure that the sub-clock oscillation has fully stabilized before switching.

After the oscillation of the sub-clock oscillation circuit has stabilized, the drive capacity of the sub-clock oscillation circuit can be reduced using the XCIN-XCOUT drive capacity select bit (bit 3 at address 000616). Reducing the drive capacity of the sub-clock oscillation circuit reduces the power dissipation. This bit changes to "1" when shifting to stop mode and at a reset.

(3) **BCLK**

The BCLK is the clock that drives the CPU, and is fc or the clock is derived by dividing the main clock by 1, 2, 4, 8, or 16. The BCLK is derived by dividing the main clock by 8 after a reset.

The main clock division select bit 0(bit 6 at address 000616) changes to "1" when shifting from high-speed/medium-speed to stop mode and at reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

(4) Peripheral function clock (f1, f8, f32, fAD)

The clock for the peripheral devices is derived from the main clock or by dividing it by 1, 8, or 32. The peripheral function clock is stopped by stopping the main clock or by setting the WAIT peripheral function clock stop bit (bit 2 at 000616) to "1" and then executing a WAIT instruction.

(5) fC132

This clock is derived by dividing the sub-clock by 1 or 32. The clock is selected by fc132 clock select bit (bit4 at address 000716). It is used for the timer A and timer B counts, intermittent pull up operation of key input.

(6) fc

This clock has the same frequency as the sub-clock. It is used for the BCLK and for the watchdog timer. Figure 1.9.4 shows the system clock control registers 0 and 1.



S	yst	em	cl	ос	k (co	ntro	l register 0	(Note 1)		
b7	b6	b5	b4	b3	b2	L	1 b0	Symbol CM0	Address 000616	When reset 4816	
	-	-		1	- 1			Bit symbol	Bit name	Function	RW
							į.	- CM00	Clock output function select bit	0 0 : I/O port P57 0 1 : fc1 output	00
								CM01		1 0 : f1 output 1 1 : Clock divide counter output	00
				-	!_			CM02	WAIT peripheral function clock stop bit	0 : Do not stop peripheral function clock in wait mode 1 : Stop peripheral function clock in wait mode (Note 8)	00
				i.				CM03	XCIN-XCOUT drive capacity select bit (Note 2)	0 : LOW 1 : HIGH	00
			į,					CM04	Sub clock (XCIN-XCOUT) oscillation enable bit	0 : Off 1 : On	00
		i.						CM05	Main clock (XIN-XOUT) stop bit (Note 3, 4, 5)	0 : On 1 : Off	00
	į.							CM06	Main clock division select bit 0 (Note 7)	0 : CM16 and CM17 valid 1 : Division by 8 mode	00
L.								CM07	System clock select bit (Note 6)	0 : Xin, Xout 1 : Xcin, Xcout	00

- Note 1: Set bit 0 of the protect register (address 000A16) to "1" before writing to this register.
- Note 2: Changes to "1" when shifting to stop mode and at a reset.
- Note 3: When entering power saving mode, main clock stops using this bit. When returning from stop mode and operating with XIN, set this bit to "0". When main clock oscillation is operating by itself, set system clock select bit (CM07) to "1" before setting this bit to "1".
- Note 4: When inputting external clock, only clock oscillation buffer is stopped and clock input is acceptable.

 Note 5: If this bit is set to "1", Xout turns "H". The built-in feedback resistor remains being connected, so XIN turns
- pulled up to XouT ("H") via the feedback resistor.

 Note 6: Sub clock (XcIn-XcouT) oscillation enable bit (CM04) to "1" and stabilize the sub-clock oscillating before setting to this bit from "0" to "1". Do not write to both bits at the same time. And also, set the main clock stop bit (CM05) to "0" and stabilize the main clock oscillating before setting this bit from "1" to "0".
- Note 7: This bit changes to "1" when shifting from high-speed/medium-speed mode to stop mode and at a reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

 Note 8: fc132, fc1, fc32 is not included. Do not set to "1" when using low-speed or low power dissipation mode.

System clock control register 1 (Note 1)

b7	b6	b5 b4	0	0	0	Symbol CM1	Address 0007 ₁₆	When reset 2016	
			- {			Bit symbol	Bit name	Function	R¦W
						CM10	All clock stop control bit (Note 4)	0 : Clock on 1 : All clocks off (stop mode)	00
					Ĺ	Reserved	bit	Must always be set to "0"	00
				1		Reserved	bit	Must always be set to "0"	00
			į.			Reserved	bit	Must always be set to "0"	00
						CM14	fC132 clock select bit	0 : fc32 1 : fc1	00
		i				CM15	XIN-XOUT drive capacity select bit (Note 2)	0 : LOW 1 : HIGH	00
	l					CM16	Main clock division select bit 1 (Note 3)	0 0 : No division mode 0 1 : Division by 2 mode	00
į.						CM17	, ,	1 0 : Division by 4 mode 1 1 : Division by 16 mode	

- Note 1: Set bit 0 of the protect register (address 000A16) to "1" before writing to this register.

 Note 2: This bit changes to "1" when shifting from high-speed/medium-speed mode to stop mode and at a reset. When
- shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

 Note 3: Can be selected when bit 6 of the system clock control register 0 (address 000616) is "0". If "1", division mode is fixed at 8.
- Note 4: If this bit is set to "1", XOUT turns "H", and the built-in feedback resistor is cut off. XCIN and XCOUT turn highimpedance state.

Figure 1.9.4. System clock control registers 0 and 1



Clock Output

The clock output function select bit allows you to choose the clock from f1, fc1, or a divide-by-n clock that is output from the P57/CKOUT pin. The clock divide counter is an 8-bit counter whose count source is f32, and its divide ratio can be set in the range of 0016 to FF16. Also, the clock divided counter can be controlled for start or stop by the clock divide counter start flag. Figure 1.9.5 shows a block diagram of clock output. Figure 1.9.6 shows a clock divided counter related register.

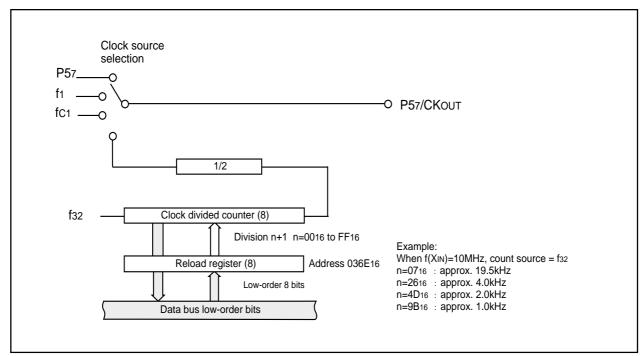


Figure 1.9.5. Block diagram of clock output

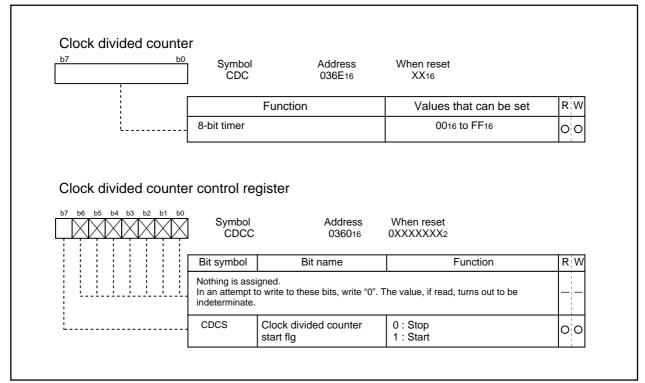


Figure 1.9.6. Clock divided counter related register



Stop Mode

Writing "1" to the all-clock stop control bit (bit 0 at address 000716) stops all oscillation and the microcomputer enters stop mode. In stop mode, the content of the internal RAM is retained provided that VCC remains above 2V.

Because the oscillation, BCLK, f1 to f32, fC, fC132, fC1, fC32 and fAD stops in stop mode, peripheral functions such as the A-D converter and watchdog timer do not function. However, timer A and timer B operate provided that the event counter mode is set to an external pulse, and UART0 to UART2 functions provided an external clock is selected. Table 1.9.2 shows the status of the ports in stop mode.

Stop mode is cancelled by a hardware reset or an interrupt. If an interrupt is to be used to cancel stop mode, that interrupt must first have been enabled. If returning by an interrupt, that interrupt routine is executed. When shifting from high-speed/medium-speed mode to stop mode and at a reset, the main clock division select bit 0 (bit 6 at address 000616) is set to "1". When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained.

Table 1.9.2. Port status during stop mode

	Pin	Status
Port		Retains status before stop mode
СКоит	When fc1 selected	"H"
	When f1, clock devided counter output selected	Retains status before stop mode

Wait Mode

When a WAIT instruction is executed, the BCLK stops and the microcomputer enters the wait mode. In this mode, oscillation continues but the BCLK and watchdog timer stop. Writing "1" to the WAIT peripheral function clock stop bit and executing a WAIT instruction stops the clock being supplied to the internal peripheral functions, allowing power dissipation to be reduced. However, peripheral function clock fc132, fc1, and fc32 do not stop so that the peripherals using fc132, fc1, and fc32 do not contribute to the power saving. When the MCU running in low-speed or low power dissipation mode, do not enter WAIT mode with this bit set to "1". Table 1.9.3 shows the status of the ports in wait mode.

Wait mode is cancelled by a hardware reset or an interrupt. If an interrupt is to be used to cancel wait mode, that interrupt must first have been enabled. If an interrupt is used to cancel wait mode, the microcomputer restarts from the interrupt routine using as BCLK, the clock that had been selected when the WAIT instruction was executed.

Table 1.9.3. Port status during wait mode

	Pin	Status
Port		Retains status before wait mode
СКоит	When fc1 selected	Does not stop
	When f1, clock devided counter output selected	Retains status before stop mode
		Does not stop when the WAIT peripheral
		function clock stop bit is "0".
		When the WAIT peripheral function clock
		stop bit is "1", the status immediately prior
		to entering wait mode is main-tained.



Status Transition Of BCLK

Power dissipation can be reduced and low-voltage operation achieved by changing the count source for BCLK. Table 1.9.4 shows the operating modes corresponding to the settings of system clock control registers 0 and 1.

When reset, the device starts in division by 8 mode. The main clock division select bit 0(bit 6 at address 000616) changes to "1" when shifting from high-speed/medium-speed to stop mode and at a reset. When shifting from low-speed/low power dissipation mode to stop mode, the value before stop mode is retained. The following shows the operational modes of BCLK.

(1) Division by 2 mode

The main clock is divided by 2 to obtain the BCLK.

(2) Division by 4 mode

The main clock is divided by 4 to obtain the BCLK.

(3) Division by 8 mode

The main clock is divided by 8 to obtain the BCLK. When reset, the device starts operating from this mode. Before the user can go from this mode to no division mode, division by 2 mode, or division by 4 mode, the main clock must be oscillating stably. When going to low-speed or lower power consumption mode, make sure the sub-clock is oscillating stably.

(4) Division by 16 mode

The main clock is divided by 16 to obtain the BCLK.

(5) No-division mode

The main clock is divided by 1 to obtain the BCLK.

(6) Low-speed mode

fC is used as the BCLK. Note that oscillation of both the main and sub-clocks must have stabilized before transferring from this mode to another or vice versa. At least 2 to 3 seconds are required after the sub-clock starts. Therefore, the program must be written to wait until this clock has stabilized immediately after powering up and after stop mode is cancelled.

(7) Low power dissipation mode

fc is the BCLK and the main clock is stopped.

Note: Before the count source for BCLK can be changed from XIN to XCIN or vice versa, the clock to which the count source is going to be switched must be oscillating stably. Allow a wait time in software for the oscillation to stabilize before switching over the clock.

Table 1.9.4. Operating modes dictated by settings of system clock control registers 0 and 1

CM17	CM16	CM07	CM06	CM05	CM04	Operating mode of BCLK
0	1	0	0	0	Invalid	Division by 2 mode
1	0	0	0	0	Invalid	Division by 4 mode
Invalid	Invalid	0	1	0	Invalid	Division by 8 mode
1	1	0	0	0	Invalid	Division by 16 mode
0	0	0	0	0	Invalid	No-division mode
Invalid	Invalid	1	Invalid	0	1	Low-speed mode
Invalid	Invalid	1	Invalid	1	1	Low power dissipation mode



Power control

The following is a description of the three available power control modes:

Modes

Power control is available in three modes.

(a) Normal operation mode

High-speed mode

Divide-by-1 frequency of the main clock becomes the BCLK. The CPU operates with the internal clock selected. Each peripheral function operates according to its assigned clock.

Medium-speed mode

Divide-by-2, divide-by-4, divide-by-8, or divide-by-16 frequency of the main clock becomes the BCLK. The CPU operates according to the internal clock selected. Each peripheral function operates according to its assigned clock.

Low-speed mode

fc becomes the BCLK. The CPU operates according to the fc clock. The fc clock is supplied by the secondary clock. Each peripheral function operates according to its assigned clock.

• Low power consumption mode

The main clock operating in low-speed mode is stopped. The CPU operates according to the fc clock. The fc clock is supplied by the secondary clock. The only peripheral functions that operate are those with the sub-clock selected as the count source.

(b) Wait mode

The CPU operation is stopped. The oscillators do not stop.

(c) Stop mode

All oscillators stop. The CPU and all built-in peripheral functions stop. This mode, among the three modes listed here, is the most effective in decreasing power consumption.

Figure 1.9.7 is the state transition diagram of the above modes.



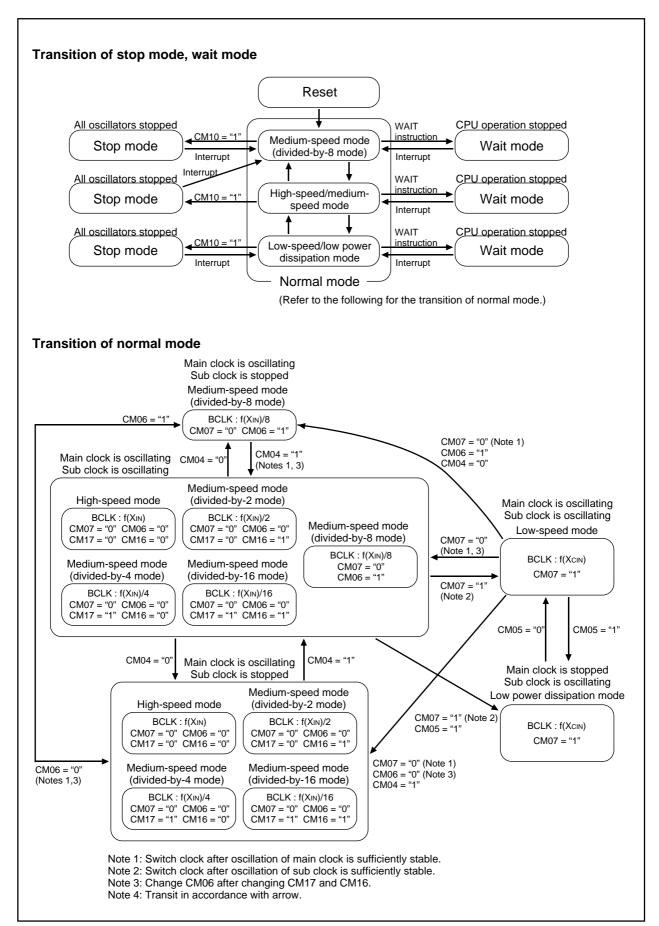


Figure 1.9.7. State transition diagram of Power control mode



Protection

The protection function is provided so that the values in important registers cannot be changed in the event that the program runs out of control. Figure 1.9.8 shows the protect register. The values in the processor mode register 0 (address 000416), processor mode register 1 (address 000516), system clock control register 0 (address 000616), system clock control register 1 (address 000716) can only be changed when the respective bit in the protect register is set to "1".

The system clock control registers 0 and 1 write-enable bit (bit 0 at 000A16) and processor mode register 0 and 1 write-enable bit (bit 1 at 000A16) do not automatically return to "0" after a value has been written to an address. The program must therefore be written to return these bits to "0".

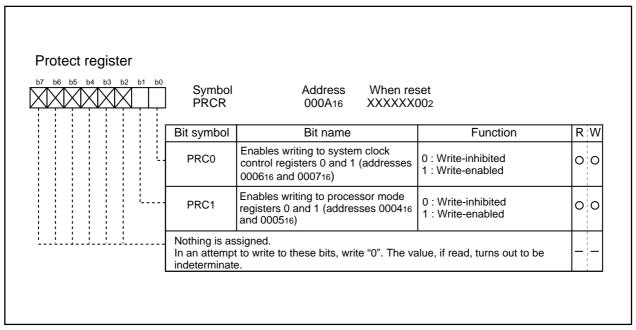


Figure 1.9.8. Protect register

Overview of Interrupt

Type of Interrupts

Figure 1.10.1 lists the types of interrupts.

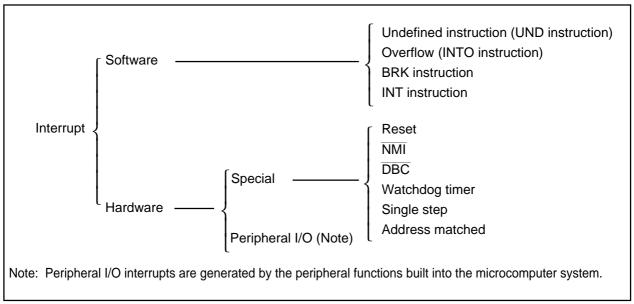


Figure 1.10.1. Classification of interrupts

• Maskable interrupt : An interrupt which can be enabled (disabled) by the interrupt enable flag

(I flag) or whose interrupt priority can be changed by priority level.

• Non-maskable interrupt : An interrupt which cannot be enabled (disabled) by the interrupt enable flag

(I flag) or whose interrupt priority cannot be changed by priority level.

Software Interrupts

A software interrupt occurs when executing certain instructions. Software interrupts are non-maskable interrupts.

Undefined instruction interrupt

An undefined instruction interrupt occurs when executing the UND instruction.

Overflow interrupt

An overflow interrupt occurs when executing the INTO instruction with the overflow flag (O flag) set to "1". The following are instructions whose O flag changes by arithmetic:

ABS, ADC, ADCF, ADD, CMP, DIV, DIVU, DIVX, NEG, RMPA, SBB, SHA, SUB

BRK interrupt

A BRK interrupt occurs when executing the BRK instruction.

INT interrupt

An INT interrupt occurs when specifying one of software interrupt numbers 0 through 63 and executing the INT instruction. Software interrupt numbers 0 through 31 are assigned to peripheral I/O interrupts, so executing the INT instruction allows executing the same interrupt routine that a peripheral I/O interrupt does.

The stack pointer (SP) used for the INT interrupt is dependent on which software interrupt number is involved.

So far as software interrupt numbers 0 through 31 are concerned, the microcomputer saves the stack pointer assignment flag (U flag) when it accepts an interrupt request. If change the U flag to "0" and select the interrupt stack pointer (ISP), and then execute an interrupt sequence. When returning from the interrupt routine, the U flag is returned to the state it was before the acceptance of interrupt request. So far as software numbers 32 through 63 are concerned, the stack pointer does not make a shift.



Hardware Interrupts

Hardware interrupts are classified into two types — special interrupts and peripheral I/O interrupts.

(1) Special interrupts

Special interrupts are non-maskable interrupts.

Reset

Reset occurs if an "L" is input to the RESET pin.

• NMI interrupt

An \overline{NMI} interrupt occurs if an "L" is input to the \overline{NMI} pin.

• DBC interrupt

This interrupt is exclusively for the debugger, do not use it in other circumstances.

Watchdog timer interrupt

Generated by the watchdog timer.

Single-step interrupt

This interrupt is exclusively for the debugger, do not use it in other circumstances. With the debug flag (D flag) set to "1", a single-step interrupt occurs after one instruction is executed.

Address match interrupt

An address match interrupt occurs immediately before the instruction held in the address indicated by the address match interrupt register is executed with the address match interrupt enable bit set to "1". If an address other than the first address of the instruction in the address match interrupt register is set, no address match interrupt occurs.

(2) Peripheral I/O interrupts

A peripheral I/O interrupt is generated by one of built-in peripheral functions. Built-in peripheral functions are dependent on classes of products, so the interrupt factors too are dependent on classes of products. The interrupt vector table is the same as the one for software interrupt numbers 0 through 31 the INT instruction uses. Peripheral I/O interrupts are maskable interrupts.

Bus collision detection interrupt

This is an interrupt that the serial I/O bus collision detection generates.

DMA0 interrupt, DMA1 interrupt

These are interrupts that DMA generates.

Key-input interrupt

A key-input interrupt occurs if either a falling edge or a both edge is input to the KI pin.

• A-D conversion interrupt

This is an interrupt that the A-D converter generates.

• UART0, UART1, UART2 transmission interrupt

These are interrupts that the serial I/O transmission generates.

• UART0, UART1, UART2 reception interrupt

These are interrupts that the serial I/O reception generates.

Timer A0 interrupt through timer A7 interrupt

These are interrupts that timer A generates

Timer B0 interrupt through timer B5 interrupt

These are interrupts that timer B generates.

• INTO interrupt through INT5 interrupt

An INT interrupt occurs if either a rising edge or a falling edge or a both edge is input to the INT pin.



Interrupts and Interrupt Vector Tables

If an interrupt request is accepted, a program branches to the interrupt routine set in the interrupt vector table. Set the first address of the interrupt routine in each vector table. Figure 1.10.2 shows the format for specifying the address.

Two types of interrupt vector tables are available — fixed vector table in which addresses are fixed and variable vector table in which addresses can be varied by the setting.

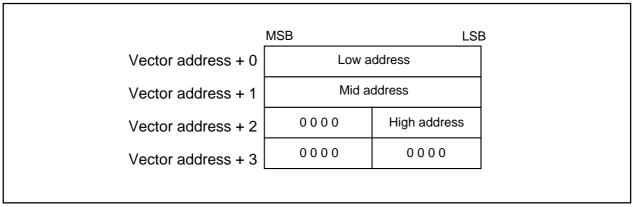


Figure 1.10.2. Format for specifying interrupt vector addresses

Fixed vector tables

The fixed vector table is a table in which addresses are fixed. The vector tables are located in an area extending from FFFDC16 to FFFFF16. One vector table comprises four bytes. Set the first address of interrupt routine in each vector table. Table 1.10.1 shows the interrupts assigned to the fixed vector tables and addresses of vector tables.

Table 1.10.1. Interrupts assigned to the fixed vector tables and addresses of vector tables

Interrupt source	Vector table addresses	Remarks	
	Address (L) to address (H)		
Undefined instruction	FFFDC16 to FFFDF16	Interrupt on UND instruction	
Overflow	FFFE016 to FFFE316	Interrupt on INTO instruction	
BRK instruction	FFFE416 to FFFE716	If the vector contains FF16, program execution starts from	
		the address shown by the vector in the variable vector table	
Address match	FFFE816 to FFFEB16	There is an address-matching interrupt enable bit	
Single step (Note)	FFFEC16 to FFFEF16	Do not use	
Watchdog timer	FFFF016 to FFFF316		
DBC (Note)	FFFF416 to FFFF716	Do not use	
NMI	FFFF816 to FFFFB16	External interrupt by input to NMI pin	
Reset	FFFFC16 to FFFFF16		

Note: Interrupts used for debugging purposes only.



Variable vector tables

The addresses in the variable vector table can be modified, according to the user's settings. Indicate the first address using the interrupt table register (INTB). The 256-byte area subsequent to the address the INTB indicates becomes the area for the variable vector tables. One vector table comprises four bytes. Set the first address of the interrupt routine in each vector table. Table 1.10.2 shows the interrupts assigned to the variable vector tables and addresses of vector tables.

Table 1.10.2. Interrupts assigned to the variable vector tables and addresses of vector tables

Software interrupt number	Vector table address Address (L) to address (H)	Interrupt source	Remarks
Software interrupt number 0	+0 to +3 (Note 1)	BRK instruction	Cannot be masked I flag
Software interrupt number 4	+16 to +19 (Note 1)	ĪNT3	
Software interrupt number 5	+20 to +23 (Note 1)	Timer B5	
Software interrupt number 6	+24 to +27 (Note 1)	Timer B4	
Software interrupt number 7	+28 to +31 (Note 1)	Timer B3	
Software interrupt number 8	+32 to +35 (Note 1)	Timer A7	
Software interrupt number 9	+36 to +39 (Note 1)	Timer A6	
Software interrupt number 10	+40 to +43 (Note 1)	Timer A5/Bus collision detection (Note 2)	
Software interrupt number 11	+44 to +47 (Note 1)	DMA0	
Software interrupt number 12	+48 to +51 (Note 1)	DMA1	
Software interrupt number 13	+52 to +55 (Note 1)	Key input interrupt	
Software interrupt number 14	+56 to +59 (Note 1)	A-D	
Software interrupt number 15	+60 to +63 (Note 1)	UART2 transmit / NACK (Note 3)	
Software interrupt number 16	+64 to +67 (Note 1)	UART2 receive / ACK (Note 3)	
Software interrupt number 17	+68 to +71 (Note 1)	UART0 transmit	
Software interrupt number 18	+72 to +75 (Note 1)	UART0 receive	
Software interrupt number 19	+76 to +79 (Note 1)	UART1 transmit	
Software interrupt number 20	+80 to +83 (Note 1)	UART1 receive	
Software interrupt number 21	+84 to +87 (Note 1)	Timer A0	
Software interrupt number 22	+88 to +91 (Note 1)	Timer A1	
Software interrupt number 23	+92 to +95 (Note 1)	Timer A2	
Software interrupt number 24	+96 to +99 (Note 1)	Timer A3/INT4 (Note 4)	
Software interrupt number 25	+100 to +103 (Note 1)	Timer A4/INT5 (Note 4)	
Software interrupt number 26	+104 to +107 (Note 1)	Timer B0	
Software interrupt number 27	+108 to +111 (Note 1)	Timer B1	
Software interrupt number 28	+112 to +115 (Note 1)	Timer B2	
Software interrupt number 29	+116 to +119 (Note 1)	ĪNT0	
Software interrupt number 30	+120 to +123 (Note 1)	ĪNT1	
Software interrupt number 31	+124 to +127 (Note 1)	ĪNT2	
Software interrupt number 32 to	+128 to +131 (Note 1)	Software interrupt	Cannot be masked I flag
Software interrupt number 63	+252 to +255 (Note 1)		l l l l l l l l l l l l l l l l l l l

Note 1: Address relative to address in interrupt table register (INTB).

Note 2: It is selected by interrupt request cause select bit (bit 4 in address 035E16).

Note 3: When IIC mode is selected, NACK and ACK interrupts are selected.

Note 4: It is selected by interrupt request cause select bit (bit 6, 7 in address 035F16).



Interrupt Control

Descriptions are given here regarding how to enable or disable maskable interrupts and how to set the priority to be accepted. What is described here does not apply to non-maskable interrupts.

Enable or disable a maskable interrupt using the interrupt enable flag (I flag), interrupt priority level selection bit, or processor interrupt priority level (IPL). Whether an interrupt request is present or absent is indicated by the interrupt request bit. The interrupt request bit and the interrupt priority level selection bit are located in the interrupt control register of each interrupt. Also, the interrupt enable flag (I flag) and the IPL are located in the flag register (FLG).

Figure 1.10.3 shows the memory map of the interrupt control registers.

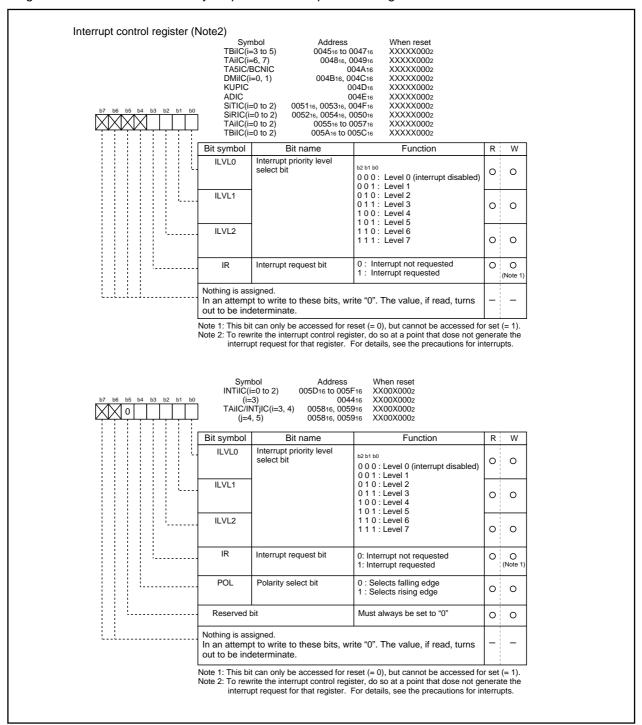


Figure 1.10.3. Interrupt control registers



Interrupt Enable Flag (I flag)

The interrupt enable flag (I flag) controls the enabling and disabling of maskable interrupts. Setting this flag to "1" enables all maskable interrupts; setting it to "0" disables all maskable interrupts. This flag is set to "0" after reset.

Interrupt Request Bit

The interrupt request bit is set to "1" by hardware when an interrupt is requested. After the interrupt is accepted and jumps to the corresponding interrupt vector, the request bit is set to "0" by hardware. The interrupt request bit can also be set to "0" by software. (Do not set this bit to "1").



Interrupt Priority Level Select Bit and Processor Interrupt Priority Level (IPL)

Set the interrupt priority level using the interrupt priority level select bit, which is one of the component bits of the interrupt control register. When an interrupt request occurs, the interrupt priority level is compared with the IPL. The interrupt is enabled only when the priority level of the interrupt is higher than the IPL. Therefore, setting the interrupt priority level to "0" disables the interrupt.

Table 1.10.3 shows the settings of interrupt priority levels and Table 1.10.4 shows the interrupt levels enabled, according to the contents of the IPL.

The following are conditions under which an interrupt is accepted:

- · interrupt enable flag (I flag) = 1
- · interrupt request bit = 1
- · interrupt priority level > IPL

The interrupt enable flag (I flag), the interrupt request bit, the interrupt priority select bit, and the IPL are independent, and they are not affected by one another.

Table 1.10.3. Settings of interrupt priority levels

Interrupt p		Interrupt priority level	Priority order
b2 b1	b0		
0 0	0	Level 0 (interrupt disabled)	
0 0	1	Level 1	Low
0 1	0	Level 2	
0 1	1	Level 3	
1 0	0	Level 4	
1 0	1	Level 5	
1 1	0	Level 6	
1 1	1	Level 7	High

Table 1.10.4. Interrupt levels enabled according to the contents of the IPL

IPL	Enabled interrupt priority levels	
IPL2 IPL1 IPL0		
0 0 0	Interrupt levels 1 and above are enabled	
0 0 1	Interrupt levels 2 and above are enabled	
0 1 0	Interrupt levels 3 and above are enabled	
0 1 1	Interrupt levels 4 and above are enabled	
1 0 0	Interrupt levels 5 and above are enabled	
1 0 1	Interrupt levels 6 and above are enabled	
1 1 0	Interrupt levels 7 and above are enabled	
1 1 1	All maskable interrupts are disabled	

Rewrite the interrupt control register

To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. If there is possibility of the interrupt request occur, rewrite the interrupt control register after the interrupt is disabled. The program examples are described as follow:

Example 1:

INT_SWITCH1:

FCLR I ; Disable interrupts.

AND.B #00h, 0055h; Clear TAOIC int. priority level and int. request bit.

NOP ; Four NOP instructions are required when using HOLD function.

NOP

FSET I ; Enable interrupts.

Example 2:

INT_SWITCH2:

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

MOV.W MEM, R0 ; Dummy read. FSET I ; Enable interrupts.

Example 3:

INT_SWITCH3:

PUSHC FLG ; Push Flag register onto stack

FCLR I ; Disable interrupts.

AND.B #00h, 0055h; Clear TA0IC int. priority level and int. request bit.

POPC FLG ; Enable interrupts.

The reason why two NOP instructions (four when using the HOLD function) or dummy read are inserted before FSET I in Examples 1 and 2 is to prevent the interrupt enable flag I from being set before the interrupt control register is rewritten due to effects of the instruction queue.

When a instruction to rewrite the interrupt control register is executed but the interrupt is disabled, the interrupt request bit is not set sometimes even if the interrupt request for that register has been generated. This will depend on the instruction. If this creates problems, use the below instructions to change the register.

Instructions: AND, OR, BCLR, BSET



Interrupt Sequence

An interrupt sequence — what are performed over a period from the instant an interrupt is accepted to the instant the interrupt routine is executed — is described here.

If an interrupt occurs during execution of an instruction, the processor determines its priority when the execution of the instruction is completed, and transfers control to the interrupt sequence from the next cycle. If an interrupt occurs during execution of either the SMOVB, SMOVF, SSTR or RMPA instruction, the processor temporarily suspends the instruction being executed, and transfers control to the interrupt sequence.

In the interrupt sequence, the processor carries out the following in sequence given:

- (1) CPU gets the interrupt information (the interrupt number and interrupt request level) by reading address 0000016. After this, the corresponding interrupt request bit becomes "0".
- (2) Saves the content of the flag register (FLG) as it was immediately before the start of interrupt sequence in the temporary register (Note) within the CPU.
- (3) Sets the interrupt enable flag (I flag), the debug flag (D flag), and the stack pointer select flag (U flag) to "0" (the U flag, however does not change if the INT instruction, in software interrupt numbers 32 through 63, is executed)
- (4) Saves the content of the temporary register (Note) within the CPU in the stack area.
- (5) Saves the content of the program counter (PC) in the stack area.
- (6) Sets the interrupt priority level of the accepted instruction in the IPL.

After the interrupt sequence is completed, the processor resumes executing instructions from the first address of the interrupt routine.

Note: This register cannot be utilized by the user.

Interrupt Response Time

'Interrupt response time' is the period between the instant an interrupt occurs and the instant the first instruction within the interrupt routine has been executed. This time comprises the period from the occurrence of an interrupt to the completion of the instruction under execution at that moment (a) and the time required for executing the interrupt sequence (b). Figure 1.10.4 shows the interrupt response time.

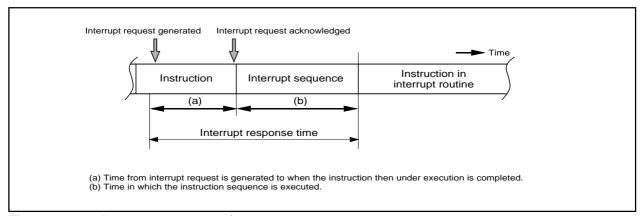


Figure 1.10.4. Interrupt response time



Time (a) is dependent on the instruction under execution. Thirty cycles is the maximum required for the DIVX instruction (without wait).

Time (b) is as shown in Table 1.10.5.

Table 1.10.5. Time required for executing the interrupt sequence

Interrupt vector address	Stack pointer (SP) value	16-Bit bus, without wait	8-Bit bus, without wait
Even	Even	18 cycles (Note 1)	20 cycles (Note 1)
Even	Odd	19 cycles (Note 1)	20 cycles (Note 1)
Odd (Note 2)	Even	19 cycles (Note 1)	20 cycles (Note 1)
Odd (Note 2)	Odd	20 cycles (Note 1)	20 cycles (Note 1)

Note 1: Add 2 cycles in the case of a DBC interrupt; add 1 cycle in the case either of an address coincidence interrupt or of a single-step interrupt.

Note 2: Locate an interrupt vector address in an even address, if possible.

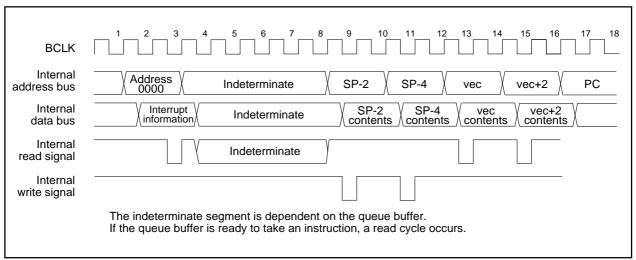


Figure 1.10.5. Time required for executing the interrupt sequence

Variation of IPL when Interrupt Request is Accepted

If an interrupt request is accepted, the interrupt priority level of the accepted interrupt is set in the IPL. If an interrupt request, that does not have an interrupt priority level, is accepted, one of the values shown in Table 1.10.6 is set in the IPL.

Table 1.10.6. Relationship between interrupts without interrupt priority levels and IPL

Interrupt sources without priority levels	Value set in the IPL
Watchdog timer, NMI	7
Reset	0
Other	Not changed



Saving Registers

In the interrupt sequence, only the contents of the flag register (FLG) and that of the program counter (PC) are saved in the stack area.

First, the processor saves the four higher-order bits of the program counter, and 4 upper-order bits and 8 lower-order bits of the FLG register, 16 bits in total, in the stack area, then saves 16 lower-order bits of the program counter. Figure 1.10.6 shows the state of the stack as it was before the acceptance of the interrupt request, and the state the stack after the acceptance of the interrupt request.

Save other necessary registers at the beginning of the interrupt routine using software. Using the PUSHM instruction alone can save all the registers except the stack pointer (SP).

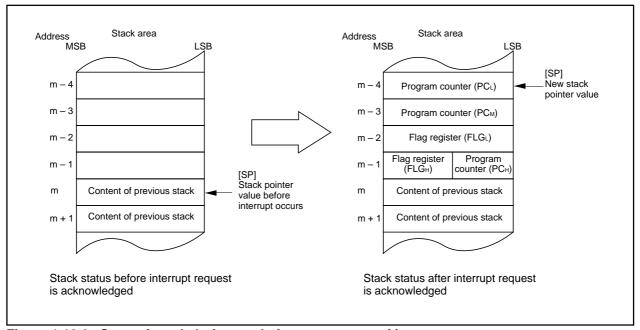


Figure 1.10.6. State of stack before and after acceptance of interrupt request

The operation of saving registers carried out in the interrupt sequence is dependent on whether the content of the stack pointer, at the time of acceptance of an interrupt request, is even or odd. If the content of the stack pointer (Note) is even, the content of the flag register (FLG) and the content of the program counter (PC) are saved, 16 bits at a time. If odd, their contents are saved in two steps, 8 bits at a time. Figure 1.10.7 shows the operation of the saving registers.

Note: When any INT instruction in software numbers 32 to 63 has been executed, this is the stack pointer indicated by the U flag. Otherwise, it is the interrupt stack pointer (ISP).

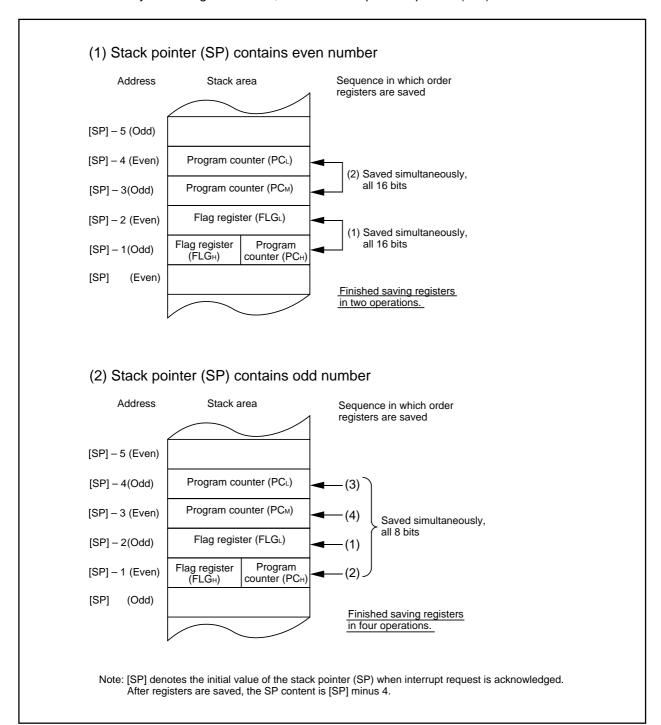


Figure 1.10.7. Operation of saving registers

Returning from an Interrupt Routine

Executing the REIT instruction at the end of an interrupt routine returns the contents of the flag register (FLG) as it was immediately before the start of interrupt sequence and the contents of the program counter (PC), both of which have been saved in the stack area. Then control returns to the program that was being executed before the acceptance of the interrupt request, so that the suspended process resumes.

Return the other registers saved by software within the interrupt routine using the POPM or similar instruction before executing the REIT instruction.

Interrupt Priority

If there are two or more interrupt requests occurring at a point in time within a single sampling (checking whether interrupt requests are made), the interrupt assigned a higher priority is accepted.

Assign an arbitrary priority to maskable interrupts (peripheral I/O interrupts) using the interrupt priority level select bit. If the same interrupt priority level is assigned, however, the interrupt assigned a higher hardware priority is accepted.

Priorities of the special interrupts, such as Reset (dealt with as an interrupt assigned the highest priority), watchdog timer interrupt, etc. are regulated by hardware.

Figure 1.10.8 shows the priorities of hardware interrupts.

Software interrupts are not affected by the interrupt priority. If an instruction is executed, control branches invariably to the interrupt routine.

Reset $> \overline{\text{NMI}} > \overline{\text{DBC}} > \text{Watchdog timer} > \text{Peripheral I/O} > \text{Single step} > \text{Address match}$

Figure 1.10.8. Hardware interrupts priorities

Interrupt resolution circuit

When two or more interrupts are generated simultaneously, this circuit selects the interrupt with the highest priority level. Figure 1.10.9 shows the circuit that judges the interrupt priority level.



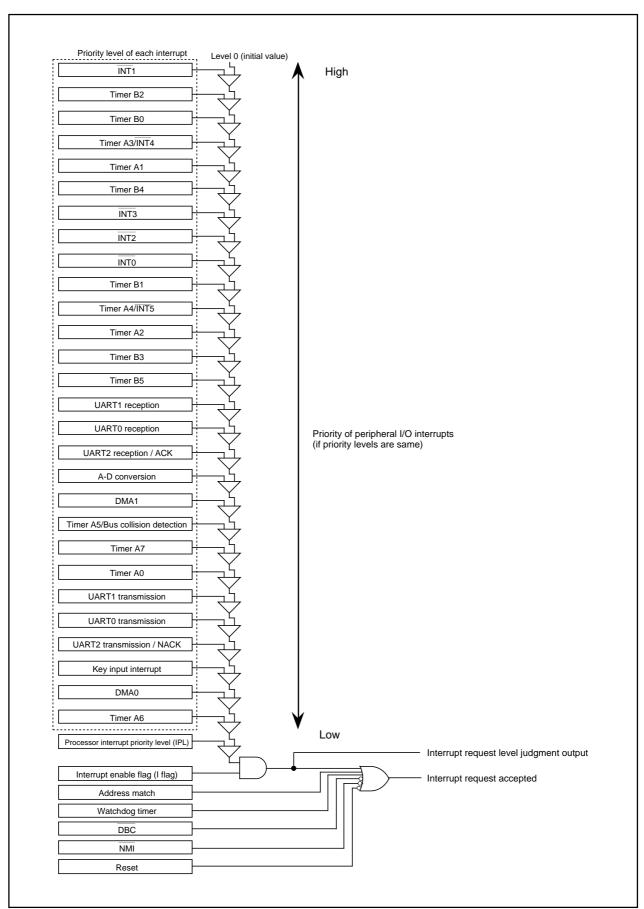


Figure 1.10.9. Maskable interrupts priorities (peripheral I/O interrupts)



INT Interrupt

INTO to INT5 are triggered by the edges of external inputs. The edge polarity is selected using the polarity select bit. Of interrupt control registers, 005816 is used both as timer A3 and external interrupt INT4 input control register, and 005916 is used both as timer A4 and as external interrupt INT5 input control register. Use the interrupt request cause select bits - bits 6 and 7 of the interrupt request cause select register 1 (address 035F16) - to specify which interrupt request cause to select. When INT4 is selected as an interrupt source, the input port for it can be selected by bits 0 and 1 of the interrupt source select register 0 (address 035E16). Similarly, when INT5 is selected as an interrupt source, the input port for it can be selected by bits 2 and 3 of the interrupt source select register 0 (address 035E16). After having set an interrupt request cause and interrupt input ports, be sure to set the corresponding interrupt request bit to "0" before enabling an interrupt.

Either of the interrupt control registers - 005816, 005916 - has the polarity-switching bit. Be sure to set this bit to "0" to select an timer as the interrupt request cause.

As for external interrupt input, an interrupt can be generated both at the rising edge and at the falling edge by setting "1" in the INTi interrupt polarity switching bit of the interrupt request cause select register 1 (035F16). To select two edges, set the polarity switching bit of the corresponding interrupt control register to 'falling edge' ("0").

When $\overline{\text{INT4}}$ input pin select bits = "11", $\overline{\text{INT4}}$ interrupt polarity switching bit = "0", and polarity select bit = "1" of the $\overline{\text{INT4}}$ interrupt control register, an interrupt is generated by a rising edge on the input port when the exclusive pin is "H", as shown by "Single edge, Rise" in Figure 1.10.12. When the exclusive pin is "H", interrupts can only be generated by an active transition on a single edge. The same applies to $\overline{\text{INT5}}$.

Figure 1.10.10 shows the interrupt request cause select register.

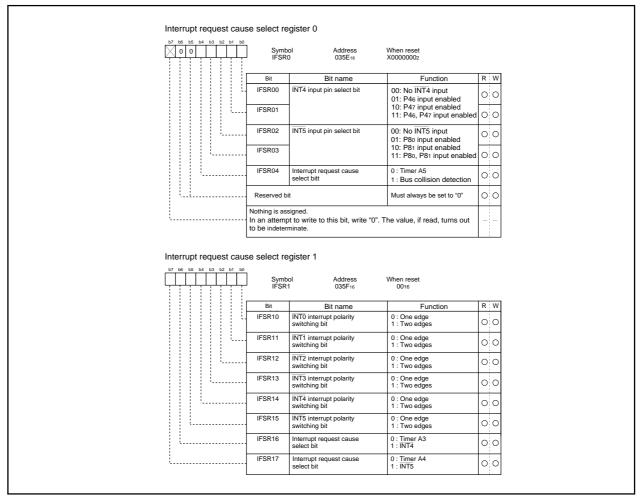


Figure 1.10.10. Interrupt request cause select registers 0, 1



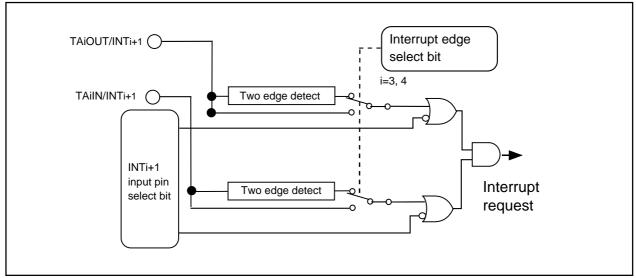


Figure 1.10.11. Constitution of INT4 and INT5

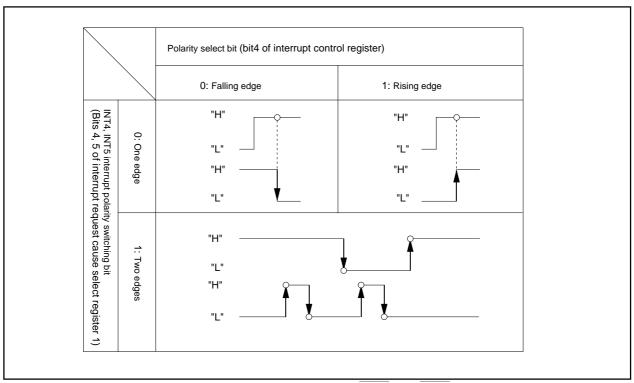


Figure 1.10.12. Typical timings in two input interrupt of INT4 and INT5 selected

NMI Interrupt

An $\overline{\text{NMI}}$ interrupt is generated when the input to the P77/ $\overline{\text{NMI}}$ pin changes from "H" to "L". The $\overline{\text{NMI}}$ interrupt is a non-maskable external interrupt. The pin level can be checked in the port P77 register (bit 7 at address 03ED₁₆).

This pin cannot be used as a normal port input.



Key Input Interrupt

A key input interrupt request is generated when an active edge selected by the key input mode register's P1, P2 key input select bits occurs on one of input ports P10 to P17, P20 to P27, or P30 to P33 whose direction register is set for input and which has been enabled for key input by the key input enable bit. For P30 to P33, key input interrupt requests are always generated by a falling edge.

A key input interrupt can also be used as a key-on wakeup function for cancelling the wait mode or stop mode. When using an oscillator connected between XCIN—XCOUT and the corresponding port has been set to have a pullup, if the P1, P2 key input select bits (bits 0, 2 at address 012616) are set for "Two edges" and the P1, P2 key input enable bits (bits 1, 3 at address 012616) are "Enabled", pullups on P10 to P17 and P20 to P27 are automatically turned on and the port is pulled "H" for only a period of about 244 us (Note) at intervals of approximately 7.8 ms (Note), as shown in Figure 1.10.15. And if the key input enable bit (bit 1, 3 and 4 at the address 012616) is set to "enable", sometimes the interrupt request bit may be set to "1", therefore set the interrupt request bit to "0" with a program.

Figure 1.10.13 shows a block diagram for key input interrupts. Note that when a "L" signal is applied to any pin which has had its key input enable bit set to "0" and is not processed for input inhibition, input to other pins are not detected as an interrupt. The fc32 is affected by a clock prescaler reset flag.

Note: XCIN = 32.768kHz

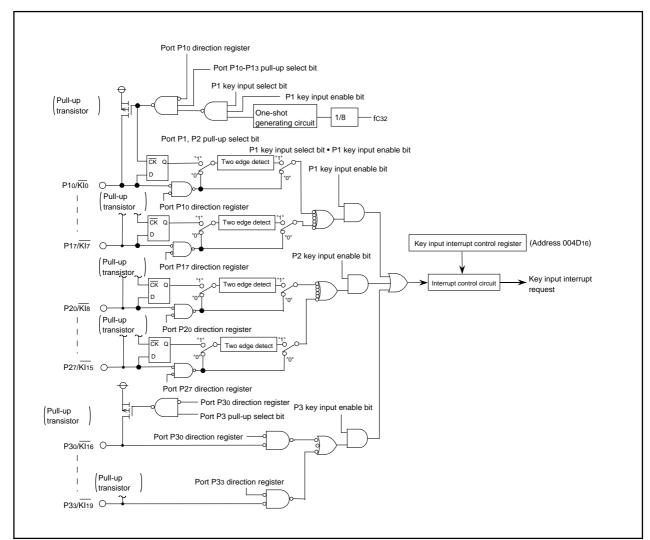


Figure 1.10.13. Block diagram of key input interrupt

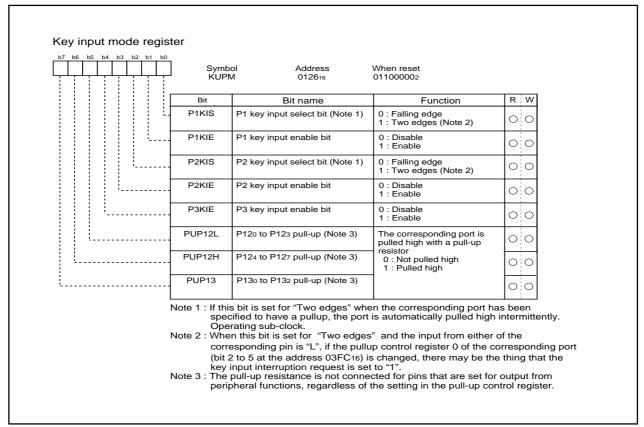


Figure 1.10.14. Key input mode register

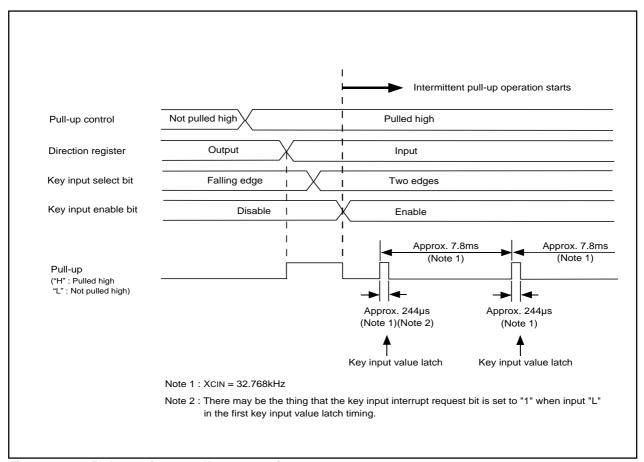


Figure 1.10.15. Intermittent pull-up operation



Address Match Interrupt

An address match interrupt is generated when the address match interrupt address register contents match the program counter value. Two address match interrupts can be set, each of which can be enabled and disabled by an address match interrupt enable bit. Address match interrupts are not affected by the interrupt enable flag (I flag) and processor interrupt priority level (IPL). The value of the program counter (PC) for an address match interrupt varies depending on the instruction being executed.

Figure 1.10.16 shows the address match interrupt-related registers.

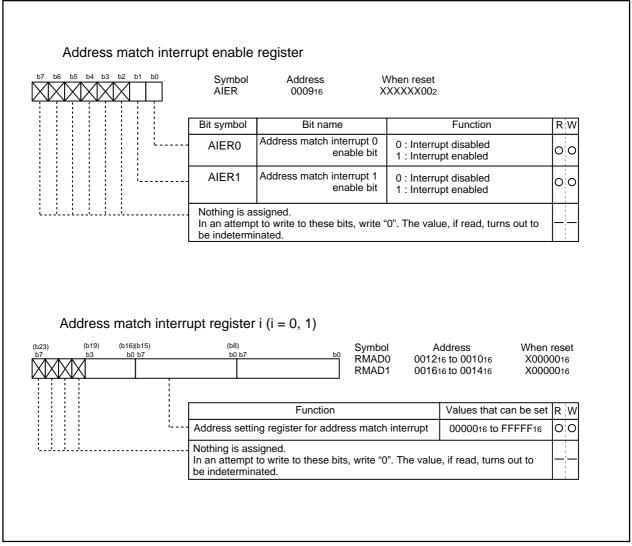


Figure 1.10.16. Address match interrupt-related registers

Precautions for Interrupts

(1) Reading address 0000016

• When maskable interrupt is occurred, CPU read the interrupt information (the interrupt number and interrupt request level) in the interrupt sequence.

The interrupt request bit of the certain interrupt written in address 0000016 will then be set to "0".

Reading address 0000016 by software sets enabled highest priority interrupt source request bit to "0".

Though the interrupt is generated, the interrupt routine may not be executed.

Do not read address 0000016 by software.

(2) Setting the stack pointer

• The value of the stack pointer immediately after reset is initialized to 000016. Accepting an interrupt before setting a value in the stack pointer may become a factor of runaway. Be sure to set a value in the stack pointer before accepting an interrupt. When using the NMI interrupt, initialize the stack pointer at the beginning of a program. Concerning the first instruction immediately after reset, generating any interrupts including the NMI interrupt is prohibited.

(3) The NMI interrupt

- •The NMI interrupt can not be disabled. Be sure to connect NMI pin to Vcc via a resistor (pull-up) if unused. Be sure to work on it.
- The NMI pin also serves as P77, which is exclusively input. Reading the contents of the P7 register allows reading the pin value. Use the reading of this pin only for establishing the pin level at the time when the NMI interrupt is input.
- Do not reset the CPU with the input to the NMI pin being in the "L" state.
- Do not attempt to go into stop mode with the input to the \overline{NMI} pin being in the "L" state. With the input to the \overline{NMI} being in the "L" state, the CM10 is fixed to "0", so attempting to go into stop mode is turned down.
- Do not attempt to go into wait mode with the input to the \overline{NMI} pin being in the "L" state. With the input to the \overline{NMI} pin being in the "L" state, the CPU stops but the oscillation does not stop, so no power is saved. In this instance, the CPU is returned to the normal state by a later interrupt.
- Signals input to the NMI pin require an "L" level of 1 clock or more, from the operation clock of the CPU.

(4) External interrupt

- Either an "L" level or an "H" level of at least 250 ns width is necessary for the signal input to pins INTo through INT5 regardless of the CPU operation clock.
- When the polarity of the INTo to INTo pins is changed, the interrupt request bit is sometimes set to "1". After changing the polarity, set the interrupt request bit to "0". Figure 1.10.17 shows the procedure for changing the INT interrupt generate factor.



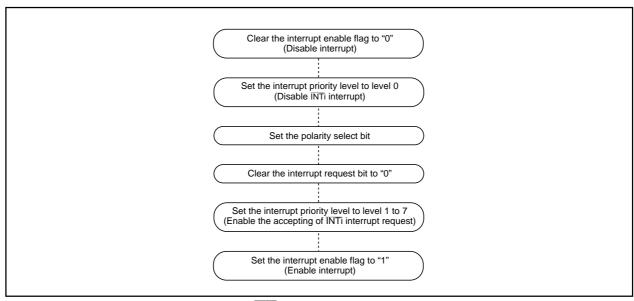


Figure 1.10.17. Switching condition of INT interrupt request

(5) Rewrite the interrupt control register

• To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. If there is possibility of the interrupt request occur, rewrite the interrupt control register after the interrupt is disabled. The program examples are described as follow:

Example 1:

```
INT_SWITCH1:
```

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TAOIC int. priority level and int. request bit.

NOP ; Four NOP instructions are required when using HOLD function.

NOP

FSET I ; Enable interrupts.

Example 2:

INT_SWITCH2:

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

MOV.W MEM, R0 ; Dummy read. FSET I ; Enable interrupts.

Example 3:

INT SWITCH3:

PUSHC FLG ; Push Flag register onto stack

FCLR I ; Disable interrupts.

AND.B #00h, 0055h ; Clear TA0IC int. priority level and int. request bit.

POPC FLG ; Enable interrupts.

The reason why two NOP instructions (four when using the HOLD function) or dummy read are inserted before FSET I in Examples 1 and 2 is to prevent the interrupt enable flag I from being set before the interrupt control register is rewritten due to effects of the instruction queue.

When a instruction to rewrite the interrupt control register is executed but the interrupt is disabled, the
interrupt request bit is not set sometimes even if the interrupt request for that register has been generated. This will depend on the instruction. If this creates problems, use the below instructions to change
the register.

Instructions: AND, OR, BCLR, BSET



Watchdog Timer

The watchdog timer has the function of detecting when the program is out of control. The watchdog timer is a 15-bit counter which down-counts the clock derived by dividing the BCLK using the prescaler. A watchdog timer interrupt is generated when an underflow occurs in the watchdog timer. When XIN is selected for the BCLK, bit 7 of the watchdog timer control register (address 000F16) selects the prescaler division ratio (by 16 or by 128). When XCIN is selected as the BCLK, the prescaler is set for division by 2 regardless of bit 7 of the watchdog timer control register (address 000F16). Thus the watchdog timer's period can be calculated as given below. The watchdog timer's period is, however, subject to an error due to the prescaler.

With XIN chosen for BCLK

Watchdog timer period =

prescaler dividing ratio (16 or 128) X watchdog timer count (32768)

BCLK

With XCIN chosen for BCLK

Watchdog timer period =

prescaler dividing ratio (2) X watchdog timer count (32768)

BCLK

For example, suppose that BCLK runs at 10 MHz and that 16 has been chosen for the dividing ratio of the prescaler, then the watchdog timer's period becomes approximately 52.4 ms.

The watchdog timer is initialized by writing to the watchdog timer start register (address 000E₁₆) and when a watchdog timer interrupt request is generated. The prescaler is initialized only when the microcomputer is reset. After a reset is cancelled, the watchdog timer and prescaler are both stopped. The count is started by writing to the watchdog timer start register (address 000E₁₆). In stop mode and wait mode, the watchdog timer and prescaler are stopped. Counting is resumed from the held value when the modes or state are released.

Figure 1.11.1 shows the block diagram of the watchdog timer. Figure 1.11.2 shows the watchdog timer-related registers.

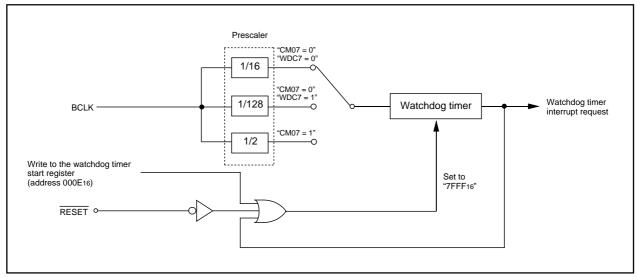


Figure 1.11.1. Block diagram of watchdog timer



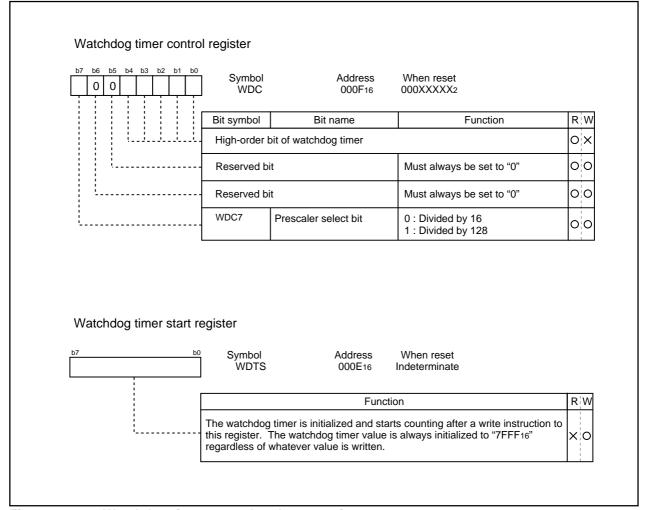


Figure 1.11.2. Watchdog timer control and start registers

DMAC

This microcomputer has two DMAC (direct memory access controller) channels that allow data to be sent to memory without using the CPU. DMAC shares the same data bus with the CPU. The DMAC is given a higher right of using the bus than the CPU, which leads to working the cycle stealing method. On this account, the operation from the occurrence of DMA transfer request signal to the completion of 1-word (16-bit) or 1-byte (8-bit) data transfer can be performed at high speed. Figure 1.12.1 shows the block diagram of the DMAC. Table 1.12.1 shows the DMAC specifications. Figures 1.12.2 to 1.12.4 show the registers used by the DMAC.

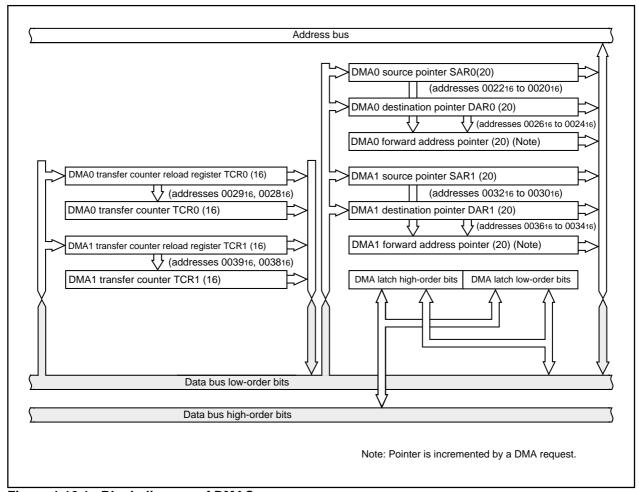


Figure 1.12.1. Block diagram of DMAC

Either a write signal to the software DMA request bit or an interrupt request signal is used as a DMA transfer request signal. But the DMA transfer is affected neither by the interrupt enable flag (I flag) nor by the interrupt priority level. The DMA transfer doesn't affect any interrupts either.

If the DMAC is active (the DMA enable bit is set to 1), data transfer starts every time a DMA transfer request signal occurs. If the cycle of the occurrences of DMA transfer request signals is higher than the DMA transfer cycle, there can be instances in which the number of transfer requests doesn't agree with the number of transfers. For details, see the description of the DMA request bit.



Table 1.12.1. DMAC specifications

Item	Specification
No. of channels	2 (cycle steal method)
Transfer memory space	 From any address in the 1M bytes space to a fixed address From a fixed address to any address in the 1M bytes space From a fixed address to a fixed address
Maximum No. of bytes transferred	(Note that DMA-related registers [002016 to 003F16] cannot be accessed) 128K bytes (with 16-bit transfers) or 64K bytes (with 8-bit transfers)
DMA request factors (Note)	Falling edge of INT0 or INT1 or both edge
	Timer A0 to timer A7 interrupt requests
	Timer B0 to timer B5 interrupt requests
	UART0 transfer and reception interrupt requests
	UART1 transfer and reception interrupt requests
	UART2 transfer and reception interrupt requests
	A-D conversion interrupt requests
	Software triggers
Channel priority	DMA0 takes precedence if DMA0 and DMA1 requests are generated simultaneously
Transfer unit	8 bits or 16 bits
Transfer address direction	forward/fixed (forward direction cannot be specified for both source and
	destination simultaneously)
Transfer mode	Single transfer mode
	After the transfer counter underflows, the DMA enable bit turns to
	"0", and the DMAC turns inactive
	Repeat transfer mode
	After the transfer counter underflows, the value of the transfer counter
	reload register is reloaded to the transfer counter.
	The DMAC remains active unless a "0" is written to the DMA enable bit.
DMA interrupt request generation timing	When an underflow occurs in the transfer counter
Active	When the DMA enable bit is set to "1", the DMAC is active.
Active	When the DMAC is active, data transfer starts every time a DMA
	transfer request signal occurs.
In a stirre	
Inactive	When the DMA enable bit is set to "0", the DMAC is inactive.
	After the transfer counter underflows in single transfer mode At the time of starting data transfer invariant to a PMAC action the
Reload timing for forward ad-	At the time of starting data transfer immediately after turning the DMAC active, the
dress pointer and transfer	value of one of source pointer and destination pointer - the one specified for the
counter	forward direction - is reloaded to the forward direction address pointer, and the value
	of the transfer counter reload register is reloaded to the transfer counter.
Writing to register	Registers specified for forward direction transfer are always write enabled.
	Registers specified for fixed address transfer are write-enabled when
	the DMA enable bit is "0".
Reading the register	Can be read at any time.
	However, when the DMA enable bit is "1", reading the register set up as the
	forward register is the same as reading the value of the forward address pointer.

Note: DMA transfer is not effective to any interrupt. DMA transfer is affected neither by the interrupt enable flag (I flag) nor by the interrupt priority level.



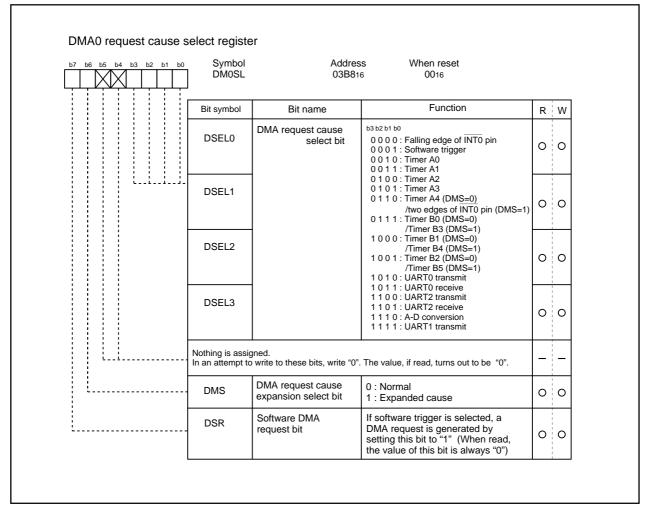


Figure 1.12.2. DMAC register (1)

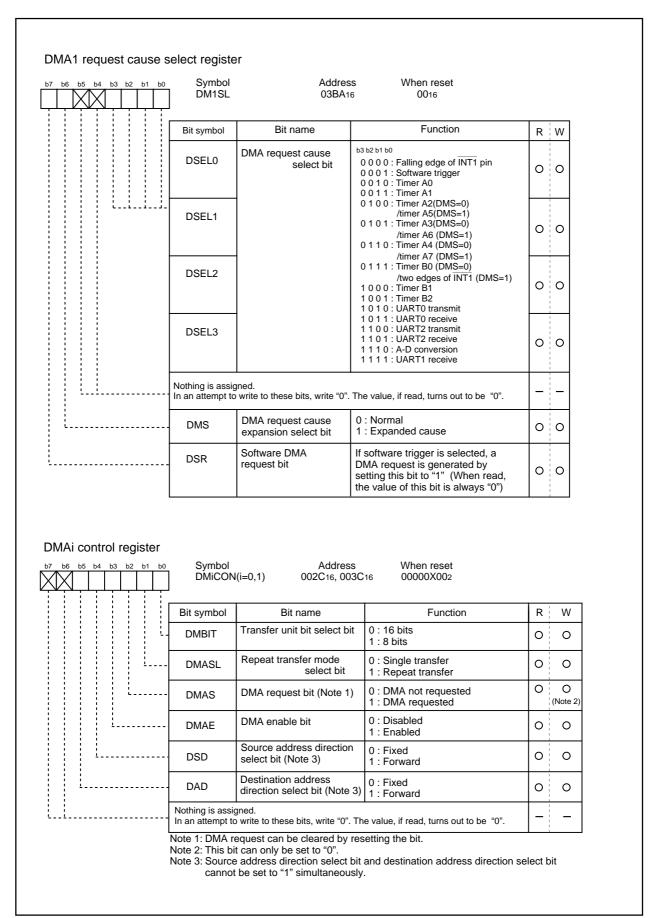


Figure 1.12.3. DMAC register (2)



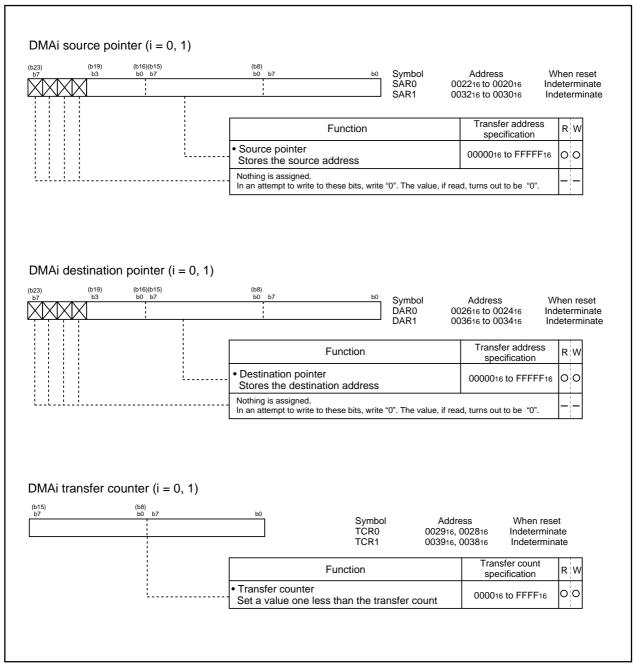


Figure 1.12.4. DMAC register (3)

(1) Transfer cycle

The transfer cycle consists of the bus cycle in which data is read from memory or from the SFR area (source read) and the bus cycle in which the data is written to memory or to the SFR area (destination write). The number of read and write bus cycles depends on the source and destination addresses. Also, the bus cycle itself is longer when software waits are inserted.

(a) Effect of source and destination addresses

When 16-bit data is transferred on a 16-bit data bus, and the source and destination both start at odd addresses, there are one more source read cycle and destination write cycle than when the source and destination both start at even addresses.

(b) Effect of software wait

When the SFR area or a memory area with a software wait is accessed, the number of cycles is increased for the wait by 1 bus cycle. The length of the cycle is determined by BCLK.

Figure 1.12.5 shows the example of the transfer cycles for a source read. For convenience, the destination write cycle is shown as one cycle and the source read cycles for the different conditions are shown. In reality, the destination write cycle is subject to the same conditions as the source read cycle, with the transfer cycle changing accordingly. When calculating the transfer cycle, remember to apply the respective conditions to both the destination write cycle and the source read cycle.



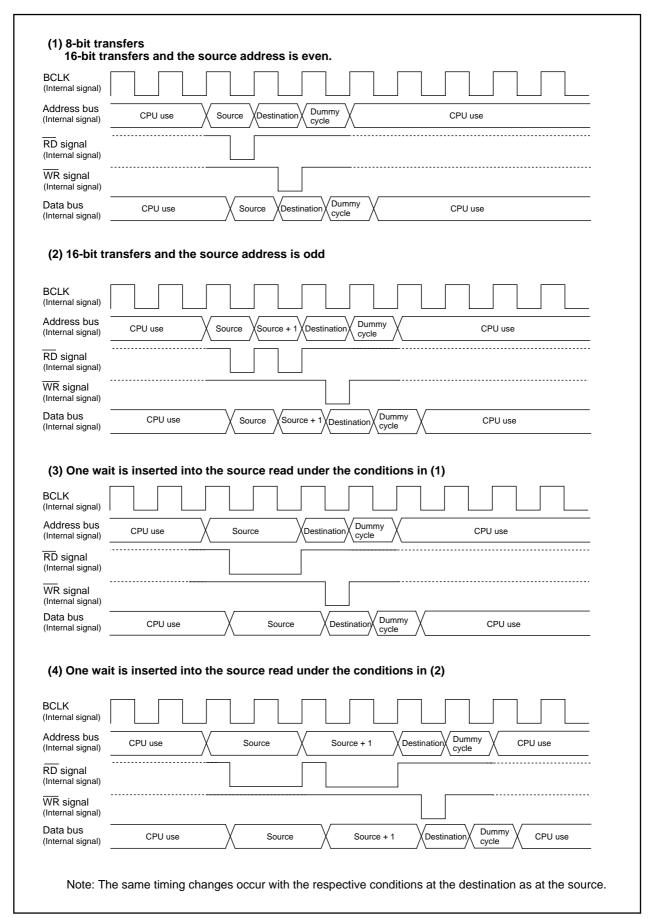


Figure 1.12.5. Example of the transfer cycles for a source read



(2) DMAC transfer cycles

Any combination of even or odd transfer read and write addresses is possible. Table 1.12.2 shows the number of DMAC transfer cycles.

The number of DMAC transfer cycles can be calculated as follows:

No. of transfer cycles per transfer unit = No. of read cycles x j + No. of write cycles x k

Table 1.12.2. No. of DMAC transfer cycles

Transfer unit	Access address	No. of read cycles	No. of read cycles
8-bit transfers	Even	1	1
(DMBIT= "1")	Odd	1	1
16-bit transfers	Even	1	1
(DMBIT= "0")	Odd	2	2

Coefficient j, k

Internal memory			
Internal ROM/RAM	Internal ROM/RAM	SFR area	
No wait	With wait		
1	2	2	



DMA enable bit

Setting the DMA enable bit to "1" makes the DMAC active. The DMAC carries out the following operations at the time data transfer starts immediately after DMAC is turned active.

- (1) Reloads the value of one of the source pointer and the destination pointer the one specified for the forward direction to the forward direction address pointer.
- (2) Reloads the value of the transfer counter reload register to the transfer counter.

Thus overwriting "1" to the DMA enable bit with the DMAC being active carries out the operations given above, so the DMAC operates again from the initial state at the instant "1" is overwritten to the DMA enable bit.

DMA request bit

The DMAC can generate a DMA transfer request signal triggered by a factor chosen in advance out of DMA request factors for each channel.

DMA request factors include the following.

- * Factors effected by using the interrupt request signals from the built-in peripheral functions and software DMA factors (internal factors) effected by a program.
- * External factors effected by utilizing the input from external interrupt signals.

For the selection of DMA request factors, see the descriptions of the DMAi factor selection register.

The DMA request bit turns to "1" if the DMA transfer request signal occurs regardless of the DMAC's state (regardless of whether the DMA enable bit is set "1" or "0"). It turns to "0" immediately before data transfer starts.

In addition, it can be set to "0" by use of a program, but cannot be set to "1".

There can be instances in which a change in DMA request factor selection bit causes the DMA request bit to turn to "1". So be sure to set the DMA request bit to "0" after the DMA request factor selection bit is changed.

The DMA request bit turns to "1" if a DMA transfer request signal occurs, and turns to "0" immediately before data transfer starts. If the DMAC is active, data transfer starts immediately, so the value of the DMA request bit, if read by use of a program, turns out to be "0" in most cases. To examine whether the DMAC is active, read the DMA enable bit.

Here follows the timing of changes in the DMA request bit.

(1) Internal factors

Except the DMA request factors triggered by software, the timing for the DMA request bit to turn to "1" due to an internal factor is the same as the timing for the interrupt request bit of the interrupt control register to turn to "1" due to several factors.

Turning the DMA request bit to "0" due to an internal factor is timed to be effected immediately before the transfer starts.

(2) External factors

An external factor is a factor caused to occur by the leading edge of input from the INTi pin (i depends on which DMAC channel is used).

Selecting the INTi pins as external factors using the DMA request factor selection bit causes input from these pins to become the DMA transfer request signals.

The timing for the DMA request bit to turn to "1" when an external factor is selected synchronizes with the signal's edge applicable to the function specified by the DMA request factor selection bit (synchronizes with the trailing edge of the input signal to each INTi pin, for example).

With an external factor selected, the DMA request bit is timed to turn to "0" immediately before data transfer starts similarly to the state in which an internal factor is selected.



(3) The priorities of channels and DMA transfer timing

If a DMA transfer request signal falls on a single sampling cycle (a sampling cycle means one period from the leading edge to the trailing edge of BCLK), the DMA request bits of applicable channels concurrently turn to "1". If the channels are active at that moment, DMA0 is given a high priority to start data transfer. When DMA0 finishes data transfer, it gives the bus right to the CPU. When the CPU finishes single bus access, then DMA1 starts data transfer and gives the bus right to the CPU.

An example in which DMA transfer is carried out in minimum cycles at the time when DMA transfer request signals due to external factors concurrently occur.

Figure 1.12.6 An example of DMA transfer effected by external factors.

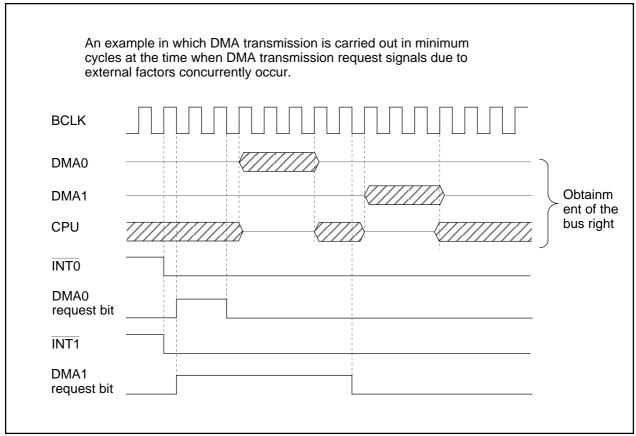


Figure 1.12.6. An example of DMA transfer effected by external factors



Timer

There are fourteen 16-bit timers. These timers can be classified by function into timers A (eight) and timers B (six). All these timers function independently. Figures 1.13.1 and 1.13.2 show the block diagram of timers.

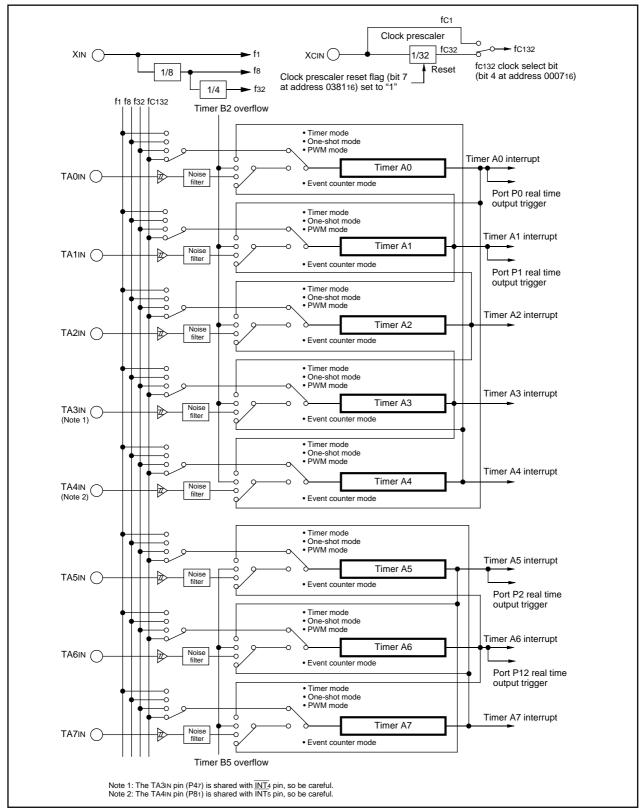


Figure 1.13.1. Timer A block diagram



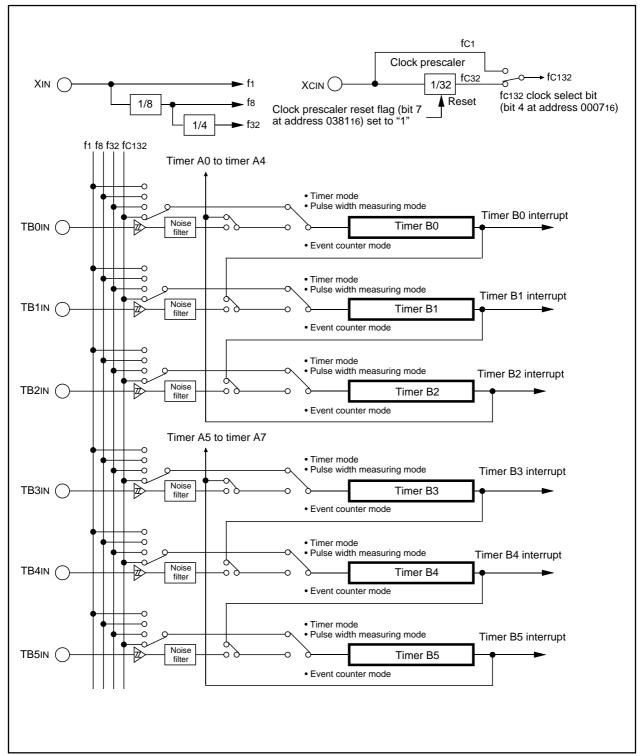


Figure 1.13.2. Timer B block diagram



Timer A

Figure 1.13.3 shows the block diagram of timer A. Figures 1.13.4 to 1.13.8 show the timer A-related registers.

Use the timer Ai mode register (i = 0 to 7) bits 0 and 1 to choose the desired mode.

Timer A has the four operation modes listed as follows:

- Timer mode: The timer counts an internal count source.
- Event counter mode: The timer counts pulses from an external source or a timer over flow.
- One-shot timer mode: The timer stops counting when the count reaches "000016".
- Pulse width modulation (PWM) mode: The timer outputs pulses of a given width.

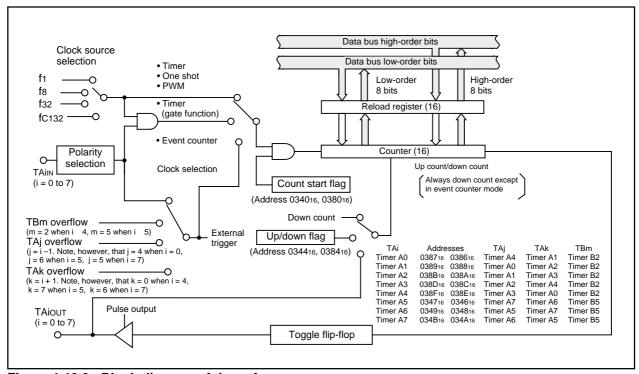


Figure 1.13.3. Block diagram of timer A

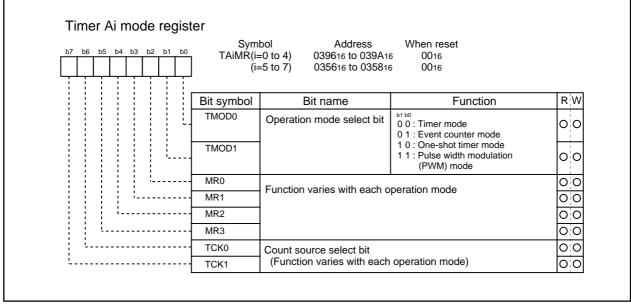


Figure 1.13.4. Timer A-related registers (1)



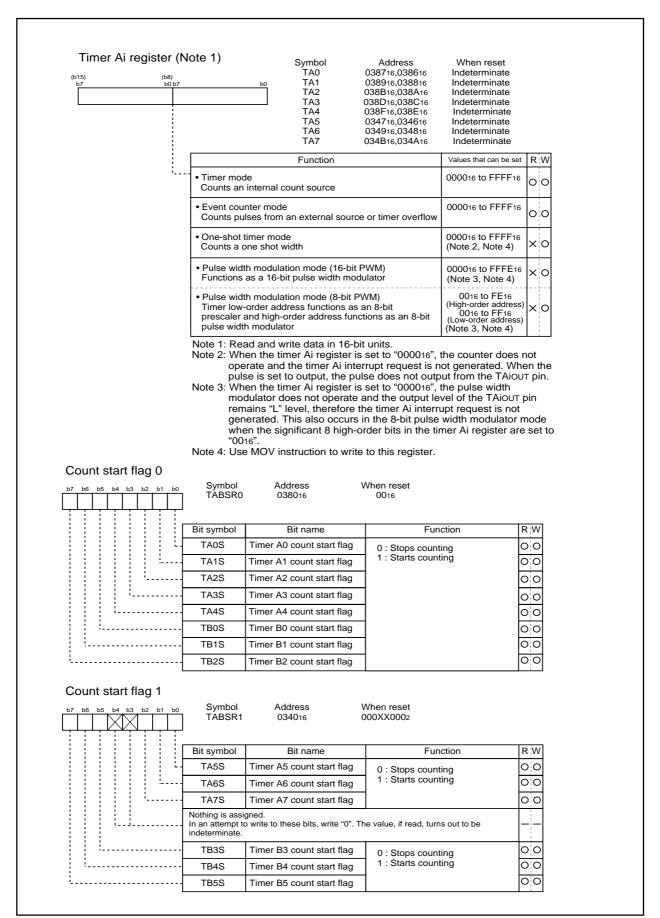


Figure 1.13.5. Timer A-related registers (2)



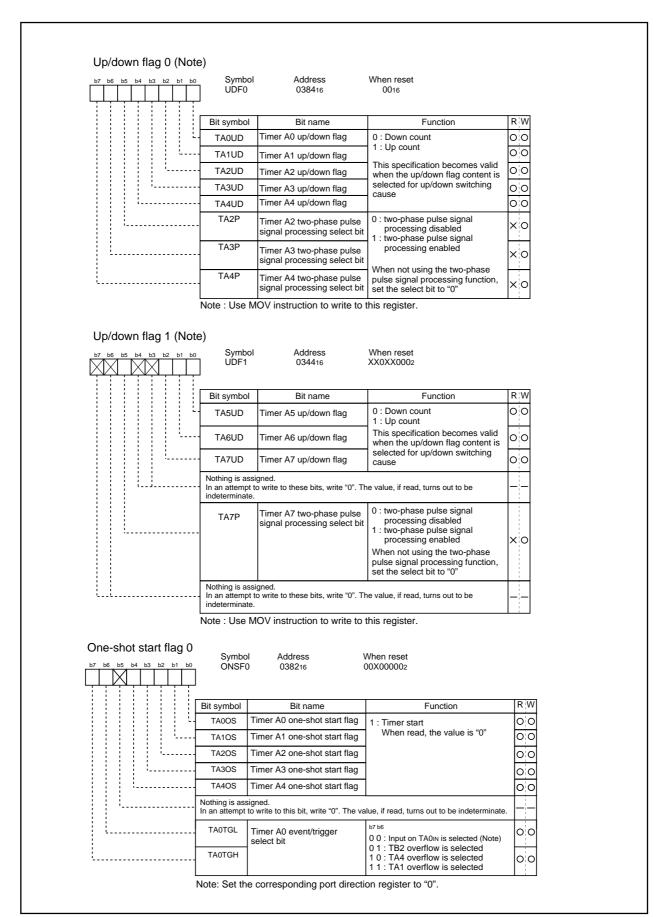


Figure 1.13.6. Timer A-related registers (3)



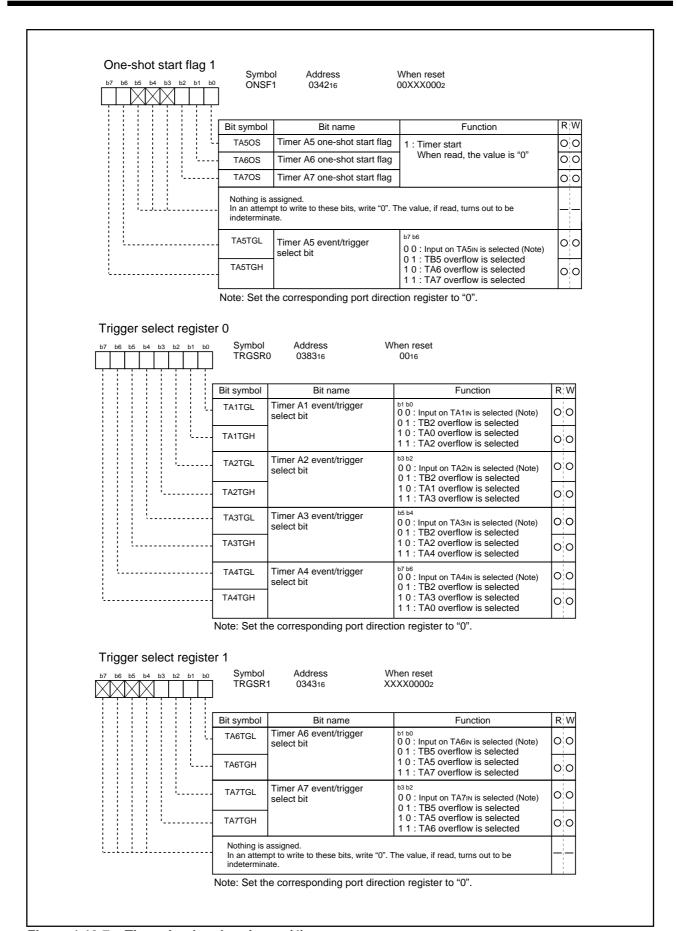


Figure 1.13.7. Timer A-related registers (4)



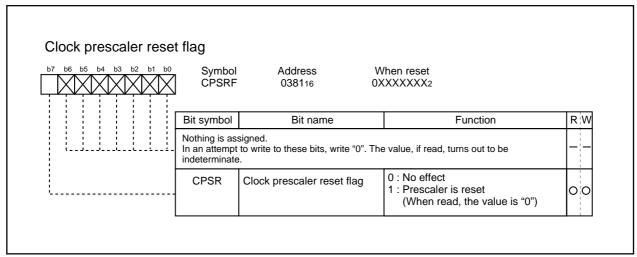


Figure 1.13.8. Timer A-related registers (5)

(1) Timer mode

In this mode, the timer counts an internally generated count source. (See Table 1.13.1.) Figure 1.13.9 shows the timer Ai mode register in timer mode.

Table 1.13.1. Specifications of timer mode

Item	Specification	
Count source	f1, f8, f32, fC132	
Count operation	Down count	
	When the timer underflows, it reloads the reload register contents before continuing counting	
Divide ratio	1/(n+1) n : Set value	
Count start condition	Count start flag is set (= 1)	
Count stop condition	Count start flag is reset (= 0)	
Interrupt request generation timing	When the timer underflows	
TAilN pin function	Programmable I/O port or gate input	
TAiout pin function	Programmable I/O port or pulse output	
Read from timer	Count value can be read out by reading timer Ai register	
Write to timer	When counting stopped	
	When a value is written to timer Ai register, it is written to both reload register and counter	
	When counting in progress	
	When a value is written to timer Ai register, it is written to only reload register	
	(Transferred to counter at next reload time)	
Select function	Gate function	
	Counting can be started and stopped by the TAilN pin's input signal	
	Pulse output function	
	Each time the timer underflows, the TAio∪T pin's polarity is reversed	

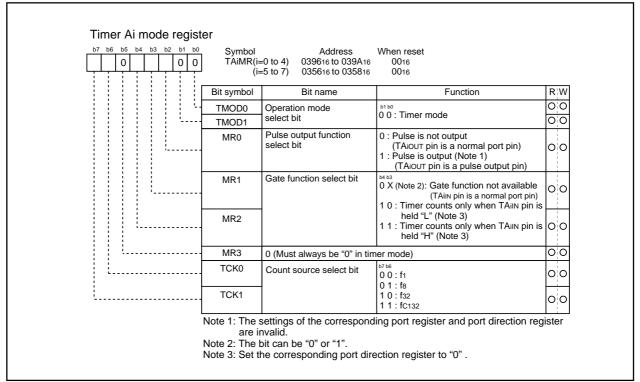


Figure 1.13.9. Timer Ai mode register in timer mode



(2) Event counter mode

In this mode, the timer counts an external signal or an internal timer's overflow. Timers A0, A1, A5 and A6 can count a single-phase external signal. Timers A2, A3, A4 and A7 can count a single-phase and a two-phase external signal. Table 1.13.2 lists timer specifications when counting a single-phase external signal. Figure 1.13.10 shows the timer Ai mode register in event counter mode.

Table 1.13.3 lists timer specifications when counting a two-phase external signal. Figure 1.13.11 shows the timer Ai mode register in event counter mode.

Table 1.13.2. Timer specifications in event counter mode (when not processing two-phase pulse signal)

Item	Specification		
Count source	External signals input to TAilN pin (effective edge can be selected by software)		
	TB2 overflow, TB5 overflow, TAj overflow, TAk overflow		
Count operation	Up count or down count can be selected by external signal or software		
	When the timer overflows or underflows, it reloads the reload register co		
	tents before continuing counting (Note)		
Divide ratio	1/ (FFFF16 - n + 1) for up count		
	1/ (n + 1) for down count n : Set value		
Count start condition	Count start flag is set (= 1)		
Count stop condition	Count start flag is reset (= 0)		
Interrupt request generation timing	The timer overflows or underflows		
TAilN pin function	Programmable I/O port or count source input		
TAiout pin function	Programmable I/O port, pulse output, or up/down count select input		
Read from timer	Count value can be read out by reading timer Ai register		
Write to timer	When counting stopped		
	When a value is written to timer Ai register, it is written to both reload register and counter		
	When counting in progress		
	When a value is written to timer Ai register, it is written to only reload register		
	(Transferred to counter at next reload time)		
Select function	Free-run count function		
	Even when the timer overflows or underflows, the reload register content is not reloaded to it		
	Pulse output function		
	Each time the timer overflows or underflows, the TAiOUT pin's polarity is reversed		

Note: This does not apply when the free-run function is selected.

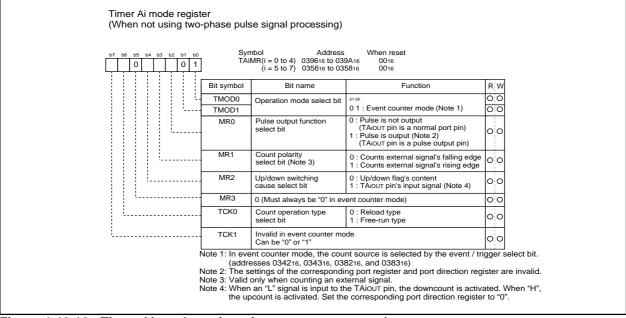


Figure 1.13.10. Timer Ai mode register in event counter mode



Table 1.13.3. Timer specifications in event counter mode (when processing two-phase pulse signal with timers A2, A3, A4 and A7)

Item	Specification	
Count source	• Two-phase pulse signals input to TAiIN or TAiOUT pin	
Count operation	Up count or down count can be selected by two-phase pulse signal	
	When the timer overflows or underflows, the reload register content is	
	reloaded and the timer starts over again (Note 1)	
Divide ratio	1/ (FFFF16 - n + 1) for up count	
	1/ (n + 1) for down count n : Set value	
Count start condition	Count start flag is set (= 1)	
Count stop condition	Count start flag is reset (= 0)	
Interrupt request generation timing	Timer overflows or underflows	
TAilN pin function	Two-phase pulse input	
TAiout pin function	Two-phase pulse input	
Read from timer	Count value can be read out by reading timer A2, A3, A4 or A7 register	
Write to timer	When counting stopped	
	When a value is written to timer A2, A3, A4 or A7 register, it is written to both	
	reload register and counter	
	When counting in progress	
	When a value is written to timer A2, A3, A4 or A7 register, it is written to only	
	reload register. (Transferred to counter at next reload time.)	
Select function (Note 2)	Normal processing operation	
(The timer counts up rising edges or counts down falling edges on the TAilN	
	pin when input signal on the TAio∪⊤ pin is "H"	
	TAIOUT _ L L L	
	TAINfff V V	
	(i=2, 3, 7) Up Up Up Down Down count count count count count count	
	Multiply-by-4 processing operation	
	If the phase relationship is such that the TAilN pin goes "H" when the input	
	signal on the TAio∪T pin is "H", the timer counts up rising and falling edges	
	on the TAiout and TAin pins. If the phase relationship is such that the	
	TAilN pin goes "L" when the input signal on the TAio∪T pin is "H", the timer	
	counts down rising and falling edges on the TAio∪T and TAiiN pins.	
	TAIOUT A VA VA VA V	
	Count up all edges Count down all edges	
	TAIIN	
	(i=3, 4)	
	Count up all edges Count down all edges	

Note 1: This does not apply when the free-run function is selected.

Note 2: Timer A3 alone can be selected. Timer A2 and timer A7 are fixed to normal processing operation, and timer A4 is fixed to multiply-by-4 processing operation.



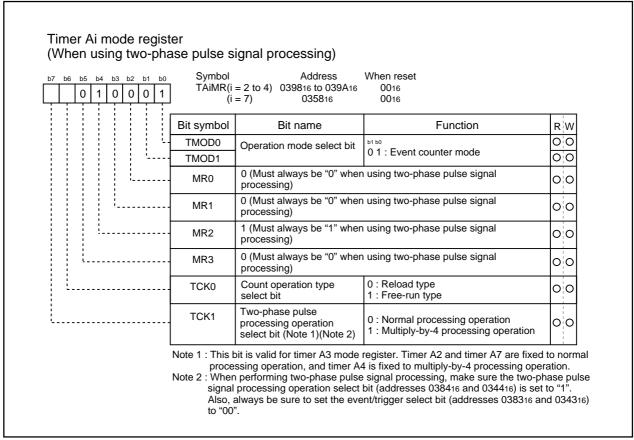


Figure 1.13.11. Timer Ai mode register in event counter mode

(3) One-shot timer mode

In this mode, the timer operates only once. (See Table 1.13.4.) When a trigger occurs, the timer starts up and continues operating for a given period. Figure 1.13.12 shows the timer Ai mode register in one-shot timer mode.

Table 1.13.4. Timer specifications in one-shot timer mode

Item	Specification	
Count source	f1, f8, f32, fC132	
Count operation	The timer counts down	
	When the count reaches 000016, the timer stops counting after reloading a new count	
	If a trigger occurs when counting, the timer reloads a new count and restarts counting	
Divide ratio	1/n n : Set value	
Count start condition	An external trigger is input	
	The timer overflows	
	• The one-shot start flag is set (= 1)	
Count stop condition	A new count is reloaded after the count has reached 000016	
	• The count start flag is reset (= 0)	
Interrupt request generation timing	The count reaches 000016	
TAin pin function	Programmable I/O port or trigger input	
TAio∪T pin function	Programmable I/O port or pulse output	
Read from timer	When timer Ai register is read, it indicates an indeterminate value	
Write to timer	When counting stopped	
	When a value is written to timer Ai register, it is written to both reload	
	register and counter	
	When counting in progress	
	When a value is written to timer Ai register, it is written to only reload register	
	(Transferred to counter at next reload time)	

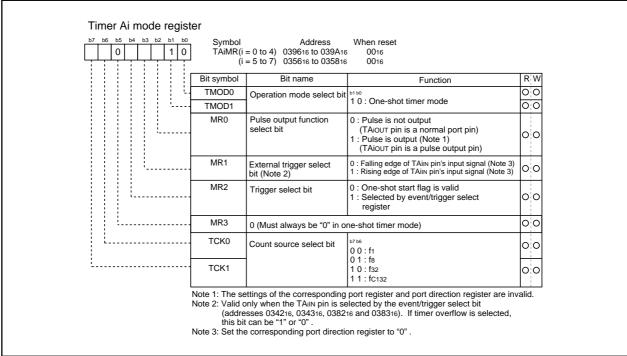


Figure 1.13.12. Timer Ai mode register in one-shot timer mode



(4) Pulse width modulation (PWM) mode

In this mode, the timer outputs pulses of a given width in succession. (See Table 1.13.5.) In this mode, the counter functions as either a 16-bit pulse width modulator or an 8-bit pulse width modulator. Figure 1.13.13 shows the timer Ai mode register in pulse width modulation mode. Figure 1.13.14 shows the example of how a 16-bit pulse width modulator operates. Figure 1.13.15 shows the example of how an 8-bit pulse width modulator operates.

Table 1.13.5. Timer specifications in pulse width modulation mode

Item	Specification		
Count source	f1, f8, f32, fC132		
Count operation	The timer counts down (operating as an 8-bit or a 16-bit pulse width modulator)		
	The timer reloads a new count at a rising edge of PWM pulse and continues countin		
	The timer is not affected by a trigger that occurs when counting		
16-bit PWM	High level width n / fj n : Set value fj=f1, f8, f32, fC132		
	Cycle time (2 ¹⁶ -1) / fj fixed		
8-bit PWM	High level width n×(m+1) / fj n : values set to timer Ai register's high-order address		
	• Cycle time (2 ⁸ -1)×(m+1) / fj m : values set to timer Ai register's low-order address		
Count start condition	External trigger is input		
	The timer overflows		
	The count start flag is set (= 1)		
Count stop condition	• The count start flag is reset (= 0)		
Interrupt request generation timing	PWM pulse goes "L"		
TAilN pin function	Programmable I/O port or trigger input		
TAiout pin function	Pulse output		
Read from timer	When timer Ai register is read, it indicates an indeterminate value		
Write to timer	When counting stopped		
	When a value is written to timer Ai register, it is written to both reload		
	register and counter		
	When counting in progress		
	When a value is written to timer Ai register, it is written to only reload register		
	(Transferred to counter at next reload time)		

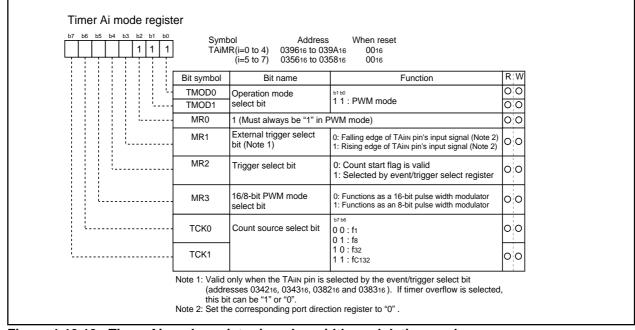


Figure 1.13.13. Timer Ai mode register in pulse width modulation mode



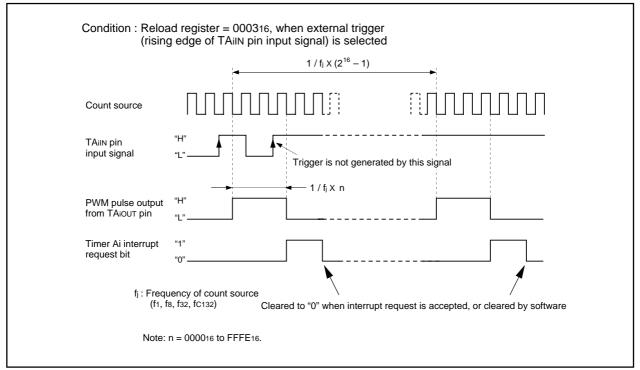


Figure 1.13.14. Example of how a 16-bit pulse width modulator operates

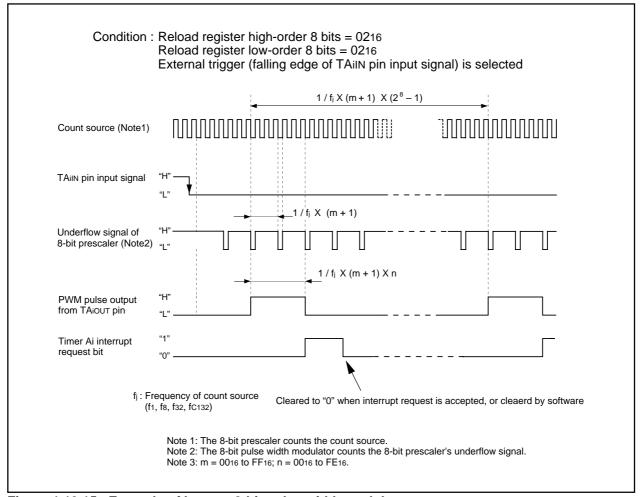


Figure 1.13.15. Example of how an 8-bit pulse width modulator operates



Timer B

Figure 1.13.16 shows the block diagram of timer B. Figures 1.13.17 and 1.13.18 show the timer B-related registers.

Use the timer Bi mode register (i = 0 to 5) bits 0 and 1 to choose the desired mode.

Timer B has three operation modes listed as follows:

- Timer mode: The timer counts an internal count source.
- Event counter mode: The timer counts pulses from an external source or a timer overflow.
- Pulse period/pulse width measuring mode: The timer measures an external signal's pulse period or pulse width.

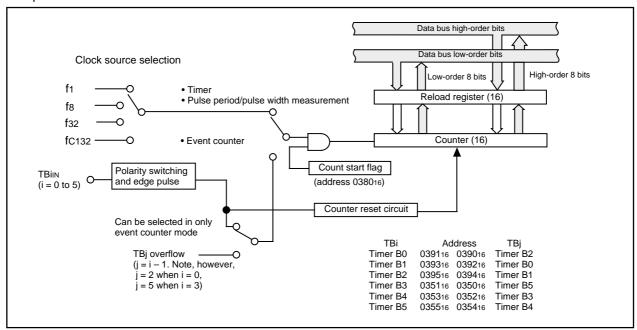


Figure 1.13.16. Block diagram of timer B

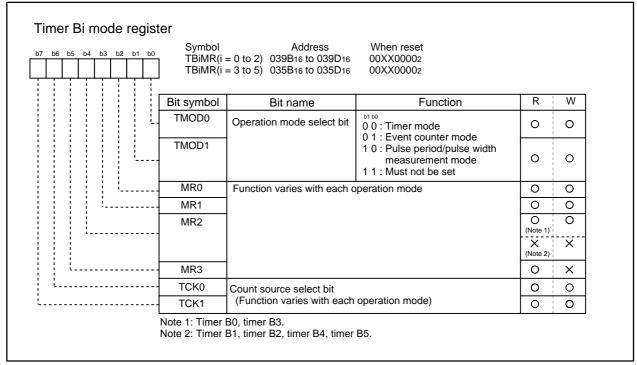


Figure 1.13.17. Timer B-related registers (1)



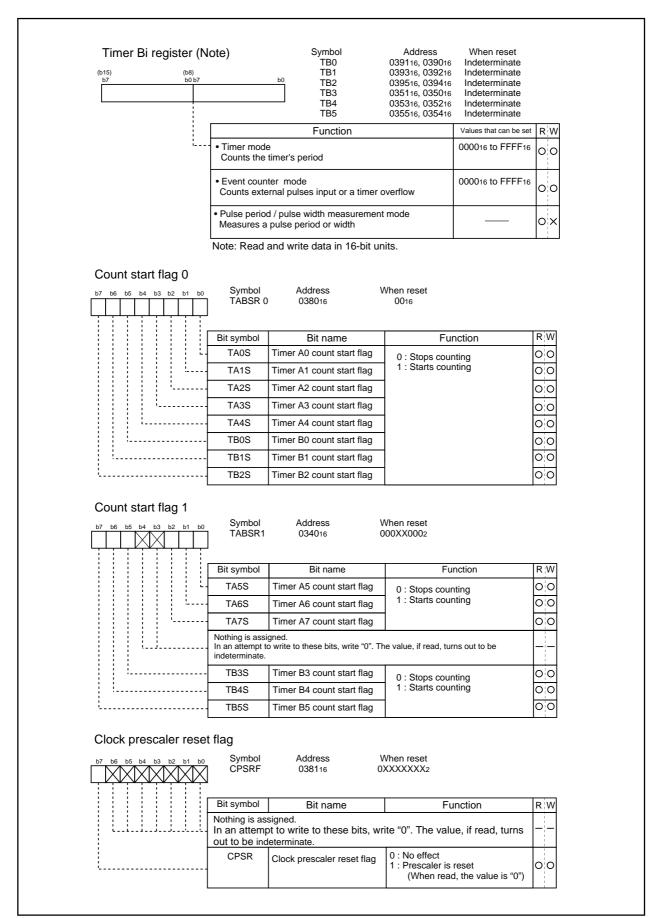


Figure 1.13.18. Timer B-related registers (2)



(1) Timer mode

In this mode, the timer counts an internally generated count source. (See Table 1.13.6.) Figure 1.13.19 shows the timer Bi mode register in timer mode.

Table 1.13.6. Timer specifications in timer mode

Item	Specification	
Count source	f1, f8, f32, fC132	
Count operation	Counts down	
	When the timer underflows, it reloads the reload register contents before	
	continuing counting	
Divide ratio	1/(n+1) n : Set value	
Count start condition	Count start flag is set (= 1)	
Count stop condition	Count start flag is reset (= 0)	
Interrupt request generation timing	The timer underflows	
TBilN pin function	Programmable I/O port	
Read from timer	Count value is read out by reading timer Bi register	
Write to timer	When counting stopped	
	When a value is written to timer Bi register, it is written to both reload register and counter	
	When counting in progress	
	When a value is written to timer Bi register, it is written to only reload register	
	(Transferred to counter at next reload time)	

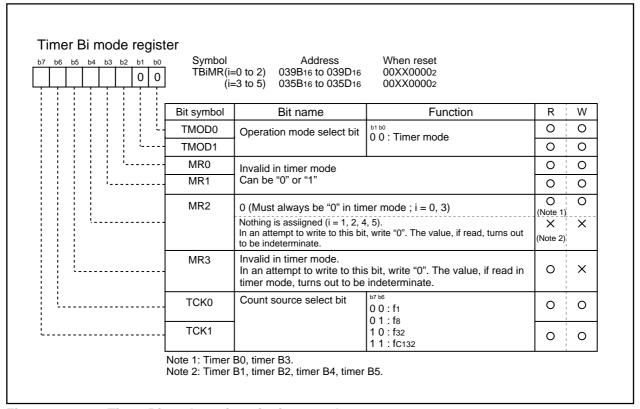


Figure 1.13.19. Timer Bi mode register in timer mode

(2) Event counter mode

In this mode, the timer counts an external signal or an internal timer's overflow. (See Table 1.13.7.) Figure 1.13.20 shows the timer Bi mode register in event counter mode.

Table 1.13.7. Timer specifications in event counter mode

Item	Specification		
Count source	• External signals input to TBiln pin		
	• Effective edge of count source can be a rising edge, a falling edge, or falling		
	and rising edges as selected by software		
Count operation	Counts down		
	When the timer underflows, it reloads the reload register contents before		
	continuing counting		
Divide ratio	1/(n+1) n : Set value		
Count start condition	Count start flag is set (= 1)		
Count stop condition	Count start flag is reset (= 0)		
Interrupt request generation timing	The timer underflows		
TBiin pin function	Count source input		
Read from timer	Count value can be read out by reading timer Bi register		
Write to timer	When counting stopped		
	When a value is written to timer Bi register, it is written to both reload register and counter		
	When counting in progress		
	When a value is written to timer Bi register, it is written to only reload register		
	(Transferred to counter at next reload time)		

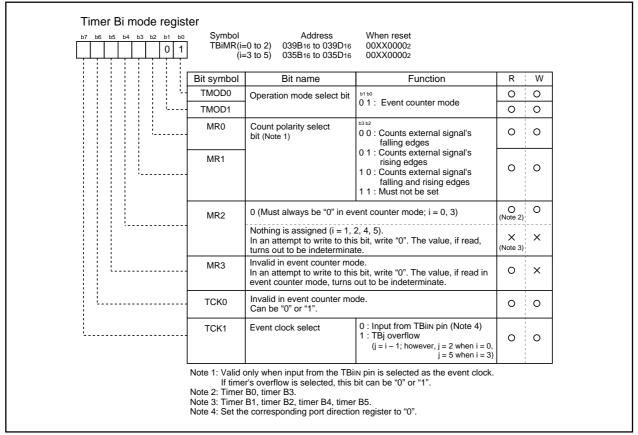


Figure 1.13.20. Timer Bi mode register in event counter mode



(3) Pulse period/pulse width measurement mode

In this mode, the timer measures the pulse period or pulse width of an external signal. (See Table 1.13.8.) Figure 1.13.21 shows the timer Bi mode register in pulse period/pulse width measurement mode. Figure 1.13.22 shows the operation timing when measuring a pulse period. Figure 1.13.23 shows the operation timing when measuring a pulse width.

Table 1.13.8. Timer specifications in pulse period/pulse width measurement mode

Item	Specification		
Count source	f1, f8, f32, fC132		
Count operation	• Up count		
	Counter value "000016" is transferred to reload register at measurement		
	pulse's effective edge and the timer continues counting		
Count start condition	Count start flag is set (= 1)		
Count stop condition	Count start flag is reset (= 0)		
Interrupt request generation timing	When measurement pulse's effective edge is input (Note 1)		
	When an overflow occurs. (Simultaneously, the timer Bi overflow flag		
	changes to "1". The timer Bi overflow flag changes to "0" when the count		
	start flag is "1" and a value is written to the timer Bi mode register.)		
TBil pin function Measurement pulse input			
Read from timer	When timer Bi register is read, it indicates the reload register's content		
	(measurement result) (Note 2)		
Write to timer	Cannot be written to		

Note 1: An interrupt request is not generated when the first effective edge is input after the timer has started counting. Note 2: The value read out from the timer Bi register is indeterminate until the second effective edge is input after the timer.

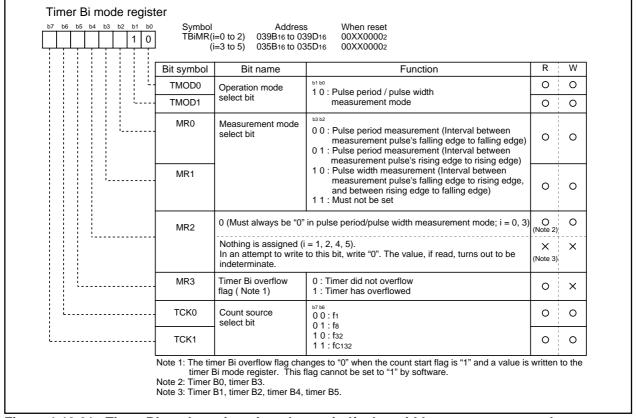


Figure 1.13.21. Timer Bi mode register in pulse period/pulse width measurement mode



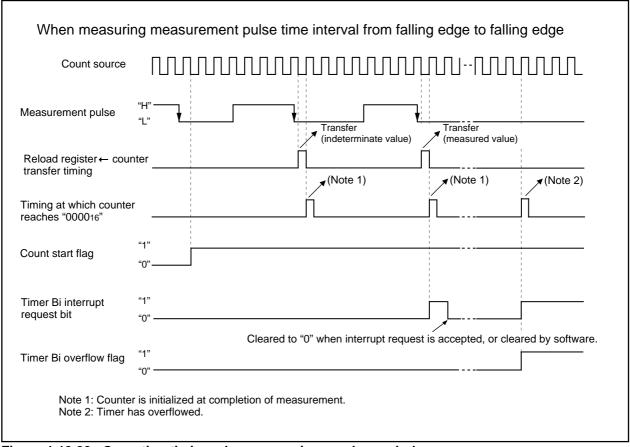


Figure 1.13.22. Operation timing when measuring a pulse period

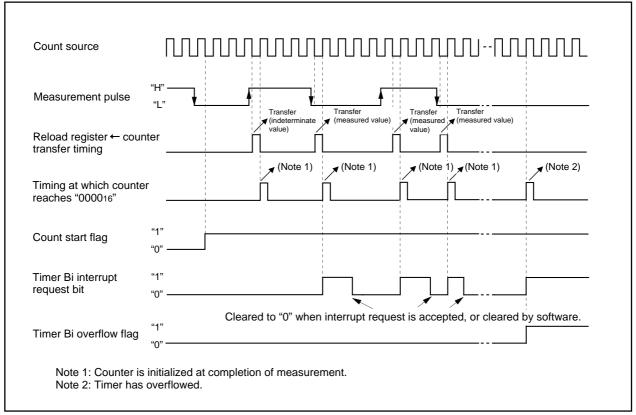


Figure 1.13.23. Operation timing when measuring a pulse width



Real time Port

When real time port output is selected, the real time port data written to the port Pm register is latched into the real time port latch each time the corresponding timer Ai underflows, with the data output from each corresponding port. The real time port data is written to the corresponding port Pm register. When the real time port mode select bit changes state from "0" to "1", the value of the real time port latch becomes "0", which is output from the corresponding pin. It is when timer Ai underflows first that the real time port data is output. If the real time port data is modified when the real time port function is enabled, the modified value is output when timer Ai underflows next time. The port functions as an ordinary port when the real time port function is disabled.

Make sure timer Ai for real time port output is set for timer mode, and is set to have "no gate function" using the gate function select bit. Also, before setting the real time port mode select bit to "1", temporarily turn off the timer Ai used and write its set value to the timer Ai register. Figure 1.14.1 shows the block diagram for real time port output. Figure 1.14.2 shows the real time control register.

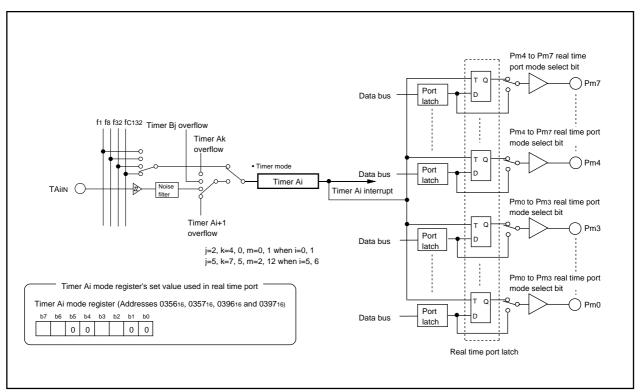


Figure 1.14.1. Block diagram for real time port output

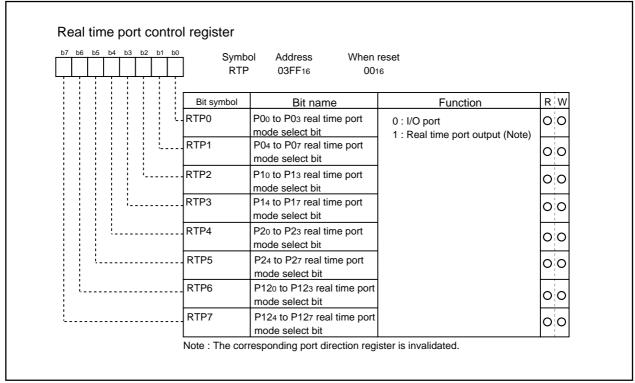


Figure 1.14.2. Real time port control register

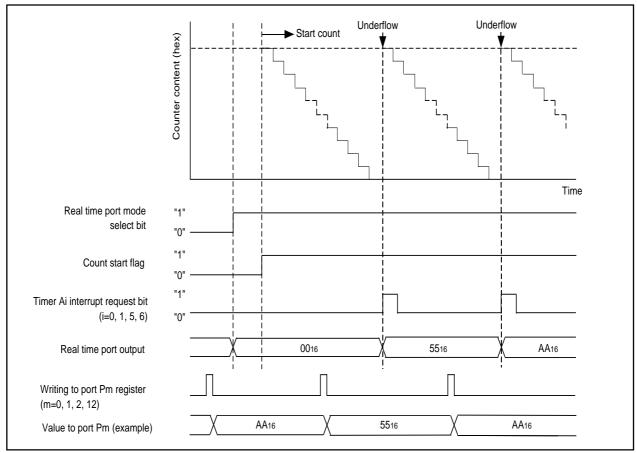


Figure 1.14.3. Timing in real time port output operation



Serial I/O

Serial I/O is configured as three channels: UART0, UART1, UART2.

UART0 to 2

UART0, UART1 and UART2 each have an exclusive timer to generate a transfer clock, so they operate independently of each other.

Figure 1.15.1 shows the block diagram of UART0, UART1 and UART2. Figures 1.15.2 and 1.15.3 show the block diagram of the transmit/receive unit.

UARTi (i = 0 to 2) has two operation modes: a clock synchronous serial I/O mode and a clock asynchronous serial I/O mode (UART mode). The contents of the serial I/O mode select bits (bits 0 to 2 at addresses 03A016, 03A816 and 037816) determine whether UARTi is used as a clock synchronous serial I/O or as a UART. Although a few functions are different, UART0, UART1 and UART2 have almost the same functions. UART2, in particular, is used for the SIM interface with some extra settings added in clock-asynchronous serial I/O mode (Note). It also has the bus collision detection function that generates an interrupt request if the TxD pin and the RxD pin are different in level.

Table 1.15.1 shows the comparison of functions of UART0 through UART2, and Figures 1.15.4 to 1.15.8 show the registers related to UARTi.

Note: SIM: Subscriber Identity Module

Table 1.15.1. Comparison of functions of UART0 through UART2

Function	UART0	UART1	UART2
CLK polarity selection	Possible (Note 1)	Possible (Note 1)	Possible (Note 1)
LSB first / MSB first selection	Possible (Note 1)	Possible (Note 1)	Possible (Note 2)
Continuous receive mode selection	Possible (Note 1)	Possible (Note 1)	Possible (Note 1)
Transfer clock output from multiple pins selection	Impossible	Possible (Note 1)	Impossible
Serial data logic switch	Impossible	Impossible	Possible (Note 4)
Sleep mode selection	Possible (Note 3)	Possible (Note 3)	Impossible
TxD, RxD I/O polarity switch	Impossible	Impossible	Possible
TxD, RxD port output format	CMOS output	CMOS output	N-channel open-drain output
Parity error signal output	Impossible	Impossible	Possible (Note 4)
Bus collision detection	Impossible	Impossible	Possible

Note 1: Only when clock synchronous serial I/O mode.

Note 2: Only when clock synchronous serial I/O mode and 8-bit UART mode.

Note 3: Only when UART mode.

Note 4: Using for SIM interface.



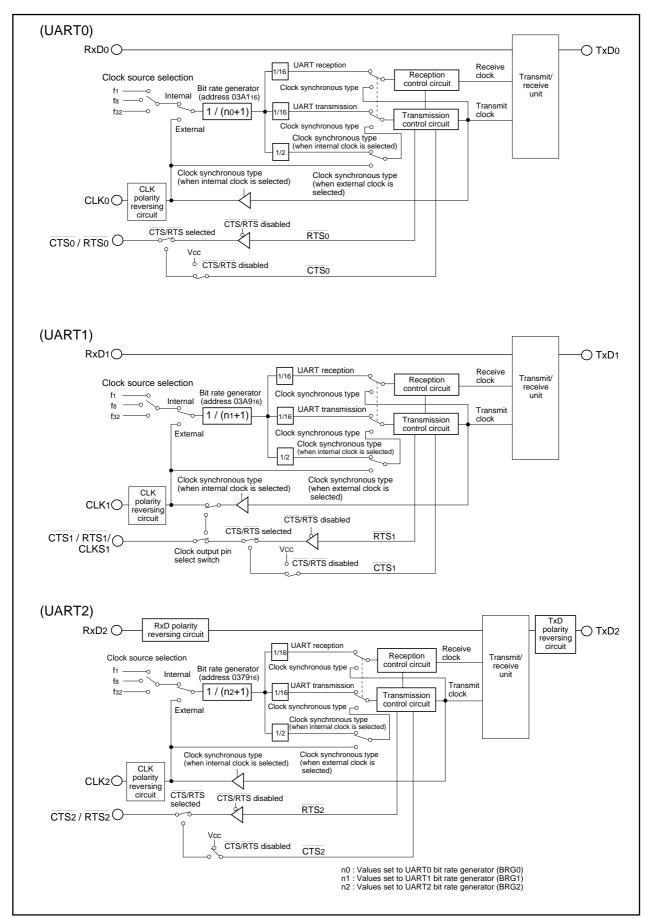


Figure 1.15.1. Block diagram of UARTi (i = 0 to 2)



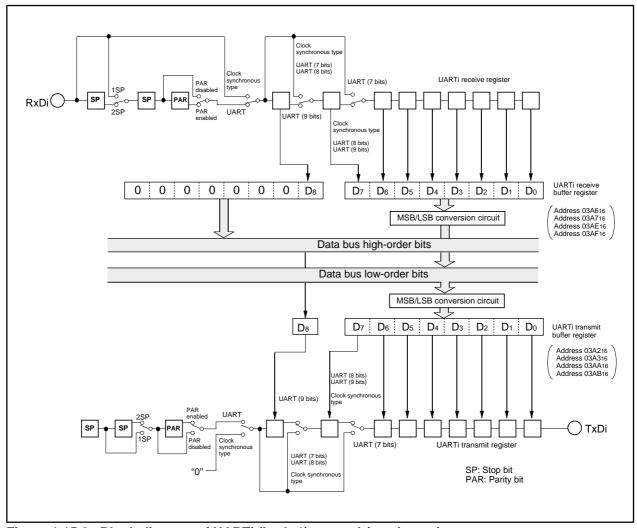


Figure 1.15.2. Block diagram of UARTi (i = 0, 1) transmit/receive unit

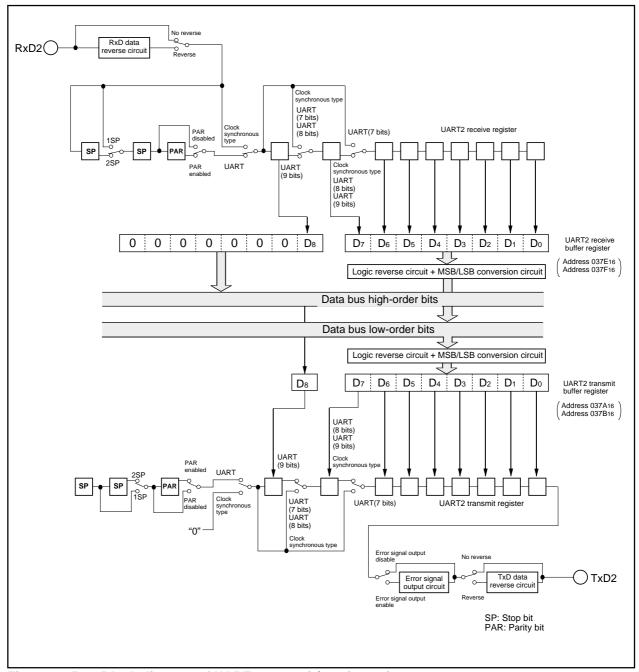


Figure 1.15.3. Block diagram of UART2 transmit/receive unit

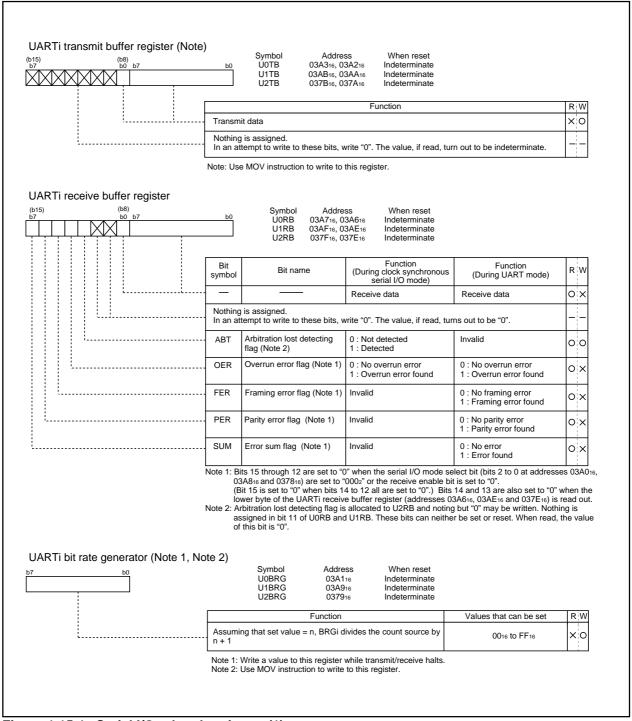


Figure 1.15.4. Serial I/O-related registers (1)

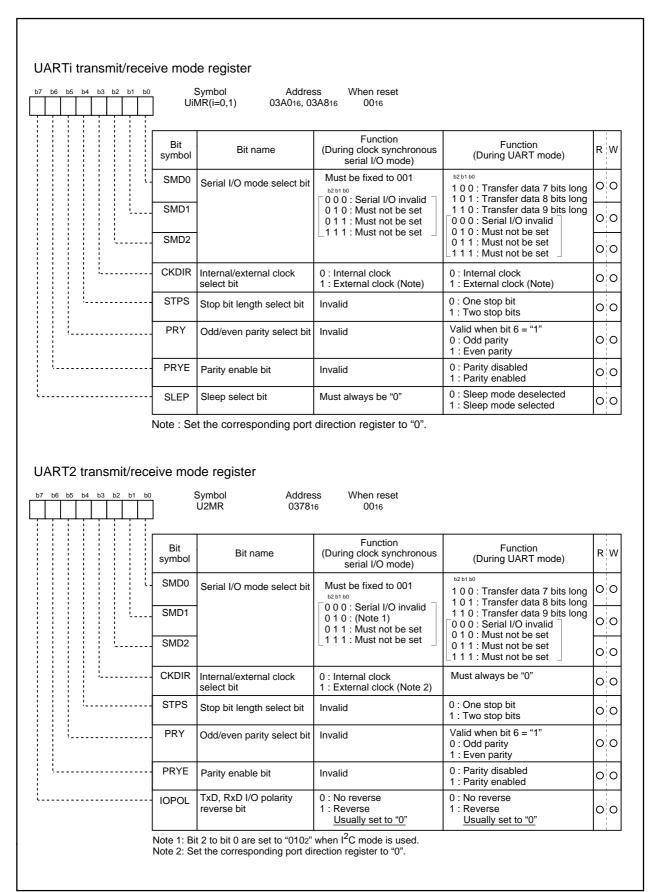


Figure 1.15.5. Serial I/O-related registers (2)



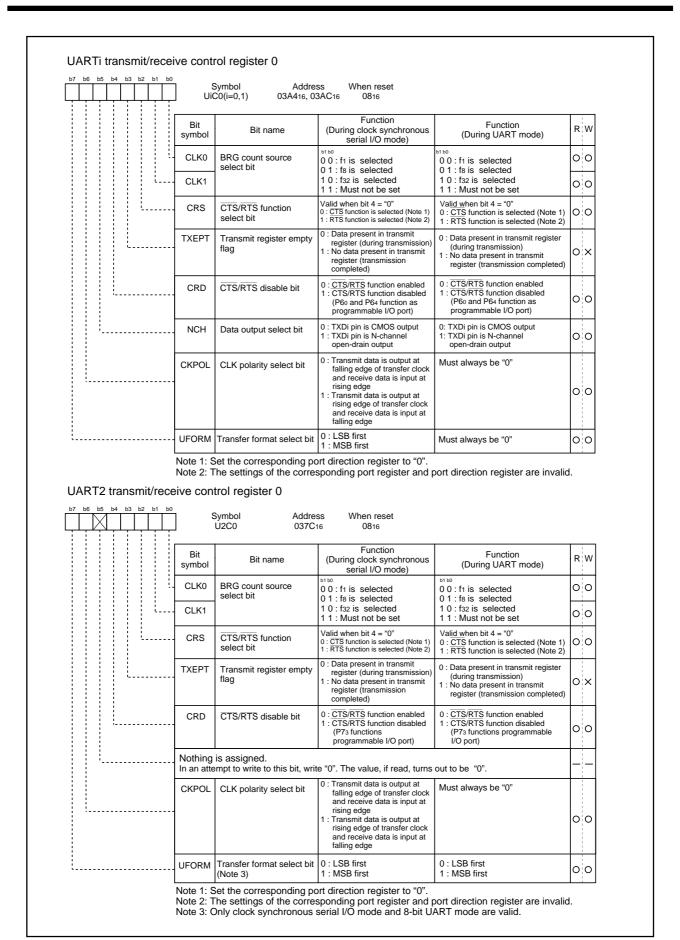


Figure 1.15.6. Serial I/O-related registers (3)



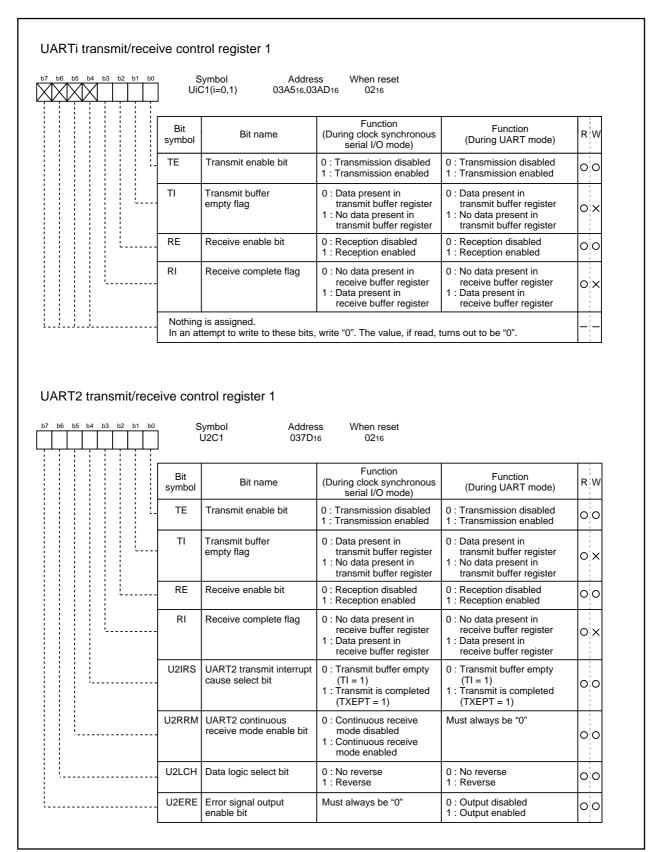


Figure 1.15.7. Serial I/O-related registers (4)



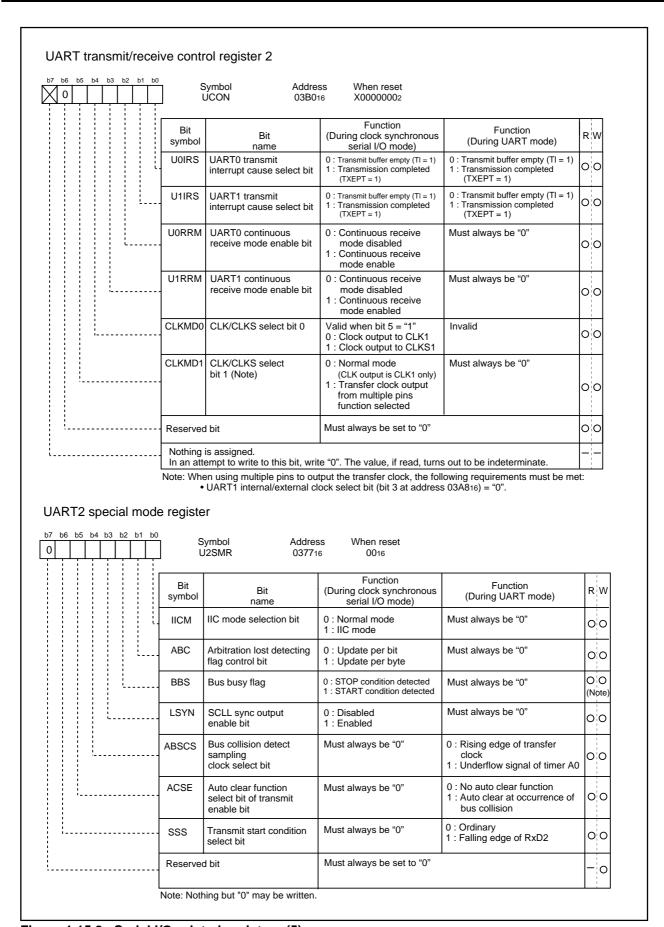


Figure 1.15.8. Serial I/O-related registers (5)



(1) Clock synchronous serial I/O mode

The clock synchronous serial I/O mode uses a transfer clock to transmit and receive data. Tables 1.15.2 and 1.15.3 list the specifications of the clock synchronous serial I/O mode. Figure 1.15.9 shows the UARTi transmit/receive mode register.

Table 1.15.2. Specifications of clock synchronous serial I/O mode (1)

Item	Specification			
Transfer data format	Transfer data length: 8 bits			
Transfer clock	When internal clock is selected (bit 3 at addresses 03A016, 03A816, 037816)			
	= "0") : fi/ 2(n+1) (Note 1) fi = f1, f8, f32			
	When external clock is selected (bit 3 at addresses 03A016, 03A816, 037816)			
	= "1") : Input from CLKi pin			
Transmission/reception control	• CTS function, RTS function, CTS and RTS function invalid: selectable			
Transmission start condition	To start transmission, the following requirements must be met:			
	- Transmit enable bit (bit 0 at addresses 03A516, 03AD16, 037D16) = "1"			
	- Transmit buffer empty flag (bit 1 at addresses 03A516, 03AD16, 037D16) = "0"			
	– When CTS function selected, CTS input level = "L"			
	Furthermore, if external clock is selected, the following requirements must also be met:			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "0":			
	CLKi input level = "H"			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "1":			
	CLKi input level = "L"			
Reception start condition	To start reception, the following requirements must be met:			
	- Receive enable bit (bit 2 at addresses 03A516, 03AD16, 037D16) = "1"			
	- Transmit enable bit (bit 0 at addresses 03A516, 03AD16, 037D16) = "1"			
	- Transmit buffer empty flag (bit 1 at addresses 03A516, 03AD16, 037D16) = "0"			
	• Furthermore, if external clock is selected, the following requirements must also be met:			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "0": CLKi input level = "H"			
	- CLKi polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) = "1":			
	CLKi input level = "L"			
Interrupt request	When transmitting			
generation timing	- Transmit interrupt cause select bit (bits 0, 1 at address 03B016, bit 4 at			
generation timing	address 037D16) = "0": Interrupts requested when data transfer from UARTi			
	transfer buffer register to UARTi transmit register is completed			
	- Transmit interrupt cause select bit (bits 0, 1 at address 03B016, bit 4 at			
	address 037D16) = "1": Interrupts requested when data transmission from			
	UARTi transfer register is completed			
	When receiving			
	Interrupts requested when data transfer from UARTi receive register to			
	UARTi receive buffer register is completed			
Error detection	Overrun error (Note 2)			
	This error occurs when the next data is ready before contents of UARTi			
	receive buffer register are read out			

Note 1: "n" denotes the value 0016 to FF16 that is set to the UART bit rate generator.

Note 2: If an overrun error occurs, the UARTi receive buffer will have the next data written in. Note also that the UARTi receive interrupt request bit does not change.



Table 1.15.3. Specifications of clock synchronous serial I/O mode (2)

Item	Specification
Select function	CLK polarity selection
	Whether transmit data is output/input timing at the rising edge or falling edge
	of thetransfer clock can be selected
	LSB first/MSB first selection
	Whether transmission/reception begins with bit 0 or bit 7 can be selected
	Continuous receive mode selection
	Reception is enabled simultaneously by a read from the receive buffer register
	Transfer clock output from multiple pins selection (UART1)
	UART1 transfer clock can be chosen by software to be output from one of
	the two pins set
	Switching serial data logic (UART2)
	Whether to reverse data in writing to the transmission buffer register or
	reading the reception buffer register can be selected.
	TxD, RxD I/O polarity reverse (UART2)
	This function is reversing TxD port output and RxD port input. All I/O data
	level is reversed.



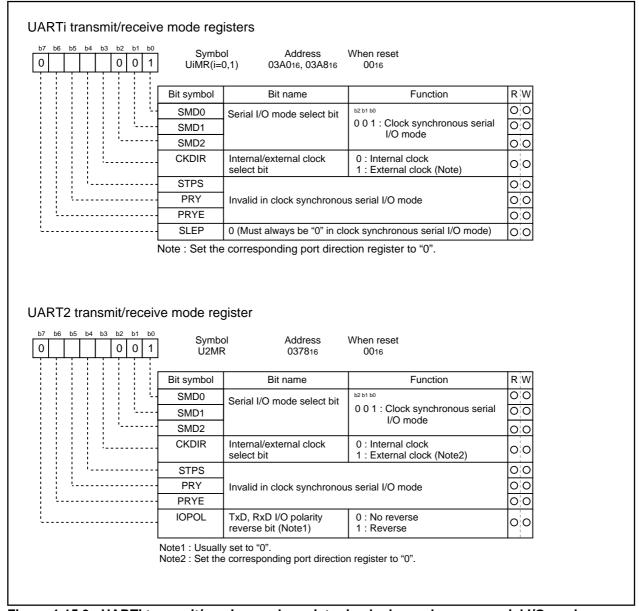


Figure 1.15.9. UARTi transmit/receive mode register in clock synchronous serial I/O mode

Table 1.15.4 lists the functions of the input/output pins during clock synchronous serial I/O mode. This table shows the pin functions when the transfer clock output from multiple pins function is <u>not selected</u>. Note that for a period from when the UARTi operation mode is selected to when transfer starts, the TxDi pin outputs a "H". (If the N-channel open-drain is selected, this pin is in floating state.)

Table 1.15.4. Input/output pin functions in clock synchronous serial I/O mode

(when transfer clock output from multiple pins is not selected)

Pin name	Function	Method of selection
TxDi (P63, P67, P70)	Serial data output	(Outputs dummy data when performing reception only)
RxDi (P62, P66, P71)	Serial data input	Port P62, P66 and P71 direction register (bits 2 and 6 at address 03EE16, bit 1 at address 03EF16)= "0" (Can be used as an input port when performing transmission only)
CLKi	Transfer clock output	Internal/external clock select bit (bit 3 at address 03A016, 03A816, 037816) = "0"
(P61, P65, P72)	Transfer clock input	Internal/external clock select bit (bit 3 at address 03A016, 03A816, 037816) = "1" Port P61, P65 and P72 direction register (bits 1 and 5 at address 03EE16, bit 2 at address 03EF16) = "0"
(P60, P64, P73)	CTS input	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) ="0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "0" Port P60, P64 and P73 direction register (bits 0 and 4 at address 03EE16, bit 3 at address 03EF16) = "0"
	RTS output	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "1"
	Programmable I/O port	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "1"



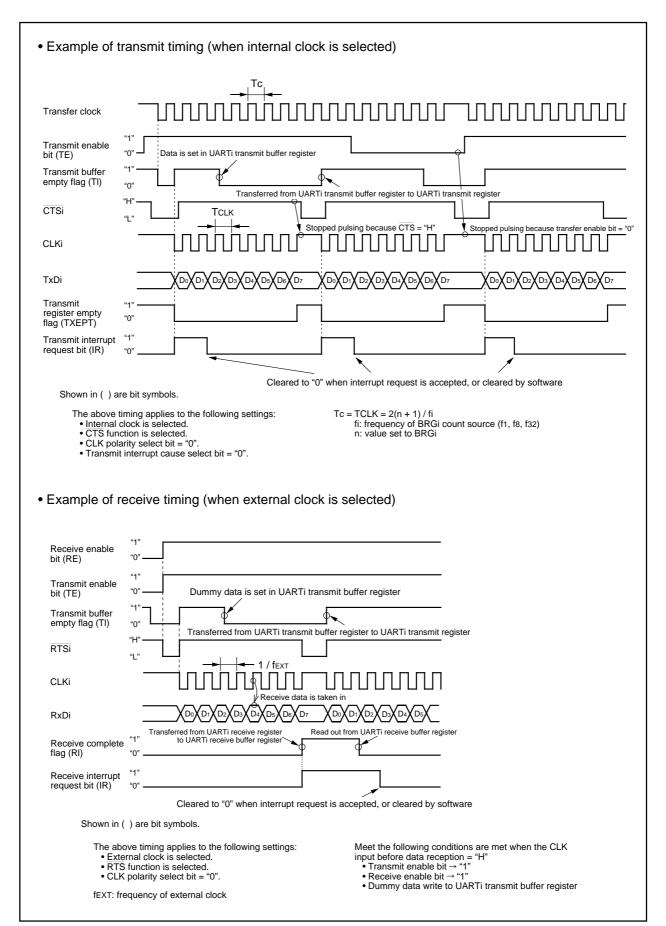


Figure 1.15.10. Typical transmit/receive timings in clock synchronous serial I/O mode

(a) Polarity select function

As shown in Figure 1.15.11, the CLK polarity select bit (bit 6 at addresses 03A416, 03AC16, 037C16) allows selection of the polarity of the transfer clock.

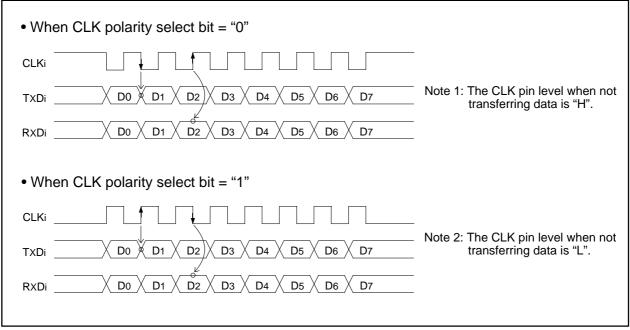


Figure 1.15.11. Polarity of transfer clock

(b) LSB first/MSB first select function

As shown in Figure 1.15.12, when the transfer format select bit (bit 7 at addresses 03A416, 03AC16, 037C16) = "0", the transfer format is "LSB first"; when the bit = "1", the transfer format is "MSB first".

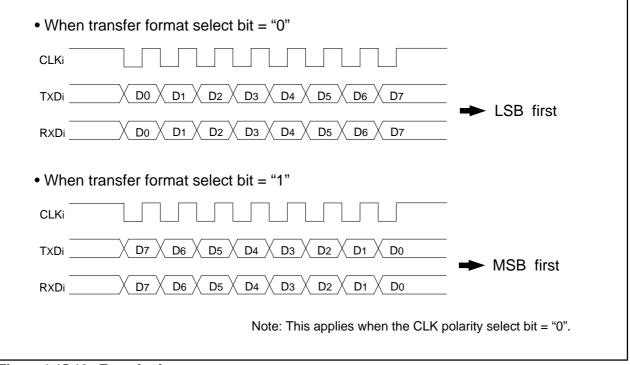


Figure 1.15.12. Transfer format

(c) Transfer clock output from multiple pins function (UART1)

This function allows the setting two transfer clock output pins and choosing one of the two to output a clock by using the CLK and CLKS select bit (bits 4 and 5 at address 03B016). (See Figure 1.15.3.) The multiple pins function is valid only when the internal clock is selected for UART1. Note that when this function is selected, UART1 CTS/RTS function cannot be used.

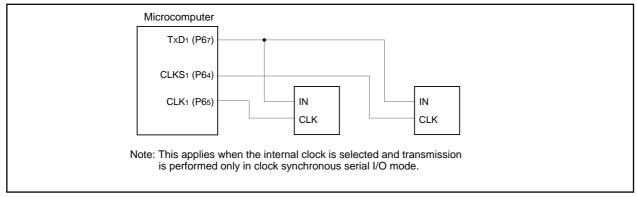


Figure 1.15.13. The transfer clock output from the multiple pins function usage

(d) Continuous receive mode

If the continuous receive mode enable bit (bits 2 and 3 at address 03B016, bit 5 at address 037D16) is set to "1", the unit is placed in continuous receive mode. In this mode, when the receive buffer register is read out, the unit simultaneously goes to a receive enable state without having to set dummy data to the transmit buffer register back again.

(e) Serial data logic switch function (UART2)

When the data logic select bit (bit6 at address 037D16) = "1", and writing to transmit buffer register or reading from receive buffer register, data is reversed. Figure 1.15.14 shows the example of serial data logic switch timing.

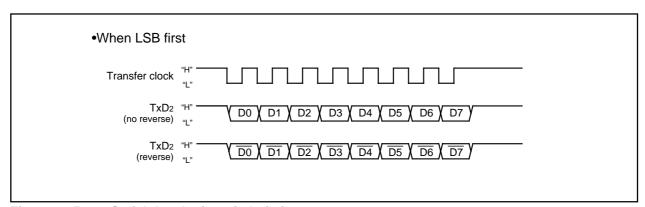


Figure 1.15.14. Serial data logic switch timing



(2) Clock asynchronous serial I/O (UART) mode

The UART mode allows transmitting and receiving data after setting the desired transfer rate and transfer data format. Tables 1.15.5 and 1.15.6 list the specifications of the UART mode. Figure 1.15.15 shows the UARTi transmit/receive mode register.

Table 1.15.5. Specifications of UART Mode (1)

Item	Specification		
Transfer data format	Character bit (transfer data): 7 bits, 8 bits, or 9 bits as selected		
	Start bit: 1 bit		
	 Parity bit: Odd, even, or nothing as selected 		
	Stop bit: 1 bit or 2 bits as selected		
Transfer clock	• When internal clock is selected (bit 3 at addresses 03A016, 03A816, 037816 = "0"):		
	$fi/16(n+1)$ (Note 1) $fi = f_1, f_8, f_{32}$		
	• When external clock is selected (bit 3 at addresses 03A016, 03A816 ="1"):		
	fEXT/16(n+1) (Note 1) (Note 2) (Do not set external clock for UART2)		
Transmission/reception control	• CTS function, RTS function, CTS and RTS function invalid: selectable		
Transmission start condition	To start transmission, the following requirements must be met:		
	- Transmit enable bit (bit 0 at addresses 03A516, 03AD16, 037D16) = "1"		
	- Transmit buffer empty flag (bit 1 at addresses 03A516, 03AD16, 037D16) = "0"		
	- When $\overline{\text{CTS}}$ function selected, $\overline{\text{CTS}}$ input level = "L"		
Reception start condition	To start reception, the following requirements must be met:		
	- Receive enable bit (bit 2 at addresses 03A516, 03AD16, 037D16) = "1"		
	- Start bit detection		
Interrupt request	When transmitting		
generation timing	- Transmit interrupt cause select bits (bits 0,1 at address 03B016, bit4 at		
	address 037D16) = "0": Interrupts requested when data transfer from UARTi		
	transfer buffer register to UARTi transmit register is completed		
	- Transmit interrupt cause select bits (bits 0, 1 at address 03B016, bit4 at		
	address 037D16) = "1": Interrupts requested when data transmission from		
	UARTi transfer register is completed		
	When receiving		
	- Interrupts requested when data transfer from UARTi receive register to		
	UARTi receive buffer register is completed		
Error detection	Overrun error (Note 3)		
	This error occurs when the next data is ready before contents of UARTi		
	receive buffer register are read out		
	Framing error		
	This error occurs when the number of stop bits set is not detected		
	Parity error		
	This error occurs when if parity is enabled, the number of 1's in parity and		
	character bits does not match the number of 1's set		
	Error sum flag		
	This flag is set (= 1) when any of the overrun, framing, and parity errors is		
	encountered		

Note 1: 'n' denotes the value 0016 to FF16 that is set to the UARTi bit rate generator.

Note 2: fext is input from the CLKi pin.

Note 3: If an overrun error occurs, the UARTi receive buffer will have the next data written in. Note also that the UARTi receive interrupt request bit does not change.



Table 1.15.6. Specifications of UART Mode (2)

Item	Specification	
Select function	Sleep mode selection (UART0, UART1)	
	This mode is used to transfer data to and from one of multiple slave micro-	
	computers	
	Serial data logic switch (UART2)	
	This function is reversing logic value of transferring data. Start bit, parity bit	
	and stop bit are not reversed.	
	• TxD, RxD I/O polarity switch (UART2)	
	This function is reversing TxD port output and RxD port input. All I/O data	
	level is reversed.	



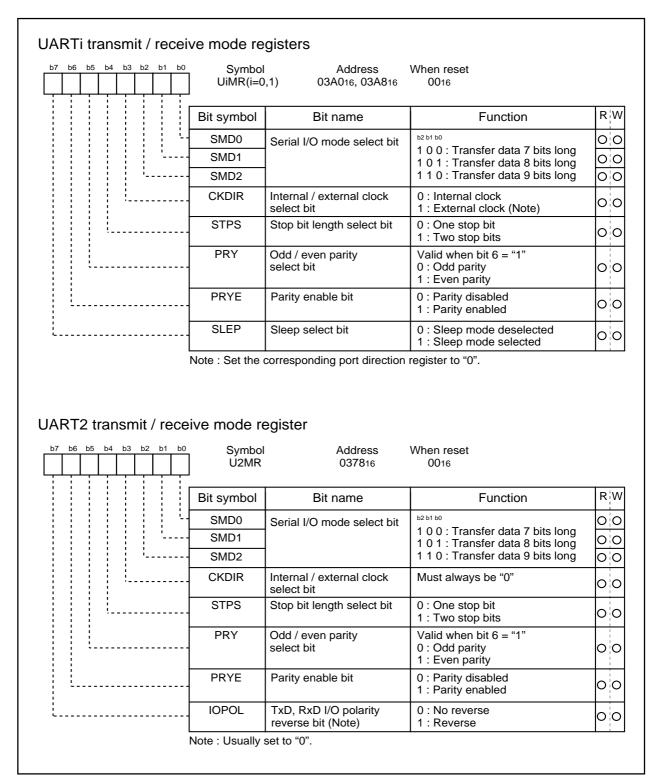


Figure 1.15.15. UARTi transmit/receive mode register in UART mode

Table 1.15.7 lists the functions of the input/output pins during UART mode. Note that for a period from when the UARTi operation mode is selected to when transfer starts, the TxDi pin outputs a "H". (If the N-channel open-drain is selected, this pin is in floating state.)

Table 1.15.7. Input/output pin functions in UART mode

Pin name	Function	Method of selection
TxDi (P63, P67, P70)	Serial data output	
RxDi (P62, P66, P71)	Serial data input	Port P62, P66 and P71 direction register (bits 2 and 6 at address 03EE16, bit 1 at address 03EF16)= "0" (Can be used as an input port when performing transmission only)
CLKi (P61, P65, P72)	Programmable I/O port	Internal/external clock select bit (bit 3 at address 03A016, 03A816, 037816) = "0"
	Transfer clock input	Internal/external clock select bit (bit 3 at address 03A016, 03A816) = "1" Port P61, P65 direction register (bits 1 and 5 at address 03EE16) = "0" (Do not set external clock for UART2)
CTSi/RTSi (P60, P64, P73)	CTS input	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) ="0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "0" Port P60, P64 and P73 direction register (bits 0 and 4 at address 03EE16, bit 3 at address 03EF16) = "0"
	RTS output	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "0" CTS/RTS function select bit (bit 2 at address 03A416, 03AC16, 037C16) = "1"
	Programmable I/O port	CTS/RTS disable bit (bit 4 at address 03A416, 03AC16, 037C16) = "1"



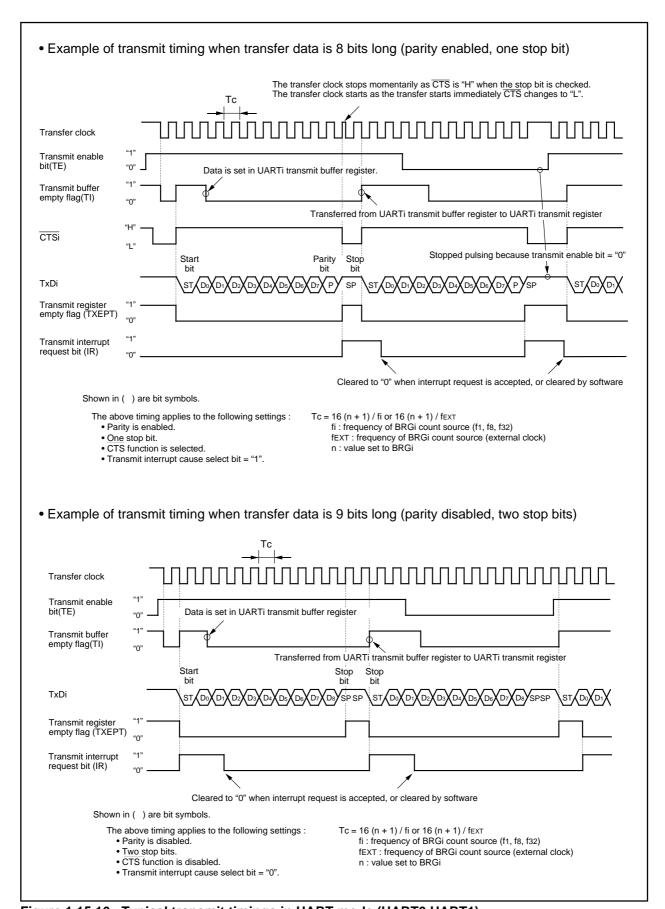


Figure 1.15.16. Typical transmit timings in UART mode (UART0,UART1)



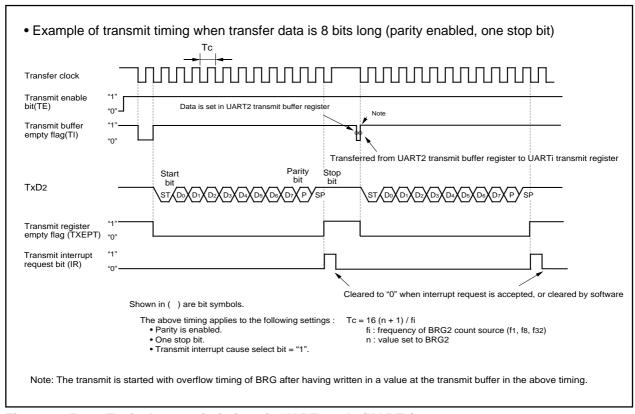


Figure 1.15.17. Typical transmit timings in UART mode (UART2)



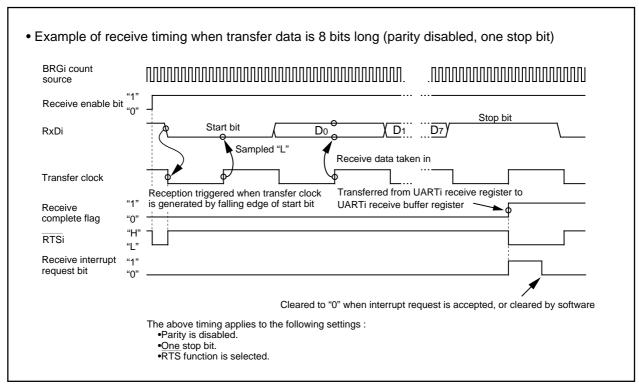


Figure 1.15.18. Typical receive timing in UART mode

(a) Sleep mode (UART0, UART1)

This mode is used to transfer data between specific microcomputers among multiple microcomputers connected using UARTi. The sleep mode is selected when the sleep select bit (bit 7 at addresses 03A016, 03A816) is set to "1" during reception. In this mode, the unit performs receive operation when the MSB of the received data = "1" and does not perform receive operation when the MSB = "0".

(b) Function for switching serial data logic (UART2)

When the data logic select bit (bit 6 of address 037D16) is assigned 1, data is inverted in writing to the transmission buffer register or reading the reception buffer register. Figure 1.15.19 shows the example of timing for switching serial data logic.

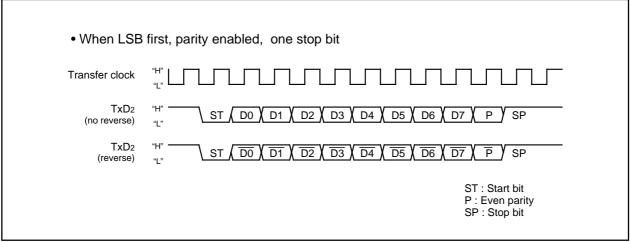


Figure 1.15.19. Timing for switching serial data logic

(c) TxD, RxD I/O polarity reverse function (UART2)

This function is to reverse TxD pin output and RxD pin input. The level of any data to be input or output (including the start bit, stop bit(s), and parity bit) is reversed. Set this function to "0" (not to reverse) for usual use.

(d) Bus collision detection function (UART2)

This function is to sample the output level of the TxD pin and the input level of the RxD pin at the rising edge of the transfer clock; if their values are different, then an interrupt request occurs. Figure 1.15.20 shows the example of detection timing of a bus collision (in UART mode).

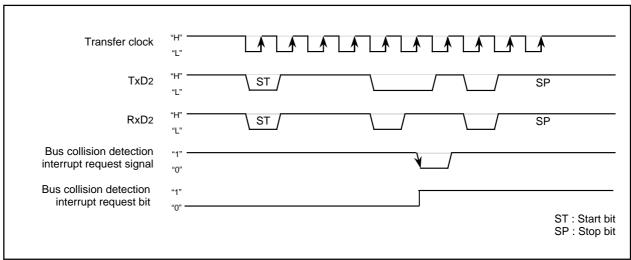


Figure 1.15.20. Detection timing of a bus collision (in UART mode)



(3) Clock-asynchronous serial I/O mode (compliant with the SIM interface)

The SIM interface is used for connecting the microcomputer with a memory card or the like; adding some extra settings in UART2 clock-asynchronous serial I/O mode allows the user to effect this function. Table 1.15.8 shows the specifications of clock-asynchronous serial I/O mode (compliant with the SIM interface).

Table 1.15.8. Specifications of clock-asynchronous serial I/O mode (compliant with the SIM interface)

Item	Specification
Transfer data format	• Transfer data 8-bit UART mode (bit 2 through bit 0 of address 037816 = "1012")
	• One stop bit (bit 4 of address 037816 = "0")
	With the direct format chosen
	Set parity to "even" (bit 5 and bit 6 of address 037816 = "1" and "1" respectively)
	Set data logic to "direct" (bit 6 of address 037D16 = "0").
	Set transfer format to LSB (bit 7 of address 037C16 = "0").
	With the inverse format chosen
	Set parity to "odd" (bit 5 and bit 6 of address 037816 = "0" and "1" respectively)
	Set data logic to "inverse" (bit 6 of address 037D16 = "1")
	Set transfer format to MSB (bit 7 of address 037C16 = "1")
Transfer clock	• With the internal clock chosen (bit 3 of address 037816 = "0"): fi / 16 (n + 1) (Note 1): fi=f1, f8, f32
	(Do not set external clock)
Transmission / reception control	• Disable the CTS and RTS function (bit 4 of address 037C16 = "1")
Other settings	The sleep mode select function is not available for UART2
	• Set transmission interrupt factor to "transmission completed" (bit 4 of address 037D16 = "1")
Transmission start condition	To start transmission, the following requirements must be met:
	- Transmit enable bit (bit 0 of address 037D16) = "1"
	- Transmit buffer empty flag (bit 1 of address 037D16) = "0"
Reception start condition	To start reception, the following requirements must be met:
	- Reception enable bit (bit 2 of address 037D16) = "1"
	- Detection of a start bit
Interrupt request	When transmitting
generation timing	When data transmission from the UART2 transfer register is completed
	(bit 4 of address 037D16 = "1")
	When receiving
	When data transfer from the UART2 receive register to the UART2 receive
	buffer register is completed
Error detection	Overrun error (see the specifications of clock-asynchronous serial I/O) (Note 2)
	• Framing error (see the specifications of clock-asynchronous serial I/O)
	 Parity error (see the specifications of clock-asynchronous serial I/O)
	- On the reception side, an "L" level is output from the TxD2 pin by use of the parity error
	signal output function (bit 7 of address 037D16 = "1") when a parity error is detected
	- On the transmission side, a parity error is detected by the level of input to
	the RxD2 pin when a transmission interrupt occurs
	• The error sum flag (see the specifications of clock-asynchronous serial I/O)

Note 1: 'n' denotes the value 0016 to FF16 that is set to the UART2 bit rate generator.

Note 2: If an overrun error occurs, the UART2 receive buffer will have the next data written in. Note also that the UART2 receive interrupt request bit does not change.



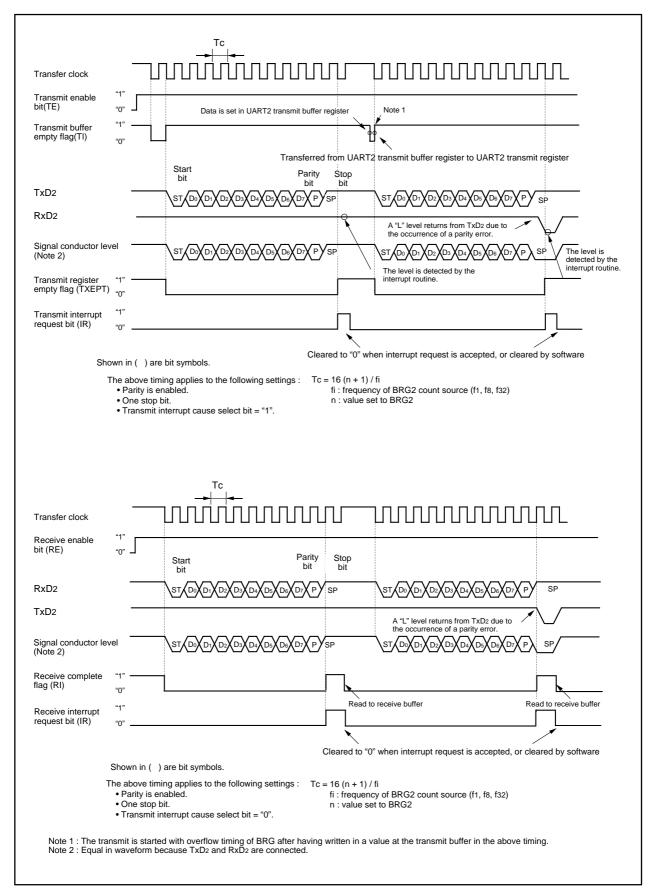


Figure 1.15.21. Typical transmit/receive timing in UART mode (compliant with the SIM interface)



(a) Function for outputting a parity error signal

With the error signal output enable bit (bit 7 of address 037D16) assigned "1", you can output an "L" level from the TxD2 pin when a parity error is detected. In step with this function, the generation timing of a transmission completion interrupt changes to the detection timing of a parity error signal. Figure 1.15.22 shows the output timing of the parity error signal.

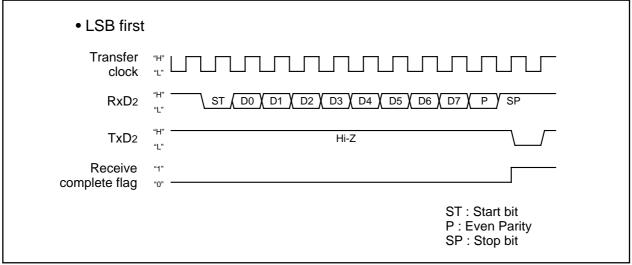


Figure 1.15.22. Output timing of the parity error signal

(b) Direct format/inverse format

Connecting the SIM card allows you to switch between direct format and inverse format. If you choose the direct format, D₀ data is output from TxD₂. If you choose the inverse format, D₇ data is inverted and output from TxD₂.

Figure 1.15.23 shows the SIM interface format.

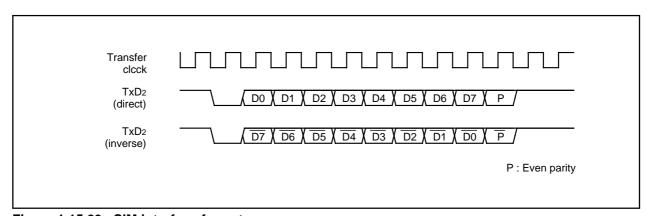


Figure 1.15.23. SIM interface format

Figure 1.15.24 shows the example of connecting the SIM interface. Connect TxD2 and RxD2 and apply pull-up.

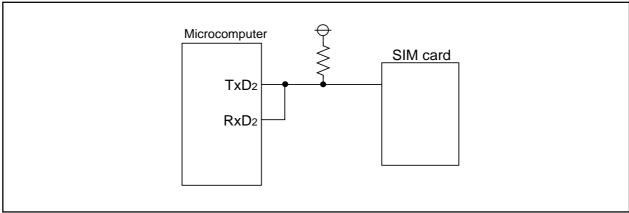


Figure 1.15.24. Connecting the SIM interface

UART2 Special Mode Register

The UART2 special mode register (address 037716) is used to control UART2 in various ways. Figure 1.15.25 shows the UART2 special mode register.

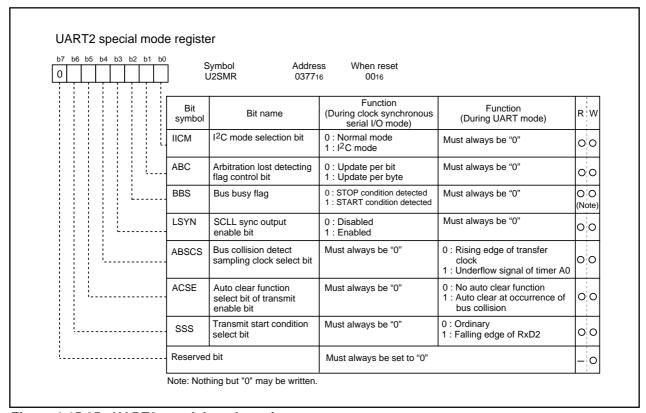


Figure 1.15.25. UART2 special mode register

Table 1.15.9. Features in I²C mode

	Function	Normal mode	I ² C mode (Note 1)	
1	Factor of interrupt number 10 (Note 2)	Bus collision detection	Start condition detection or stop condition detection	
2	Factor of interrupt number 15 (Note 2)	UART2 transmission	No acknowledgment detection (NACK)	
3	Factor of interrupt number 16 (Note 2)	UART2 reception	Acknowledgment detection (ACK)	
4	UART2 transmission output delay	Not delayed	Delayed	
5	P70 at the time when UART2 is in use	TxD2 (output)	SDA (input/output) (Note 3)	
6	P71 at the time when UART2 is in use	RxD2 (input)	SCL (input/output)	
7	P72 at the time when UART2 is in use	CLK2	P72	
8	DMA1 factor at the time when 1 1 0 1 is assigned to the DMA request factor selection bits	UART2 reception	Must not be set	
9	Noise filter width	15ns	50ns	
10	Reading P71	Reading the terminal when 0 is assigned to the direction register	Reading the terminal regardless of the value of the direction register	
11	Initial value of UART2 output	H level (when 0 is assigned to the CLK polarity select bit)	The value set in latch P70 when the port is selected	

Note 1: Make the settings given below when I^2C mode is in use.

Set 0 1 0 in bits 2, 1, 0 of the UART2 transmission/reception mode register.

Disable the RTS/CTS function. Choose the MSB First function.

Note 2: Follow the steps given below to switch from a factor to another.

- 1. Disable the interrupt of the corresponding number.
- 2. Switch from a factor to another.
- 3. Reset the interrupt request flag of the corresponding number.
- 4. Set an interrupt level of the corresponding number.

Note 3: Set an initial value of SDA transmission output when serial I/O is invalid.



In the first place, the control bits related to the I²C bus (simplified I²C bus) interface are explained. Bit 0 of the UART special mode register (037716) is used as the I²C mode selection bit.

Setting "1" in the I²C mode select bit (bit 0) goes the circuit to achieve the I²C bus (simplified I²C bus) interface effective.

Table 1.15.9 shows the relation between the I²C mode select bit and respective control workings. Since this function uses clock-synchronous serial I/O mode, set this bit to "0" in UART mode.

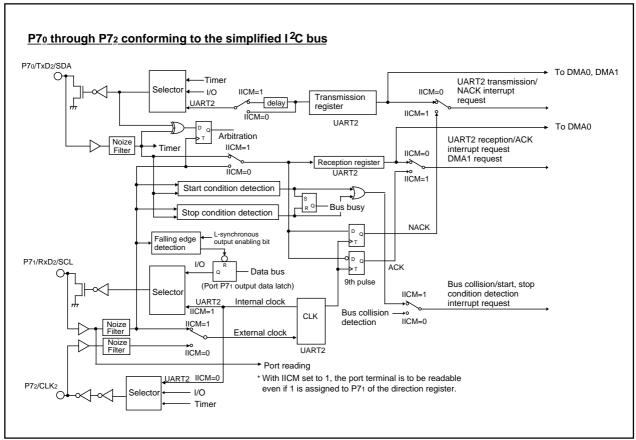


Figure 1.15.26. Functional block diagram for I²C mode

Figure 1.15.26 shows the functional block diagram for I²C mode. Setting "1" in the I²C mode selection bit (IICM) causes ports P70, P71, and P72 to work as data transmission-reception terminal SDA, clock input-output terminal SCL, and port P72 respectively. A delay circuit is added to the SDA transmission output, so the SDA output changes after SCL fully goes to "L". An attempt to read Port P71 (SCL) results in getting the terminal's level regardless of the content of the port direction register. The initial value of SDA transmission output in this mode goes to the value set in port P70. The interrupt factors of the bus collision detection interrupt, UART2 transmission interrupt, and of UART2 reception interrupt turn to the start/stop condition detection interrupt, acknowledgment non-detection interrupt, and acknowledgment detection interrupt respectively.

The start condition detection interrupt refers to the interrupt that occurs when the falling edge of the SDA terminal (P70) is detected with the SCL terminal (P71) staying "H". The stop condition detection interrupt refers to the interrupt that occurs when the rising edge of the SDA terminal (P70) is detected with the SCL terminal (P71) staying "H". The bus busy flag (bit 2 of the UART2 special mode register) is set to "1" by the start condition detection, and set to "0" by the stop condition detection.



The acknowledgment non-detection interrupt refers to the interrupt that occurs when the SDA terminal level is detected still staying "H" at the rising edge of the 9th transmission clock. The acknowledgment detection interrupt refers to the interrupt that occurs when SDA terminal's level is detected already went to "L" at the 9th transmission clock. Bit 1 of the UART2 special mode register (037716) is used as the arbitration lost detecting flag control bit. Arbitration means the act of detecting the nonconformity between transmission data and SDA terminal data at the timing of the SCL rising edge. This detecting flag is located at bit 3 of the UART2 reception buffer register (037F16), and "1" is set in this flag when nonconformity is detected. Use the arbitration lost detecting flag control bit to choose which way to use to update the flag, bit by bit or byte by byte. When setting this bit to "1" and updated the flag byte by byte if nonconformity is detected, the arbitration lost detecting flag is set to "1" at the falling edge of the 9th transmission clock.

If update the flag byte by byte, must judge and clear ("0") the arbitration lost detecting flag after completing the first byte acknowledge detect and before starting the next one byte transmission.

Bit 3 of the UART2 special mode register is used as SCL- and L-synchronous output enable bit. Setting this bit to "1" goes the P71 data register to "0" in synchronization with the SCL terminal level going to "L".



Some other functions added are explained here. Figure 1.15.27 shows their workings.

Bit 4 of the UART2 special mode register is used as the bus collision detect sampling clock select bit. The bus collision detect interrupt occurs when the RxD2 level and TxD2 level do not match, but the nonconformity is detected in synchronization with the rising edge of the transfer clock signal if the bit is set to "0". If this bit is set to "1", the nonconformity is detected at the timing of the overflow of timer A0 rather than at the rising edge of the transfer clock.

Bit 5 of the UART2 special mode register is used as the auto clear function select bit of transmit enable bit. Setting this bit to "1" automatically resets the transmit enable bit to "0" when "1" is set in the bus collision detect interrupt request bit (nonconformity).

Bit 6 of the UART2 special mode register is used as the transmit start condition select bit. Setting this bit to "1" starts the TxD transmission in synchronization with the falling edge of the RxD terminal.

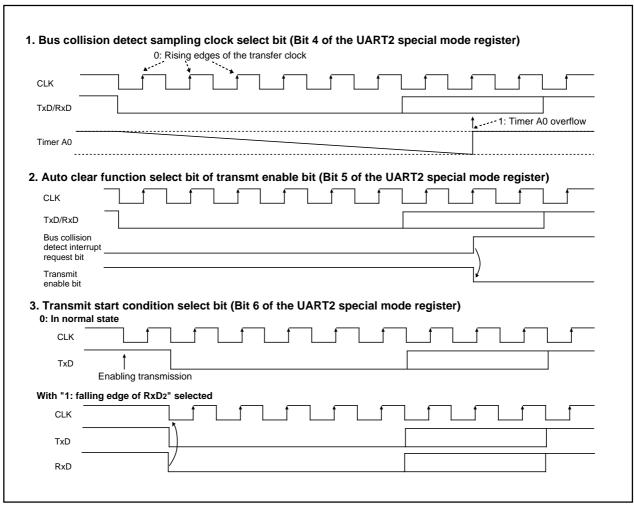


Figure 1.15.27. Some other functions added

UART2 Special Mode Register 2

UART2 special mode register 2 (address 037616) is used to further control UART2 in I²C mode. Figure 1.15.28 shows the UART2 special mode register 2.

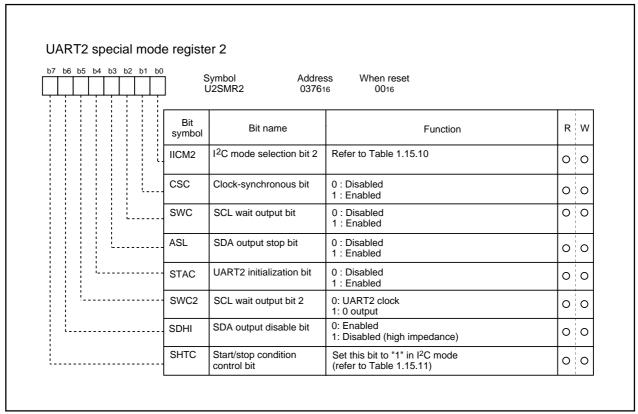


Figure 1.15.28. UART2 special mode register 2

Bit 0 of the UART2 special mode register 2 (address 037616) is used as the I²C mode selection bit 2. Table 1.15.10 shows the types of control to be changed by I²C mode selection bit 2 when the I²C mode selection bit is set to "1". Table 1.15.11 shows the timing characteristics of detecting the start condition and the stop condition. Set the start/stop condition control bit (bit 7 of UART2 special mode register 2) to "1" in I²C mode.

Table 1.15.10. Functions changed by I²C mode selection bit 2

	Function	IICM2 = 0	IICM2 = 1
1	Factor of interrupt number 15	No acknowledgment detection (NACK)	UART2 transmission (the rising edge of the final bit of the clock)
2	Factor of interrupt number 16	Acknowledgment detection (ACK)	UART2 reception (the falling edge of the final bit of the clock)
3	DMA1 factor at the time when 1 1 0 1 is assigned to the DMA request factor selection bits	Must not be set	UART2 reception (the falling edge of the final bit of the clock)
4	Timing for transferring data from the UART2 reception shift register to the reception buffer.	The rising edge of the final bit of the reception clock	The falling edge of the final bit of the reception clock
5	Timing for generating a UART2 reception/ACK interrupt request	The rising edge of the final bit of the reception clock	The falling edge of the final bit of the reception clock

Table 1.15.11. Timing characteristics of detecting the start condition and the stop condition(Note1)

3 to 6 cycles < duration for setting-up (Note2)
3 to 6 cycles < duration for holding (Note2)

Note 1: When the start/stop condition count bit is "1".

Note 2: "cycles" is in terms of the input oscillation frequency f(XIN) of the main clock.

	Duration for setting up	Duration for holding	
SCL -			
SDA _ (Start condition)			
SDA (Stop condition)			i i i

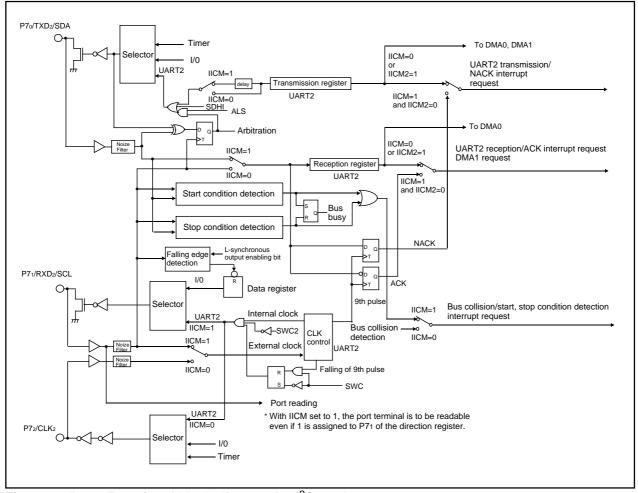


Figure 1.15.29. Functional block diagram for I²C mode

Functions available in I²C mode are shown in Figure 1.15.29 — a functional block diagram.

Bit 3 of the UART2 special mode register 2 (address 037616) is used as the SDA output stop bit. Setting this bit to "1" causes an arbitration loss to occur, and the SDA pin turns to high-impedance state at the instant when the arbitration lost detecting flag is set to "1".

Bit 1 of the UART2 special mode register 2 (address 037616) is used as the clock synchronization bit. With this bit set to "1" at the time when the internal SCL is set to "H", the internal SCL turns to "L" if the falling edge is found in the SCL pin; and the baud rate generator reloads the set value, and start counting within the "L" interval. When the internal SCL changes from "L" to "H" with the SCL pin set to "L", stops counting the baud rate generator, and starts counting it again when the SCL pin turns to "H". Due to this function, the UART2 transmission-reception clock becomes the logical product of the signal flowing through the internal SCL and that flowing through the SCL pin. This function operates over the period from the moment earlier by a half cycle than falling edge of the UART2 first clock to the rising edge of the ninth bit. To use this function, choose the internal clock for the transfer clock.

Bit 2 of the UART2 special mode register 2 (037616) is used as the SCL wait output bit. Setting this bit to "1" causes the SCL pin to be fixed to "L" at the falling edge of the ninth bit of the clock. Setting this bit to "0" frees the output fixed to "L".



Bit 4 of the UART2 special mode register 2 (address 037616) is used as the UART2 initialization bit. Setting this bit to "1", and when the start condition is detected, the microcomputer operates as follows.

- (1) The transmission shift register is initialized, and the content of the transmission register is transferred to the transmission shift register. This starts transmission by dealing with the clock entered next as the first bit. The UART2 output value, however, doesn't change until the first bit data is output after the entrance of the clock, and remains unchanged from the value at the moment when the microcomputer detected the start condition.
- (2) The reception shift register is initialized, and the microcomputer starts reception by dealing with the clock entered next as the first bit.
- (3) The SCL wait output bit turns to "1". This turns the SCL pin to "L" at the falling edge of the ninth bit of the clock.

Starting to transmit/receive signals to/from UART2 using this function doesn't change the value of the transmission buffer empty flag. To use this function, choose the external clock for the transfer clock. Bit 5 of the UART2 special mode register 2 (037616) is used as the SCL pin wait output bit 2. Setting this bit to "1" with the serial I/O specified allows the user to forcibly output an "L" from the SCL pin even if UART2 is in operation. Setting this bit to "0" frees the "L" output from the SCL pin, and the UART2 clock is input/output.

Bit 6 of the UART2 special mode register 2 (037616) is used as the SDA output disable bit. Setting this bit to "1" forces the SDA pin to turn to the high-impedance state. Refrain from changing the value of this bit at the rising edge of the UART2 transfer clock. There can be instances in which arbitration lost detecting flag is turned on.



LCD Drive Control Circuit

The M30220 group has the built-in Liquid Crystal Display (LCD) drive control circuit consisting of the following.

- LCD display RAM
- · Segment output enable register
- LCD mode register
- Charge-pump
- Selector
- Timing controller
- Common driver
- Segment driver
- · Bias control circuit

A maximum of 48 segment output pins and 4 common output pins can be used.

Up to 192 pixels can be controlled for LCD display. When the LCD enable bit is set to "1" after data is set in the LCD mode register, the segment output enable register and the LCD display RAM, the LCD drive control circuit starts reading the display data automatically, performs the bias control and the duty ratio control, and displays the data on the LCD panel. When using the output port function, write data into the LCD display RAM while the time division select bit are "00" and the LCD output enable bit is "0", and if the LCDRAM output bit is set to "1", the SEG0 - SEG15 pin and the pin which are selected as segment output by the segment output enable register will respectively output the contents of the bit corresponds to the COMo of LCD display RAM.

Table 1.16.1 shows maximum number of display pixels at each duty ratio. Figure 1.16.1 shows the block diagram of LCD controller / driver.

Table 1.16.1. Maximum number of display pixels at each duty ratio

	Duty ratio	Maximum number of display pixel
ſ	2	96 dots or 8 segment LCD 12 digits
ĺ	3	144 dots or 8 segment LCD 18 digits
Ī	4	192 dots or 8 segment LCD 24 digits



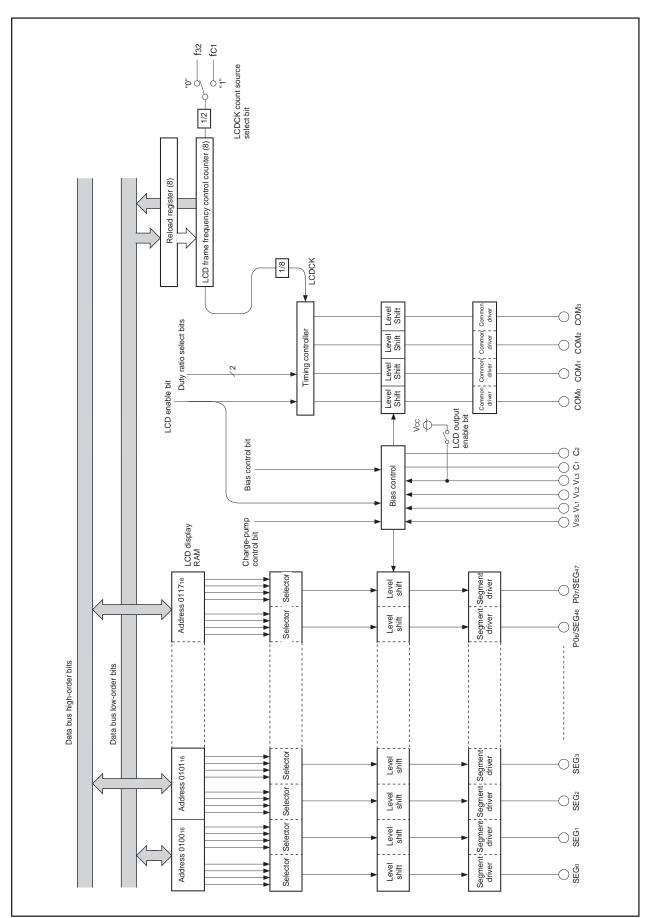


Figure 1.16.1. Block diagram of LCD controller/driver



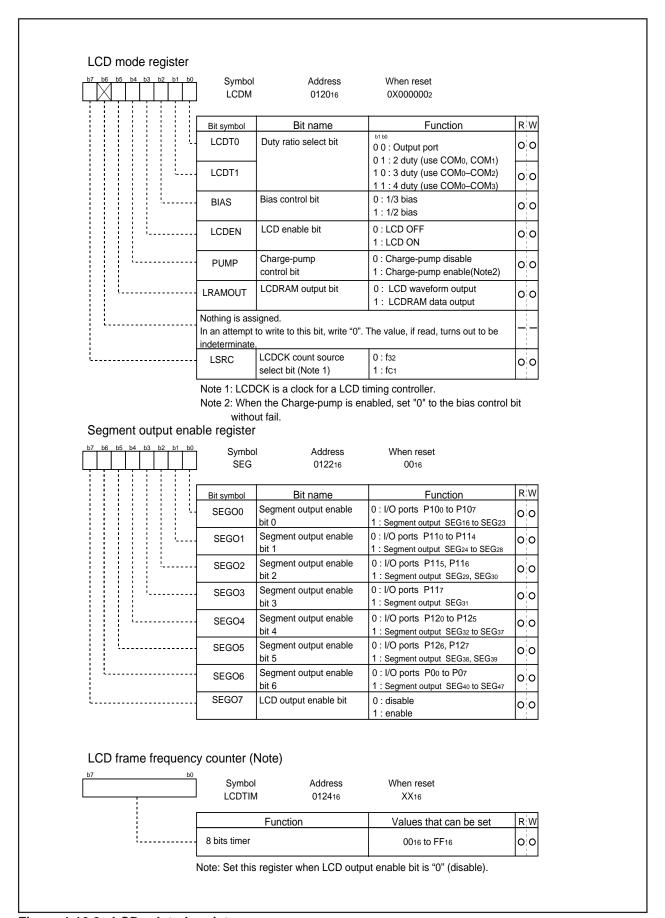


Figure 1.16.2. LCD-related registers

Charge-pump

The charge-pump performs threefold boosting. This circuit inputs a reference voltage for boosting from LCD power input pin VL1.

To activate the charge-pump, by the segment output enable register and the LCD mode register, choose the segment/port, select the time division and the bias control, and set up the LCD frame frequency counter, and select the count source for LCDCK, then set the LCD output enable bit (bit 7 at the address 012216) to "enable", apply a voltage equal to or greater than 1.3 V but not exceeding 2.1 V to the VL1 pin, after that, set the charge-pump control bit (bit 4 at address 012016) to "step up enabled". However, set the bias control to "1/3 bias" without fail.

When using the charge-pump, a voltage that is twice as large as VL1 occurs at VL2 pin, and a voltage that is three times as large as VL1 occurs at the VL3 pin.

The charge-pump control bit (bit 4 of the address 012016) controls the charge-pump.

When not using the charge-pump, enable the LCD output enable bit and apply an appropriate voltage to the LCD power supply input pins (VL1 to VL3). When the LCD output enable bit is disabled, the VL3 pin is connected to VCC internally.

Bias Control and Applied Voltage to LCD Power Input Pins

To the LCD power input pins (VL1 to VL3), apply the voltage shown in Table 1.16.2 according to the bias value. Select a bias value by the bias control bit (bit 2 of the address 012016).

Table 1.16.2. Bias control and applied voltage to VL1 to VL3

Bias value	Voltage value
	VL3 = VLCD
1/3 bias	VL2 = 2/3 VLCD
	VL1 = 1/3 VLCD
1/2 bias	VL3 = VLCD
	VL2 = VL1 = 1/2 VLCD

Note: VLCD is the maximum value of supplied voltage for the LCD panel.

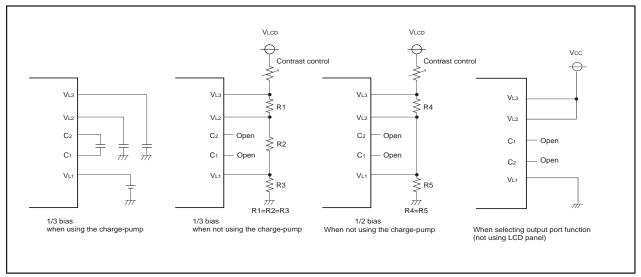


Figure 1.16.3. Example of circuit at each bias



Common Pin and Duty Ratio Control

The common pins (COM₀ to COM₃) to be used are determined by duty ratio. Select duty ratio by the duty ratio select bits (bits 0 and 1 of address 012016).

Table 1.16.3. Duty ratio control and common pins used

Duty	Duty ratio select bit		Common pins used
ratio	Bit 1	Bit 0	
2	0	1	COM0, COM1 (Note 1)
3	1	0	COM0 to COM2 (Note 2)
4	1	1	COM0 to COM3

Note 1: COM2 and COM3 are open.

Note 2: COM3 is open.

LCD Display RAM

Address 010016 to 011716 is the designated RAM for the LCD display. When "1" are written to these addresses, the corresponding segments of the LCD display panel are turned on.

Figure 1.16.4 shows the LCD display RAM map.

Bit	7	6	5	4	3	2	1	0	R	w
Address	СОМз	COM ₂	COM ₁	COM ₀	СОМз	COM ₂	COM ₁	COM ₀		<u>.</u>
010016		SE	G ₁			SE	G ₀		0	0
010116		SE	Gз		SEG ₂				0	0 :
010216		SE	G ₅			SE	G4		0	0
010316		SE	G ₇			SE	G ₆		0	0
010416		SE	G ₉			SE	G8		0	0
010516		SE	G11			SE	G10		0	0
010616		SE	G13			SE	G12		0	0
010716		SE	G15			SE	G14		0	0 ;
010816		SEG ₁₇			SEG ₁₆				0	0
010916		SEG19			SEG ₁₈			0	0	
010A ₁₆	SEG ₂₁			SEG ₂₀				0	0 ;	
010B ₁₆	SEG23			SEG22				0	0	
010C ₁₆	SEG ₂₅		SEG ₂₄				0	0		
010D ₁₆	SEG27		SEG ₂₆				0	0		
010E ₁₆		SE	G29			SE	G28		0	0
010F ₁₆		SE	G 31			SE	G30		0	0
011016		SE	G 33		SEG32				0	0
011116	0111 ₁₆ SEG ₃₅		SEG35			SE	G34		0	<u>; O</u>
011216		SEG37				SE	G36		0	0
011316		SEG39			SEG38				0	0
011416		SEG41			SEG ₄₀				0	0
011516		SEG43			SEG42				0	0
011616		SEG ₄₅				SE	G44		_	0
011716		SEG ₄₇				SE	G46		0	0

Figure 1.16.4. LCD display RAM map

LCD Drive Timing

The LCDCK timing frequency (LCD drive timing) is generated internally and the frame frequency can be determined with the following equation. The LCDCK count source frequency is fc1 (same frequency as XCIN) or f32 (divide-by-32 of XIN frequency).

 $f(LCDCK) = \frac{\text{(frequency of count source for LCDCK)}}{16 \text{ X (LCD frame frequency count value + 1)}}$ $Frame frequency = \frac{f(LCDCK)}{\text{duty ratio}}$



Figure 1.16.5 shows the LCD drive waveform (1/2 bias), Figure 1.16.6 shows the LCD drive waveform (1/3 bias).

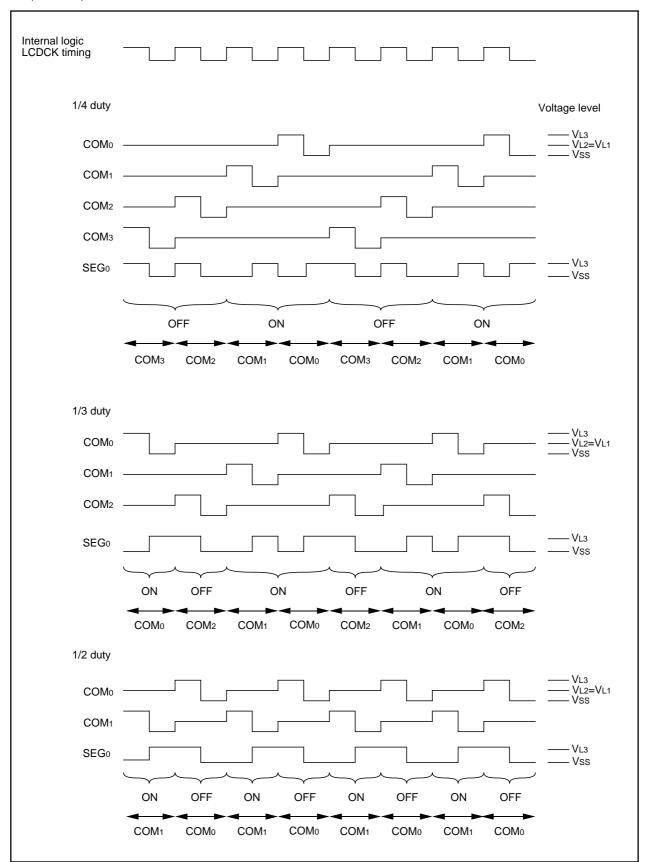


Figure 1.16.5. LCD drive waveform (1/2 bias)

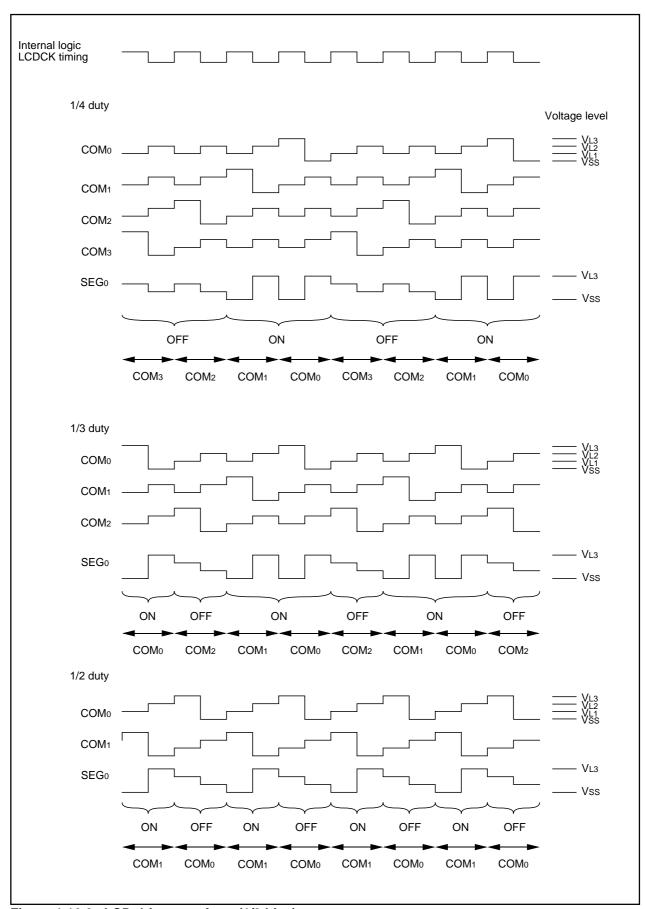


Figure 1.16.6. LCD drive waveform (1/3 bias)

A-D Converter

The A-D converter consists of one 10-bit successive approximation A-D converter circuit with a capacitive coupling amplifier. Pins P90 to P97 also function as the analog signal input pins. The direction registers of these pins for A-D conversion must therefore be set to input. The Vref connect bit (bit 5 at address 03D716) can be used to isolate the resistance ladder of the A-D converter from the reference voltage input pin (VREF) when the A-D converter is not used. Doing so stops any current flowing into the resistance ladder from VREF, reducing the power dissipation. When using the A-D converter, start A-D conversion only after setting bit 5 of 03D716 to connect VREF.

The result of A-D conversion is stored in the A-D registers of the selected pins. When set to 10-bit precision, the low 8 bits are stored in the even addresses and the high 2 bits in the odd addresses. When set to 8-bit precision, the low 8 bits are stored in the even addresses.

Table 1.17.1 shows the performance of the A-D converter. Figure 1.17.1 shows the block diagram of the A-D converter, and Figures 1.17.2 and 1.17.3 show the A-D converter-related registers.

Table 1.17.1. Performance of A-D converter

Item	Performance			
Method of A-D conversion	Successive approximation (capacitive coupling amplifier)			
Analog input voltage (Note 1)	0V to AVcc (Vcc)			
Operating clock \$\phiAD\$ (Note 2)	VCC = 4.0 to 5.5V fAD/divide-by-2 of fAD/divide-by-4 of fAD, fAD=f(XIN)			
	VCC = 2.7 to 4.0V divide-by-2 of fAD/divide-by-4 of fAD, fAD=f(XIN)			
Resolution	8-bit or 10-bit (selectable)			
Absolute precision	Vcc = 5V • Without sample and hold function			
	±3LSB			
	 With sample and hold function (8-bit resolution) 			
	±2LSB			
	 With sample and hold function (10-bit resolution) 			
	±3LSB			
	Vcc = 3V • Without sample and hold function (8-bit resolution)			
	±2LSB			
Operating modes	One-shot mode, repeat mode, single sweep mode, repeat sweep mode 0,			
	and repeat sweep mode 1			
Analog input pins	8pins (ANo to AN7)			
A-D conversion start condition	Software trigger			
	A-D conversion starts when the A-D conversion start flag changes to "1"			
	External trigger (can be retriggered)			
	A-D conversion starts when the A-D conversion start flag is "1" and the			
	ADTRG/P130 input changes from "H" to "L"			
Conversion speed per pin	Without sample and hold function			
	8-bit resolution: 49 \$\phiAD\$ cycles, 10-bit resolution: 59 \$\phiAD\$ cycles			
	With sample and hold function			
	8-bit resolution: 28 \$\phiAD\$ cycles, 10-bit resolution: 33 \$\phiAD\$ cycles			

Note 1: Does not depend on use of sample and hold function.

Note 2: Without sample and hold function, set the ϕAD frequency to 250kHz min. With the sample and hold function, set the ϕAD frequency to 1MHz min.



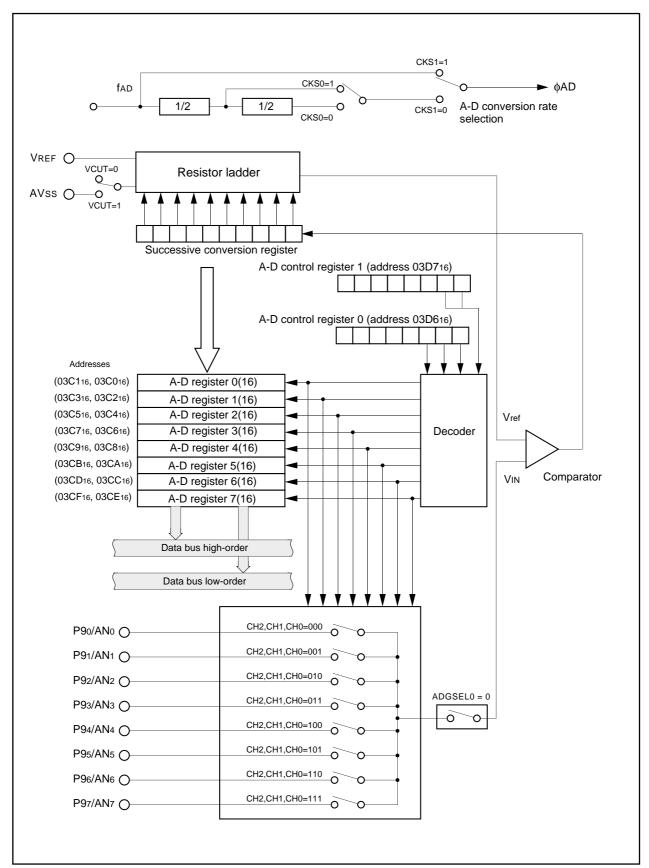
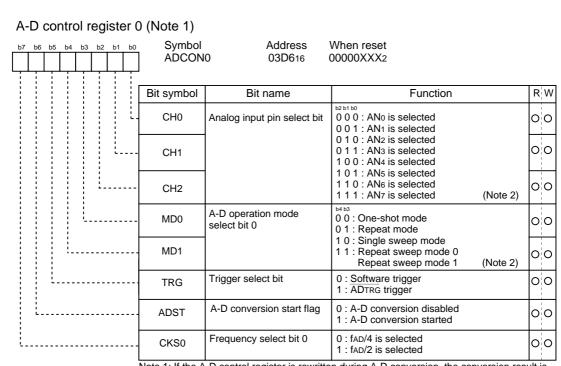


Figure 1.17.1. Block diagram of A-D converter



Note 1: If the A-D control register is rewritten during A-D conversion, the conversion result is indeterminate.

Note 2: When changing A-D operation mode, set analog input pin again.

A-D control register 1 (Note)

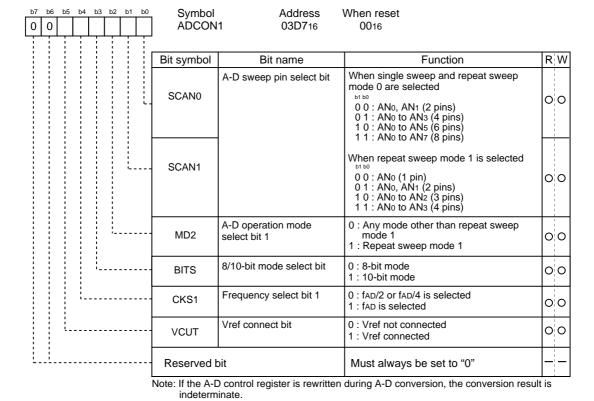


Figure 1.17.2. A-D converter-related registers (1)



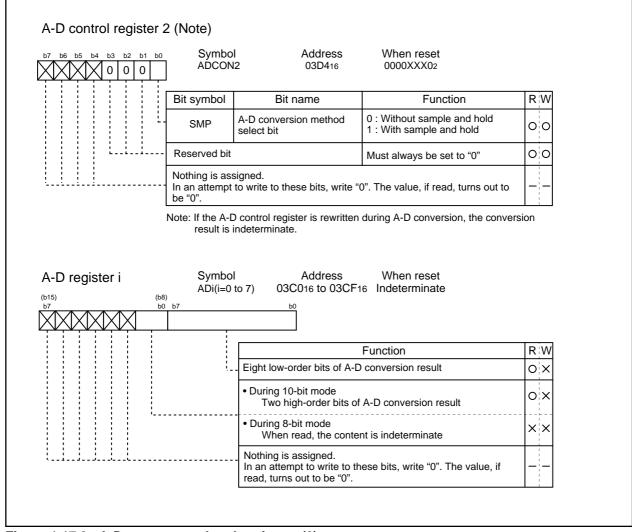


Figure 1.17.3. A-D converter-related registers (2)

(1) One-shot mode

In one-shot mode, the pin selected using the analog input pin select bit is used for one-shot A-D conversion. Table 1.17.2 shows the specifications of one-shot mode. Figure 1.17.4 shows the A-D control register in one-shot mode.

Table 1.17.2. One-shot mode specifications

	•
Item	Specification
Function	The pin selected by the analog input pin select bit is used for one A-D conversion
Start condition	Writing "1" to A-D conversion start flag
Stop condition	• End of A-D conversion (A-D conversion start flag changes to "0", except
	when external trigger is selected)
	Writing "0" to A-D conversion start flag
Interrupt request generation timing	End of A-D conversion
Input pin	One of ANo to AN7, as selected
Reading of result of A-D converter	Read A-D register corresponding to selected pin

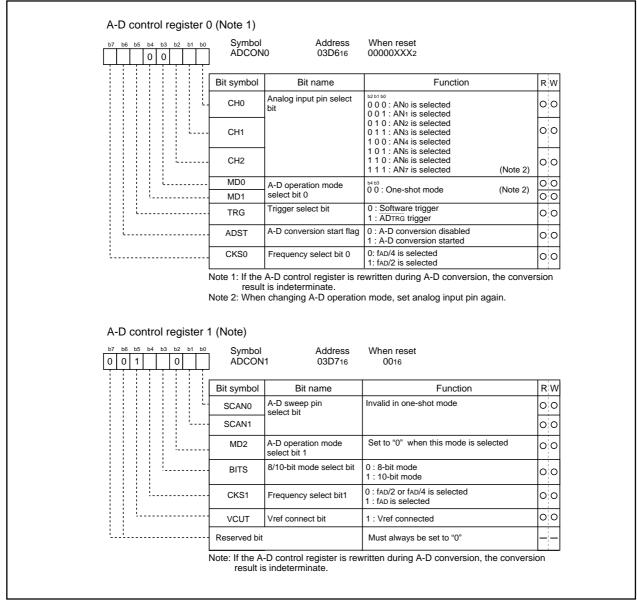


Figure 1.17.4. A-D conversion register in one-shot mode



(2) Repeat mode

In repeat mode, the pin selected using the analog input pin select bit is used for repeated A-D conversion. Table 1.17.3 shows the specifications of repeat mode. Figure 1.17.5 shows the A-D control register in repeat mode.

Table 1.17.3. Repeat mode specifications

Item	Specification
Function	The pin selected by the analog input pin select bit is used for repeated A-D conversion
Star condition	Writing "1" to A-D conversion start flag
Stop condition	Writing "0" to A-D conversion start flag
Interrupt request generation timing	None generated
Input pin	One of ANo to ANo, as selected
Reading of result of A-D converter	Read A-D register corresponding to selected pin (at any time)

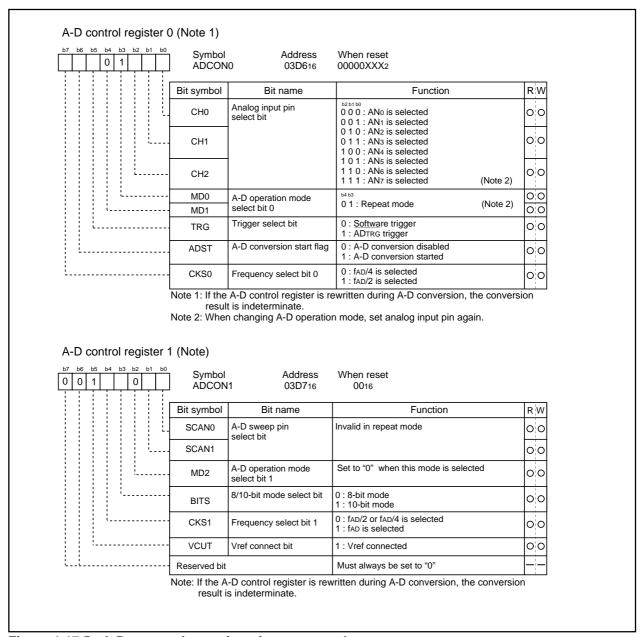


Figure 1.17.5. A-D conversion register in repeat mode



(3) Single sweep mode

In single sweep mode, the pins selected using the A-D sweep pin select bit are used for one-by-one A-D conversion. Table 1.17.4 shows the specifications of single sweep mode. Figure 1.17.6 shows the A-D control register in single sweep mode.

Table 1.17.4. Single sweep mode specifications

Item	Specification
Function	The pins selected by the A-D sweep pin select bit are used for one-by-one A-D conversion
Start condition	Writing "1" to A-D converter start flag
Stop condition	• End of A-D conversion (A-D conversion start flag changes to "0", except
	when external trigger is selected)
	Writing "0" to A-D conversion start flag
Interrupt request generation timing	End of A-D conversion
Input pin	ANo and AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins), or ANo to AN7 (8 pins)
Reading of result of A-D converter	Read A-D register corresponding to selected pin

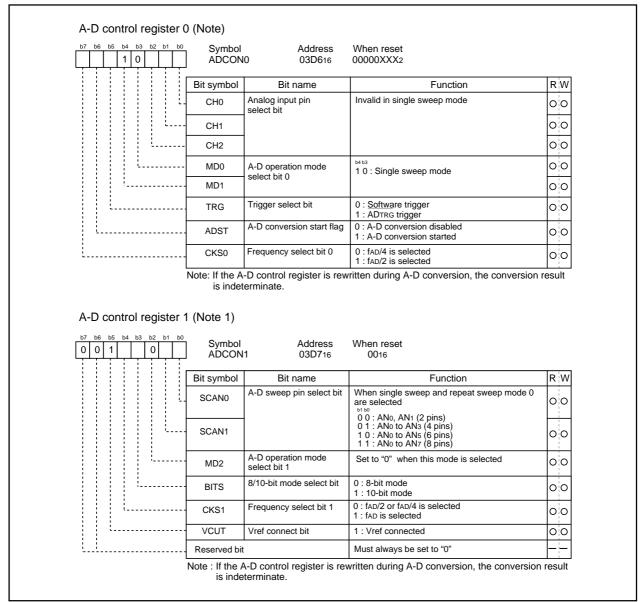


Figure 1.17.6. A-D conversion register in single sweep mode



(4) Repeat sweep mode 0

In repeat sweep mode 0, the pins selected using the A-D sweep pin select bit are used for repeat sweep A-D conversion. Table 1.17.5 shows the specifications of repeat sweep mode 0. Figure 1.17.7 shows the A-D control register in repeat sweep mode 0.

Table 1.17.5. Repeat sweep mode 0 specifications

Item	Specification
Function	The pins selected by the A-D sweep pin select bit are used for repeat A-D conversion
Start condition	Writing "1" to A-D conversion start flag
Stop condition	Writing "0" to A-D conversion start flag
Interrupt request generation timing	None generated
Input pin	ANo and AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins), or ANo to AN7 (8 pins)
Reading of result of A-D converter	Read A-D register corresponding to selected pin (at any time)

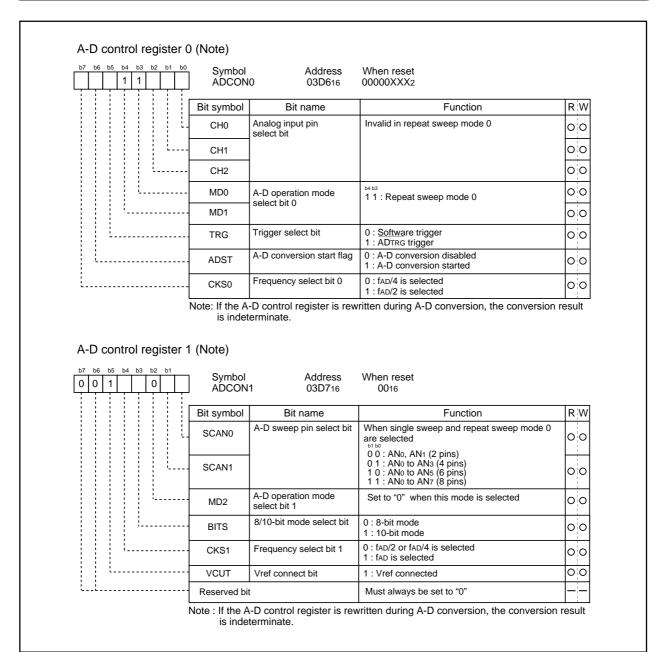


Figure 1.17.7. A-D conversion register in repeat sweep mode 0

(5) Repeat sweep mode 1

In repeat sweep mode 1, all pins are used for A-D conversion with emphasis on the pin or pins selected using the A-D sweep pin select bit. Table 1.17.6 shows the specifications of repeat sweep mode 1. Figure 1.17.8 shows the A-D control register in repeat sweep mode 1.

Table 1.17.6. Repeat sweep mode 1 specifications

Item	Specification
Function	All pins perform repeat A-D conversion, with emphasis on the pin or
	pins selected by the A-D sweep pin select bit
	Example : ANo selected ANo → AN1 → AN0 → AN2 → AN0 → AN3, etc
Start condition	Writing "1" to A-D conversion start flag
Stop condition	Writing "0" to A-D conversion start flag
Interrupt request generation timing	None generated
Input pin	With emphasis on these pins; ANo (1 pin), ANo and AN1 (2 pins), ANo to AN2
	(3 pins), ANo to AN3 (4 pins)
Reading of result of A-D converter	Read A-D register corresponding to selected pin (at any time)

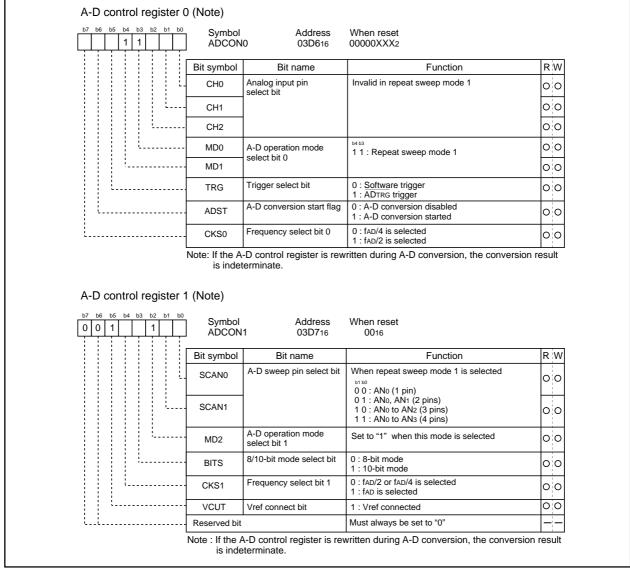


Figure 1.17.8. A-D conversion register in repeat sweep mode 1



Sample and hold

Sample and hold is selected by setting bit 0 of the A-D control register 2 (address 03D416) to "1". When sample and hold is selected, the rate of conversion of each pin increases. As a result, a 28 \$\phiAD\$ cycle is achieved with 8-bit resolution and 33 \$\phiAD\$ with 10-bit resolution. Sample and hold can be selected in all modes. However, in all modes, be sure to specify before starting A-D conversion whether sample and hold is to be used. When sample and hold is selected, apply a 4.0 V - 5.5 V voltage to Vcc.



D-A Converter

This is an 8-bit, R-2R type D-A converter. The microcomputer contains three independent D-A converters of this type.

D-A conversion is performed when a value is written to the corresponding D-A register. Bits 0 to 2 (D-A output enable bits) of the D-A control register decide if the result of conversion is to be output. Do not set the target port to output mode if D-A conversion is to be performed.

Output analog voltage (V) is determined by a set value (n : decimal) in the D-A register.

$$V = VREF X n / 256 (n = 0 to 255)$$

VREF: reference voltage

Table 1.18.1 lists the performance of the D-A converter. Figure 1.18.1 shows the block diagram of the D-A converter. Figure 1.18.2 shows the D-A converter Equivalent circuit.

Table 1.18.1. Performance of D-A converter

Item	Performance
Conversion method	R-2R method
Resolution	8 bits
Analog output pin	3 channels

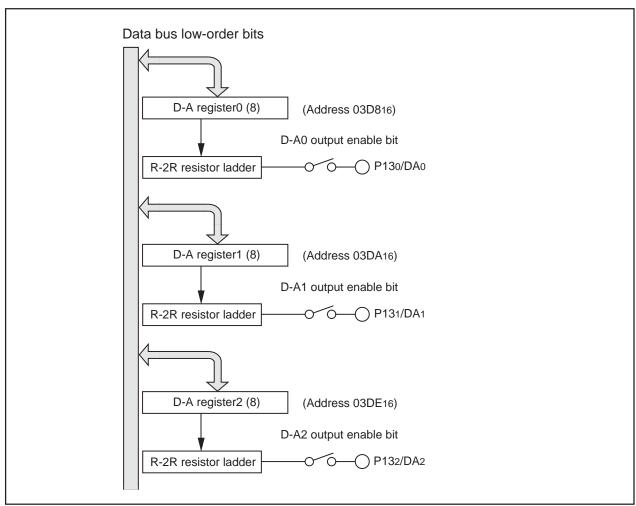


Figure 1.18.1. Block diagram of D-A converter



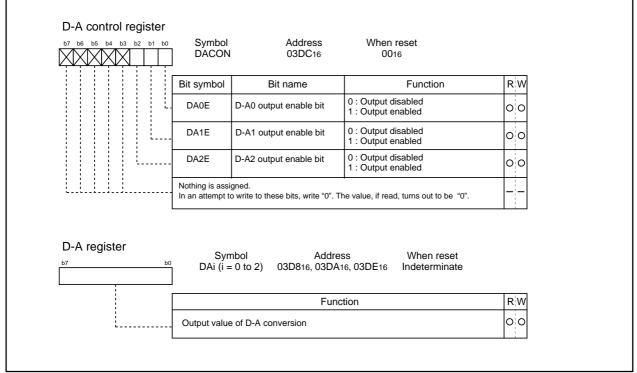


Figure 1.18.2. D-A control register

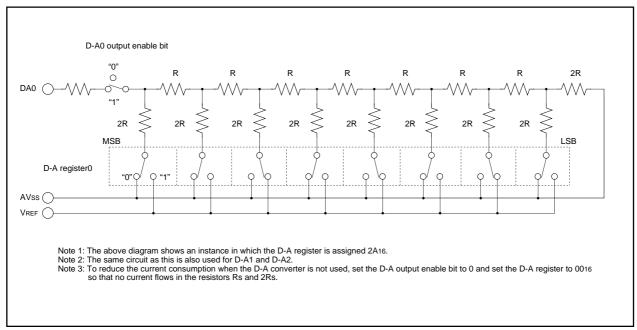


Figure 1.18.3. D-A converter equivalent circuit

Programmable I/O Ports

There are 104 programmable I/O ports: P0 to P13 (excluding P77). Each port can be set independently for input or output using the direction register. A pull-up resistance for each block of 4 ports can be set. P77 is an input-only port and has no built-in pull-up resistance.

Figures 1.19.1 to 1.19.4 show the programmable I/O ports. Figure 1.19.5 shows the I/O pins.

Each pin functions as a programmable I/O port and as the I/O for the built-in peripheral devices.

To use the pins as the inputs for the built-in peripheral devices, set the direction register of each pin to input mode. When the pins are used as the outputs for the built-in peripheral devices (other than the D-A converter), they function as outputs regardless of the contents of the direction registers. When pins are to be used as the outputs for the D-A converter, do not set the direction registers to output mode. See the descriptions of the respective functions for how to set up the built-in peripheral devices.

(1) Direction registers

Figure 1.19.6 shows the direction registers.

These registers are used to choose the direction of the programmable I/O ports. Each bit in these registers corresponds one for one to each I/O pin.

Note: There is no direction register bit for P77.

(2) Port registers

Figure 1.19.7 shows the port registers.

These registers are used to write and read data for input and output to and from an external device. A port register consists of a port latch to hold output data and a circuit to read the status of a pin. Each bit in port registers corresponds one for one to each I/O pin.

(3) Pull-up control registers

Figure 1.19.8 shows the pull-up control registers.

The pull-up control register can be set to apply a pull-up resistance to each block of 4 ports. When ports are set to have a pull-up resistance, the pull-up resistance is connected only when the direction register is set for input. The pull-up resistance is not connected for pins that are set for output from peripheral functions, regardless of the setting in the pull-up control register. When pull-up is ON for ports P1 and P2, an intermittent pull-up that pulls up the port for only a set period of time, can be performed from the key input mode register.

(4) Key input mode register

Figure 1.19.9 shows the key input mode register.

With bits 0 and 1 of this register, it is possible to select both edges or the fall edge of the key input for P1 and P2. Also, with bit 2, it is possible to make the pull-up for a port (P1 or P2), which is set for pull-up using the pull-up control register, automatically connect as an intermittent pull-up. And, using the significant 3 bits, the pull-up resistance can be connected to and disconnected from ports P12 and P13.

(5) Real-time port control register

Figure 1.19.10 shows the real-time port control register. The real-time port control register can be used to set the registers of ports P0, P1, P2 and P12 for real-time port output, whereby output is synchronized with timer overflow of timers A0, A1, A5 and A6 in the timer mode. For details, see "Real-time Port".



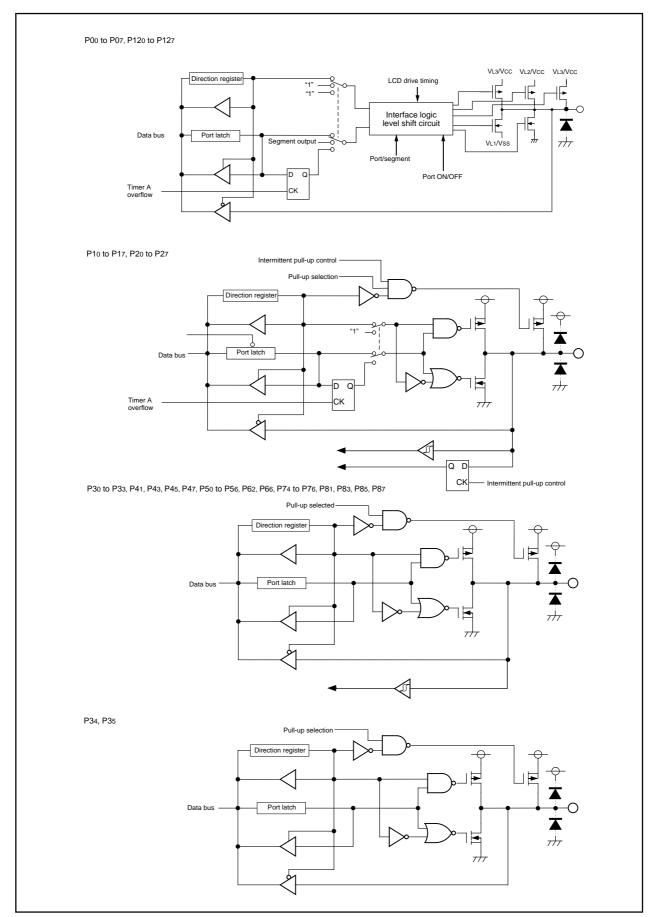


Figure 1.19.1. Programmable I/O ports (1)

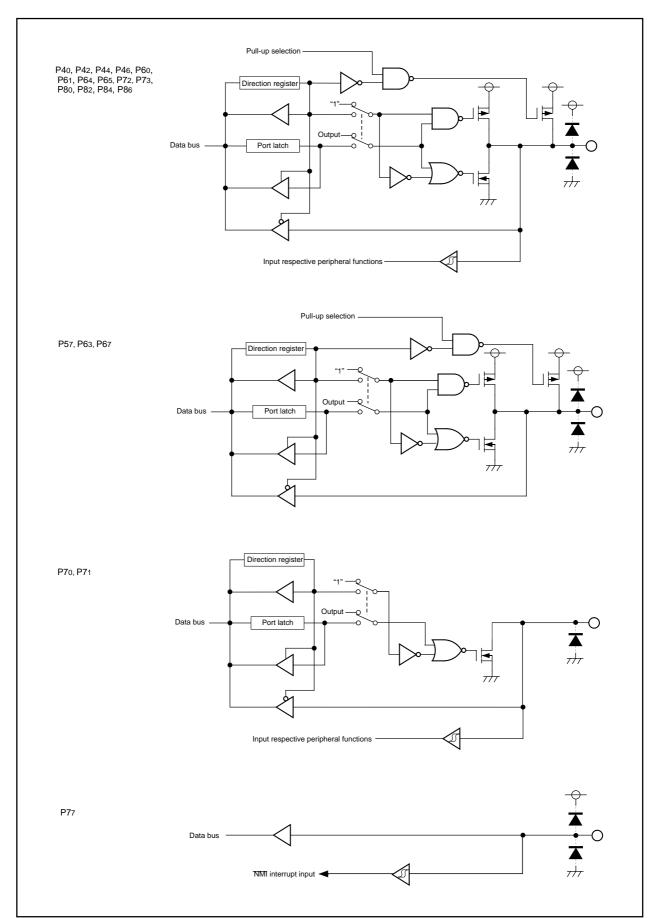


Figure 1.19.2. Programmable I/O ports (2)



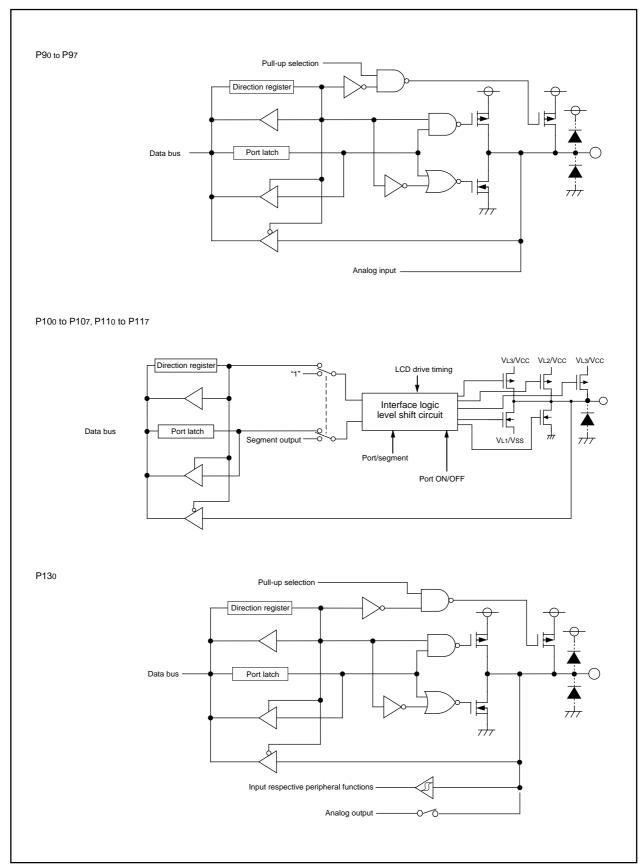


Figure 1.19.3. Programmable I/O ports (3)

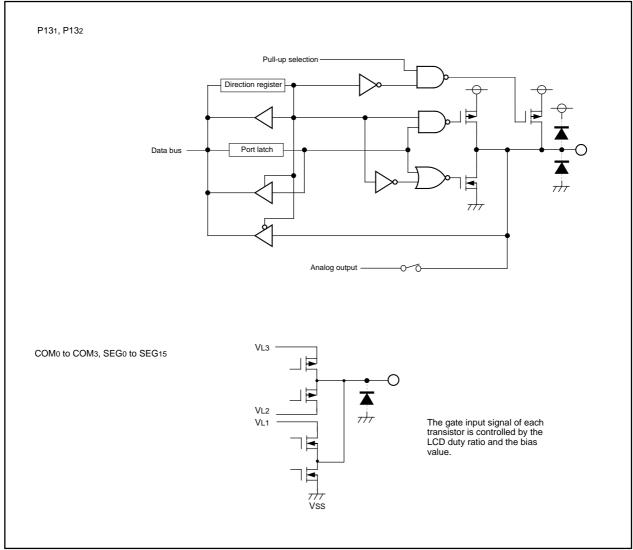


Figure 1.19.4. Programmable I/O ports (4)

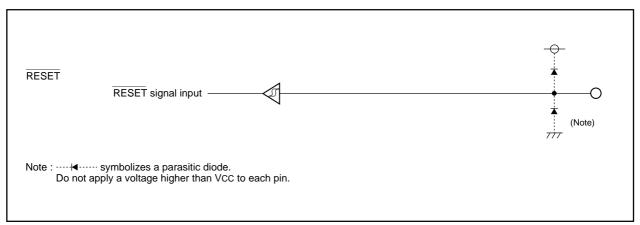


Figure 1.19.5. I/O pins



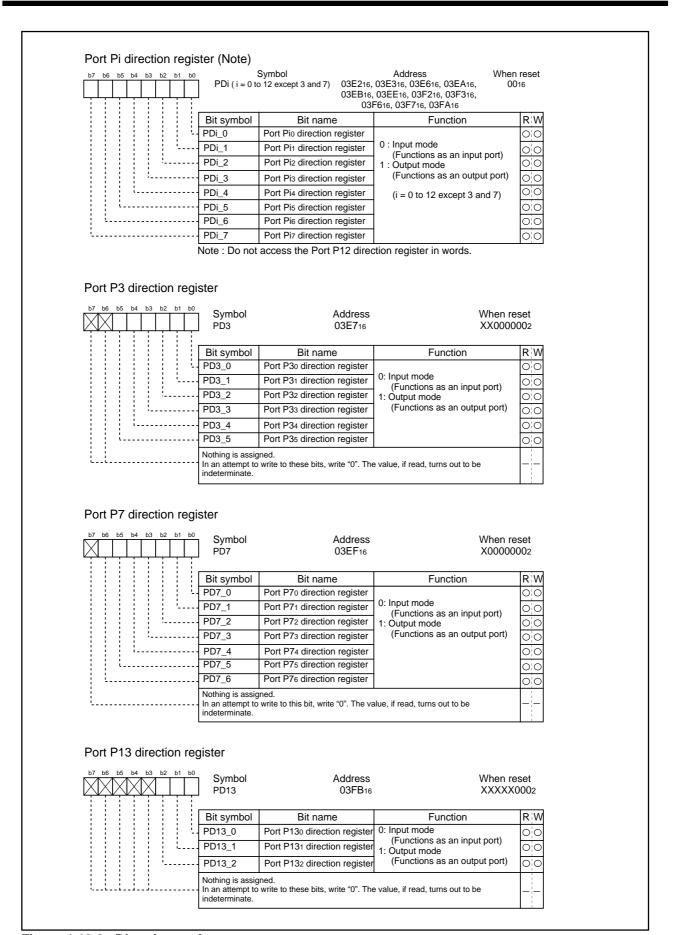


Figure 1.19.6. Direction register



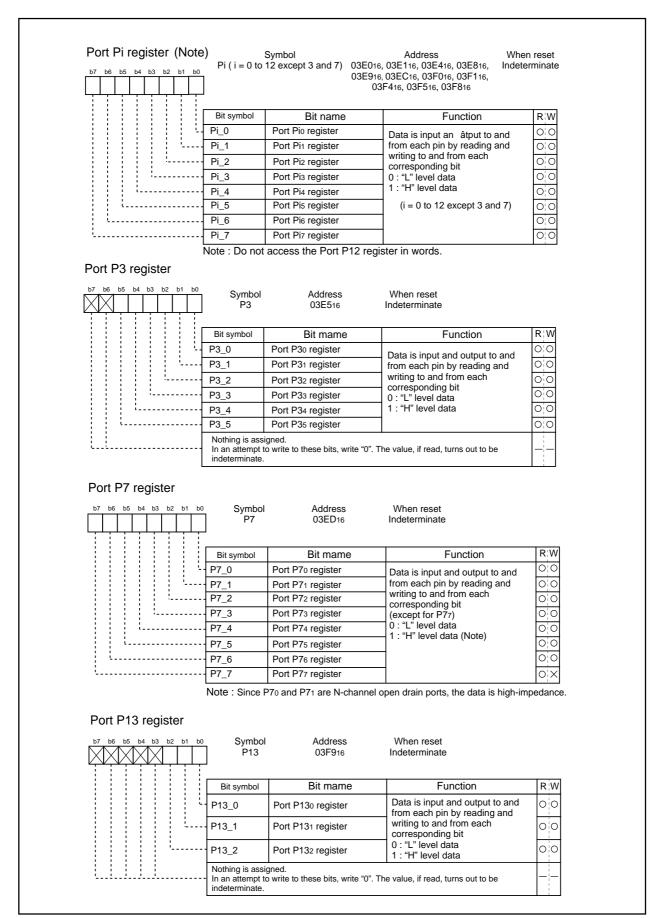
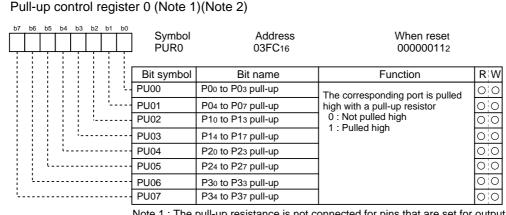


Figure 1.19.7. Port register

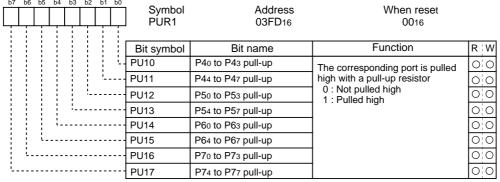




Note 1 : The pull-up resistance is not connected for pins that are set for output from peripheral functions, regardless of the setting in the pull-up control register.

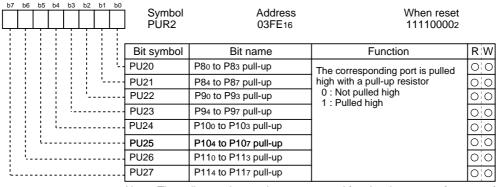
Note 2: Do not access this register in words.

Pull-up control register 1 (Note)



Note: The pull-up resistance is not connected for pins that are set for output from peripheral functions, regardless of the setting in the pull-up control register.

Pull-up control register 2 (Note)



Note: The pull-up resistance is not connected for pins that are set for output from peripheral functions, regardless of the setting in the pull-up control register.

Figure 1.19.8. Pull-up control register



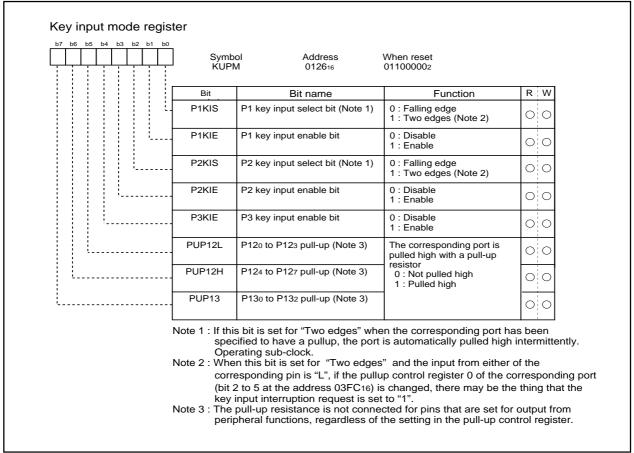


Figure 1.19.9. Key input mode register

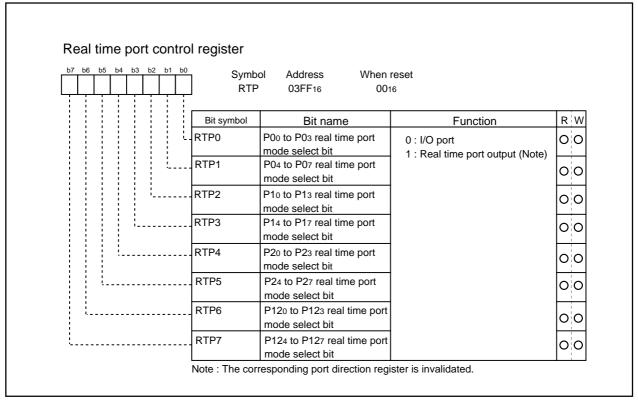


Figure 1.19.10. Realtime port control register



Table 1.19.1.	Example connection of	unused pins	in single-chip mode
---------------	-----------------------	-------------	---------------------

Pin name	Connection
Ports P0 to P13 (excluding P77)	After setting for output mode, leave these pins open; or after setting for input mode, connect every pin to Vss via a resistor (Note 1, Note 3).
XOUT (Note 2), XCOUT	Open
XCIN	Connect this pin to Vss via a resistor (pull-down)
NMI	Connect this pin to Vcc via a resistor (pull-up)
AVcc	Connect to Vcc
AVSS, VREF	Connect to Vss
COMo to COM3	Open
SEG0 to SEG15	Open
C1, C2	Open
VL2, VL3	Connect to Vcc
VL1	Connect to Vss
CNVss	Connect this pin to Vss via a resistor (pull-down)

Note 1: If setting these pins in output mode and opening them, ports are in input mode until switched into output mode by use of software after reset. Thus the voltage levels of the pins become unstable, and there can be instances in which the power source current increases while the ports are in input mode.

In view of an instance in which the contents of the direction registers change due to a runaway generated by noise or other causes, setting the contents of the direction registers periodically by use of software increases program reliability.

- Note 2: When an external clock is input to the XIN pin.
- Note 3: Output "L" if port P70 and P71 are set to output mode. Port P70 and P71 are N channel open drain.

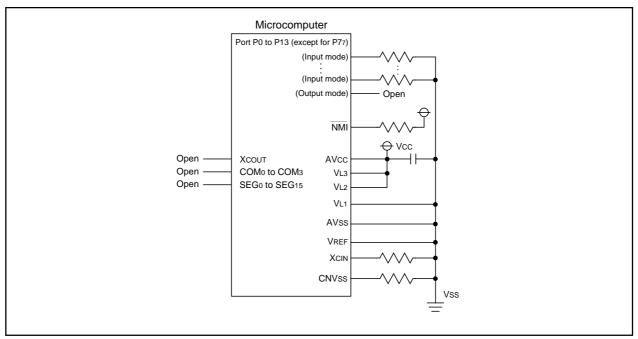


Figure 1.19.11. Example connection of unused pins

Usage Precaution

Timer A (timer mode)

(1) Reading the timer Ai register while a count is in progress allows reading, with arbitrary timing, the value of the counter. Reading the timer Ai register with the reload timing gets "FFF16". Reading the timer Ai register after setting a value in the timer Ai register with a count halted but before the counter starts counting gets a proper value.

Timer A (event counter mode)

- (1) Reading the timer Ai register while a count is in progress allows reading, with arbitrary timing, the value of the counter. Reading the timer Ai register with the reload timing gets "FFF16" by underflow or "000016" by overflow. Reading the timer Ai register after setting a value in the timer Ai register with a count halted but before the counter starts counting gets a proper value.
- (2) When stop counting in free run type, set timer again.

Timer A (one-shot timer mode)

- (1) Setting the count start flag to "0" while a count is in progress causes as follows:
 - The counter stops counting and a content of reload register is reloaded.
 - The TAiout pin outputs "L" level.
 - The interrupt request generated and the timer Ai interrupt request bit goes to "1".
- (2) The timer Ai interrupt request bit goes to "1" if the timer's operation mode is set using any of the following procedures:
 - Selecting one-shot timer mode after reset.
 - Changing operation mode from timer mode to one-shot timer mode.
 - Changing operation mode from event counter mode to one-shot timer mode.

 Therefore, to use timer Ai interrupt (interrupt request bit), set timer Ai interrupt request bit to "0" after the above listed changes have been made.

Timer A (pulse width modulation mode)

- (1) The timer Ai interrupt request bit becomes "1" if setting operation mode of the timer in compliance with any of the following procedures:
 - Selecting PWM mode after reset.
 - Changing operation mode from timer mode to PWM mode.
 - Changing operation mode from event counter mode to PWM mode.

Therefore, to use timer Ai interrupt (interrupt request bit), set timer Ai interrupt request bit to "0" after the above listed changes have been made.

(2) Setting the count start flag to "0" while PWM pulses are being output causes the counter to stop counting. If the TAiout pin is outputting an "H" level in this instance, the output level goes to "L", and the timer Ai interrupt request bit goes to "1". If the TAiout pin is outputting an "L" level in this instance, the level does not change, and the timer Ai interrupt request bit does not becomes "1".

Timer B (timer mode, event counter mode)

(1) Reading the timer Bi register while a count is in progress allows reading, with arbitrary timing, the value of the counter. Reading the timer Bi register with the reload timing gets "FFF16". Reading the timer Bi register after setting a value in the timer Bi register with a count halted but before the counter starts counting gets a proper value.



Timer B (pulse period/pulse width measurement mode)

- (1) If changing the measurement mode select bit is set after a count is started, the timer Bi interrupt request bit goes to "1".
- (2) When the first effective edge is input after a count is started, an indeterminate value is transferred to the reload register. At this time, timer Bi interrupt request is not generated.

Real time port

- (1) Make sure timer Ai for real time port output is set for timer mode, and is set to have "no gate function" using the gate function select bit.
- (2) Before setting the real time port mode select bit to "1", temporarily turn off the timer Ai used and write its set value to the timer Ai register.

Serial I/O

When the IIC mode select bit (bit 0 at address 037716) is set to "1";

- (1) When setting up port P7 (address 03EF16), write immediate values. If you use Read/Modify/Write instructions (BSET, BCLR, AND, OR, etc..) on the port P7 direction register, the value of P71 direction register may change to unknown data.
- (2) Only for the mask ROM version, when the internal/external clock select bit (bit 3 of address 037816) is set to "1 (set to slave)", the SCL wait output bit (bit 2 of address 037616) and SCL wait output bit 2 (bit 5 of address 037616) do not function.
- (3) Only for the mask ROM version, when the internal/external clock select bit (bit 3 of address 037816) is set to "1 (set to slave)", the port P71 cannot be read unless the port P71 direction register (bit 1 of address 03EF16) is set to "0", although it is specified as follows; "When IICM=1, the port pin shall be able to be read even if the P71 direction register=1."

A-D Converter

- (1) Write to each bit (except bit 6) of A-D control register 0, to each bit of A-D control register 1, and to bit 0 of A-D control register 2 when A-D conversion is stopped (before a trigger occurs). In particular, when the Vref connection bit is changed from "0" to "1", start A-D conversion after an elapse of 1 µs or longer.
- (2) When changing A-D operation mode, select analog input pin again.
- (3) Using one-shot mode or single sweep mode Read the correspondence A-D register after confirming A-D conversion is finished. (It is known by A-D conversion interrupt request bit.)
- (4) Using repeat mode, repeat sweep mode 0 or repeat sweep mode 1 Use the undivided main clock as the internal CPU clock.

Stop Mode and Wait Mode

- (1) When returning from stop mode by hardware reset, RESET pin must be set to "L" level until main clock oscillation is stabilized.
- (2) When switching to either wait mode or stop mode, instructions occupying four bytes either from the WAIT instruction or from the instruction that sets the every-clock stop bit to "1" within the instruction queue are prefetched and then the program stops. So put at least four NOPs in succession either to the WAIT instruction or to the instruction that sets the every-clock stop bit to "1".
- (3) When the MCU running in low-speed or low power dissipation mode, do not enter WAIT mode with WAIT peripheral function clock stop bit set to "1".



Interrupts

- (1) Reading address 0000016
 - When maskable interrupt is occurred, CPU read the interrupt information (the interrupt number and interrupt request level) in the interrupt sequence.

The interrupt request bit of the certain interrupt written in address 0000016 will then be set to "0". Reading address 0000016 by software sets enabled highest priority interrupt source request bit to "0". Though the interrupt is generated, the interrupt routine may not be executed.

Do not read address 0000016 by software.

- (2) Setting the stack pointer
 - The value of the stack pointer immediately after reset is initialized to 000016. Accepting an interrupt before setting a value in the stack pointer may become a factor of runaway. Be sure to set a value in the stack pointer before accepting an interrupt. When using the NMI interrupt, initialize the stack pointer at the beginning of a program. Concerning the first instruction immediately after reset, generating any interrupts including the NMI interrupt is prohibited.
- (3) The NMI interrupt
 - The NMI interrupt can not be disabled. Be sure to connect NMI pin to Vcc via a resistor (pull-up) if unused. Be sure to work on it.
 - Do not get either into stop mode with the NMI pin set to "L".
- (4) External interrupt
 - When the polarity of the $\overline{\text{INT}_0}$ to $\overline{\text{INT}_5}$ pins is changed, the interrupt request bit is sometimes set to "1". After changing the polarity, set the interrupt request bit to "0".
- (5) Rewrite the interrupt control register
 - To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. If there is possibility of the interrupt request occur, rewrite the interrupt control register after the interrupt is disabled. The program examples are described as follow:

Example 1:

```
INT_SWITCH1:
       FCLR
                              ; Disable interrupts.
       AND.B
                #00h, 0055h
                              ; Clear TA0IC int. priority level and int. request bit.
       NOP
                              ; Four NOP instructions are required when using HOLD function.
       NOP
       FSET
                              ; Enable interrupts.
Example 2:
   INT_SWITCH2:
       FCLR
                               ; Disable interrupts.
                #00h, 0055h
       AND.B
                              ; Clear TA0IC int. priority level and int. request bit.
       MOV.W MEM, R0
                                Dummy read.
       FSET
                               ; Enable interrupts.
Example 3:
   INT SWITCH3:
       PUSHC FLG
                               ; Push Flag register onto stack
       FCLR
                               ; Disable interrupts.
       AND.B
                #00h, 0055h
                              ; Clear TA0IC int. priority level and int. request bit.
       POPC
                FI G
                               : Enable interrupts.
```

The reason why two NOP instructions (four when using the HOLD function) or dummy read are inserted before FSET I in Examples 1 and 2 is to prevent the interrupt enable flag I from being set before the interrupt control register is rewritten due to effects of the instruction queue.

 When a instruction to rewrite the interrupt control register is executed but the interrupt is disabled, the interrupt request bit is not set sometimes even if the interrupt request for that register has been generated. This will depend on the instruction. If this creates problems, use the below instructions to change the register.

Instructions: AND, OR, BCLR, BSET



Table 1.21.1. Absolute maximum ratings

Symbol		Parameter	Condition	Rated value	Unit
Vcc	Supply v	oltage	Vcc=AVcc	- 0.3 to 6.5	V
AVcc	Analog s	upply voltage	Vcc=AVcc	- 0.3 to 6.5	V
Vı	Input voltage	RESET, V _{REF} , X _{IN} P00 to P07, P10 to P17, P20 to P27, P30 to P35, P40 to P47, P50 to P57, P60 to P67, P72 to P77, P80 to P87, P90 to P97, P100 to P107, P110 to P117, P120 to P127, P130 to P132 (Mask ROM version CNVss)		- 0.3 to Vcc+0.3	V
		VL1		- 0.3 to VL2	
		VL2		VL1 to VL3	
		VL3		VL2 to 6.5	
		P70, P71, C1, C2 (flash memory version CNVss)		- 0.3 to 6.5	
Vo	Output voltage	P10 to P17, P20 to P27, P30 to P35, P40 to P47, P50 to P57, P60 to P67, P72 to P76, P80 to P87, P90 to P97, P130 to P132, XOUT		- 0.3 to Vcc+0.3	V
		P0 ₀ to P0 ₇ , P10 ₀ to P10 ₇ ,	When output port	- 0.3 to Vcc	
		P110 to P117, P120 to P127,	When segment output	- 0.3 to VL3	
		P70, P71		- 0.3 to 6.5	
Pd	Power di	ssipation	Ta = 25°C	300	mW
Topr	Operatin	g ambient temperature		– 20 to 85	°C
Tstg	Storage t	temperature		- 40 to 150	°C



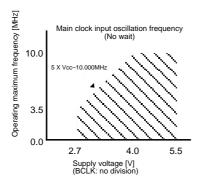
Table 1.21.2. Recommended operating conditions (referenced to VCC = 2.7V to 5.5V at Ta = -20 to $85^{\circ}C$ unless otherwise specified)

		6				Standard	k	Unit
Symbol	Parameter			Min	Тур.	Max.	Ullit	
Vcc	Supply voltage				2.7	5.0	5.5	V
AVcc	Analog supply	voltage				Vcc		V
Vss	Analog supply	voltage				0		V
AVss	Analog supply	voltage				0		V
ViH	HIGH input voltage		67, P72 to P77, P8 o P117, P120 to F	80 to P35, P40 to P47, 80 to P87, P90 to P97, P127, 130 to P132,	0.8Vcc		Vcc	V
		P70, P71			0.8Vcc		6.5	
VIL	LOW input voltage		67, P70 to P77, P8	80 to P35, P40 to P47, 80 to P87, P90 to P97, P127, 130 to P132,	0		0.2Vcc	V
IOH (peak)	HIGH peak	P00 to P07, P100 to F	P107, P110 to P1	17, P120 to P127			-0.5	mA
	output current (Note 2)	P10 to P17, P20 to P2 P50 to P57, P60 to P6 P130 to P132		40 to P47, 80 to P87, P90 to P97,			-10.0	IIIA
IOH (avg)	HIGH average	P00 to P07, P100 to F	P107, P110 to P1	17, P120 to P127			-0.1	
TOTT (avg)	output current (Note 1)	P10 to P17, P20 to P2 P50 to P57, P60 to P6 P130 to P132		40 to P47, 80 to P87, P90 to P97,			-5.0	mA
IOL (peak)	LOW peak	P0o to P07, P10o to F	P107, P110 to P1	17, P120 to P127			5.0	
	output current (Note 2)	P10 to P17, P20 to P2	27,P30 to P35, P4				10.0	mA
IOL (avg)	LOW average	P00 to P07, P100 to F	P107, P110 to P1	17, P120 to P127			2.5	
	output current (Note 1)	P10 to P17, P20 to P2 P50 to P57, P60 to P0 P130 to P132	,	lo to P47, 30 to P87, P90 to P97,			5.0	mA
				Vcc=4.0V to 5.5V	0		10	MHz
f (XIN)	Main clock inp		No wait	Vcc=2.7V to 4.0V	0		5 x Vcc -10.000	MHz
(· ····)	oscillation freq		\\\/:4bo:4	Vcc=4.0V to 5.5V	0		10	MHz
	(1	Note 3)	With wait	Vcc=2.7V to 4.0V	0		2.31 x Vcc +0.760	MHz
f (Xcin)	Subclock oscilla	tion frequency				32.768	50	kHz

Note 1: The mean output current is the mean value within 100ms.

Note 2: The total IoL (peak) for ports P0, P1, P2, P30 to P35, P4, P5, P6, P70 to P76 and P122 to P127 must be 80mA max. The total IOH (peak) for ports P0, P1, P2, P30 to P35, P4, P5, P6, P72 to P76 and P122 to P127 must be 80mA max. The total IoL (peak) for ports P8, P9, P10, P11, P120, P121 and P130 to P132 must be 80mA max. The total IOH (peak) for ports P8, P9, P10, P11, P120, P121 and P130 to P132 must be 80mA max.

Note 3: Relationship between main clock oscillation frequency and supply voltage.



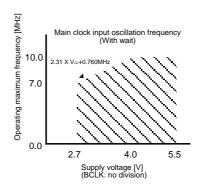




Table 1.21.3. Electrical characteristics (referenced to VCC = 5V, Vss = 0V at Ta = 25°C, f(XIN)=10MHz unless otherwise specified)

0	Dovernator			Magazining appolition	Standard			1.1
Symbol		Paramete	er	Measuring condition	Min	Тур.	Max.	Unit
Vон	HIGH output voltage	P00 to P07, P100 P110 to P117, P1		Iон= -0.1mA	3.0			V
Vон	HIGH output voltage	HIGH output P10 to P17, P20 to P27, P30 to F voltage P40 to P47, P50 to P57, P60 to F		IOH= -5mA	3.0			
		P72 to P76, P80 t P130 to P132	to P87, P90 to P97,	Іон= –200μА	4.7			V
Voн	HIGH output	Хоит	HIGHPOWER	IOH= -1mA	3.0			V
	voltage		LOWPOWER	Iон= −0.5mA	3.0			·
Voн	HIGH output	Хсоит	HIGHPOWER	With no load applied		3.0		V
	voltage		LOWPOWER	With no load applied		1.6		•
VoL	LOW output voltage	P30 to P35, P40	to P17, P20 to P27, to P47, P50 to P57, to P76, P80 to P87,	IoL=5mA			2.0	V
		P90 to P97, P100 P110 to P117, P1 P130 to P132	to P107,	Ιοι=200μΑ			0.45	
Vol	LOW output	Хоит	HIGHPOWER	IoL=1mA			2.0	V
	voltage	7.00.	LOWPOWER	IoL=0.5mA			2.0	V
Vol	LOW output	VCOLIT	HIGHPOWER	With no load applied		0		.,
VOL	voltage	AC001	LOWPOWER	With no load applied		0		V
VT+-VT-	Hysteresis	TA0IN to TA7IN, INTo to INT5, AD CTS1, CLK0, CLI TA2OUT to TA40 Klo to Kl15 (Note	TRG, CTS0, K1, NMI, UT, TA70UT,		0.2		0.8	V
VT+-VT-	Hysteresis	RESET			0.2		1.8	V
Іін	HIGH input current	P30 to P35, P40 to P60 to P67, P70 to P97, P100 P110 to P117, P1		Vi=5V			5.0	μΑ
liL	LOW input current	P30 to P35, P40 to P60 to P67, P70 to P97, P100 P110 to P117, P1		Vi=0V			-5.0	μА
RPULLUP	Pull-up resistance	P30 to P35, P40 t		Vi=0V	30.0	50.0	167.0	kΩ
RfXIN	Feedback res	sistance XIN				1.0		$M\Omega$
RfXCIN	Feedback re	sistance Xcin				6.0		МΩ
VRAM	RAM retention	on voltage		When clock is stopped	2.0			V

Note: Has no effect during intermittent pullup operation.



Table 1.21.4. Electrical characteristics (referenced to VCC = 5V, Vss = 0V at Ta = 25°C, f(XIN)=10MHz unless otherwise specified)

_					Standar		d d	
Symbol	Paramete	r	Measurii	ng condition	Min.	Тур.	Max.	Unit
			Mask ROM, flash memory versions	f(XIN)=10MHz Square wave, no division		19.0	38.0	mA
			Mask ROM version	f(Xcin)=32kHz Square wave		90.0		μA
		I/o pin is no	Flash memory version	f(Xcin)=32kHz Square wave		200.0		μA
Icc	Power supply current	load applied	Mask ROM, flash memory versions	f(XCIN)=32kHz When a WAIT instruction is executed		4.0		μA
				When clock is stopped Ta=25 °C			1.0	
				When clock is stopped Ta=85 °C			20.0	μA
VL3	Supply voltage (VL3) (Note	e)	When charge-pump	not used	2.7		6.5	V
VL1	Supply voltage (VL1)		When charge-pump used		1.3	1.7	2.1	٧
IL1	Power supply current (VL1)		VL1=1.7V, f(LCDCK) =	: 200Hz		3.0	6.0	μA

Note: Rating: VL1=-0.3 V to VL2, VL2=VL1 to VL3, VL3=VL2 to 6.5 V.

Table 1.21.5. A-D conversion characteristics (referenced to VCC = AVCC = VREF = 5V, Vss = AVSS = 0V at $Ta = 25^{\circ}C$, f(XIN) = 10MHz unless otherwise specified)

Cymbol		Parameter	Macauring andition	S	tandar	ď	Unit
Symbol		Parameter	Measuring condition		Тур.	Max.	Unit
_	Resolution	on	VREF =VCC			10	Bits
-	Absolute accuracy	Sample & hold function not available	VREF = VCC = 5V			±3	LSB
	docuracy	Sample & hold function available(10bit)	VREF =VCC= 5V			±3	LSB
		Sample & hold function available(8bit)	VREF = VCC = 5V			±2	LSB
RLADDER	Ladder r	esistance	VREF =VCC	10		40	kΩ
tconv	Convers	ion time(10bit)		3.3			μS
tconv	Convers	ion time(8bit)		2.8			μS
t SAMP	Sampling	g time		0.3			μS
VREF	Reference	ce voltage		2		Vcc	V
VIA	Analog i	nput voltage		0		VREF	V

Table 1.21.6. D-A conversion characteristics (referenced to VCC = AVCC = VREF = 5V, VSS = AVSS = 0V at Ta = 25°C, f(XIN) = 10MHz unless otherwise specified)

Coursels al	Dt	NA Property	S	1.1		
Symbol	Parameter	Measuring condition	Min.	Тур.	Max.	Unit
_	Resolution				8	Bits
_	Absolute accuracy				1.0	%
tsu	Setup time				3	μS
Ro	Output resistance		4	10	20	kΩ
Ivref	Reference power supply input current	(Note)			1.5	mA

Note: This applies when using one D-A converter, with the D-A register for the unused D-A converter set to "0016".

The A-D converter's ladder resistance is not included.

Also, when the Vref is unconnected at the A-D control register, IVREF is sent.



Timing requirements (referenced to VCC = 5V, VSS = 0V at Ta = 25°C unless otherwise specified)

Table 1.21.7. External clock input

Symbol	Doromotor	Star	l lmit	
	Parameter	Min.	Max.	Unit
tc	External clock input cycle time	100		ns
tw(H)	External clock input HIGH pulse width	40		ns
tw(L)	External clock input LOW pulse width	40		ns
tr	External clock rise time		15	ns
tf	External clock fall time		15	ns

Table 1.21.8. Timer A input (counter input in event counter mode)

	_	Stan	dard	
Symbol	Parameter		Max.	Unit
tc(TA)	TAin input cycle time	100		ns
tw(TAH)	TAin input HIGH pulse width	40		ns
tw(TAL)	TAin input LOW pulse width	40		ns

Table 1.21.9. Timer A input (gating input in timer mode)

Symbol	Parameter	Stan Min.	dard	Unit
Cymbol	i didilictei		Max.	Orine
tc(TA)	TAin input cycle time	400		ns
tw(TAH)	TAim input HIGH pulse width	200		ns
tw(TAL)	TAin input LOW pulse width	200		ns

Table 1.21.10. Timer A input (external trigger input in one-shot timer mode)

Cumbal	Parameter -		Standard	
Symbol			Max.	Unit
tc(TA)	TAiın input cycle time	200		ns
tw(TAH)	TAin input HIGH pulse width	100		ns
tw(TAL)	TAin input LOW pulse width	100		ns

Table 1.21.11. Timer A input (external trigger input in pulse width modulation mode)

Symbol	Doromotor	Stan	dard	Unit
	Parameter	Min.	Max.	Unit
tw(TAH)	TAim input HIGH pulse width	100		ns
tw(TAL)	TAin input LOW pulse width	100		ns

Table 1.21.12. Timer A input (up/down input in event counter mode)

Coursels and	Down water	Star	11-7	
Symbol	Parameter	Min.	Max.	Unit
tc(UP)	TAiout input cycle time	2000		ns
tw(UPH)	TAiout input HIGH pulse width	1000		ns
tw(UPL)	TAiout input LOW pulse width	1000		ns
tsu(UP-TIN)	TAiout input setup time	400		ns
th(TIN-UP)	TAiout input hold time	400		ns



Timing requirements (referenced to VCC = 5V, VSS = 0V at Ta = 25°C unless otherwise specified)

Table 1.21.13. Timer B input (counter input in event counter mode)

Symbol	Doromotor	Stan	l loit	
	Parameter		Max.	Unit
tc(TB)	TBiin input cycle time (counted on one edge)	100		ns
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	40		ns
tw(TBL)	TBin input LOW pulse width (counted on one edge)	40		ns
tc(TB)	TBiin input cycle time (counted on both edges)	200		ns
tw(TBH)	TBiin input HIGH pulse width (counted on both edges)	80		ns
tw(TBL)	TBiin input LOW pulse width (counted on both edges)	80		ns

Table 1.21.14. Timer B input (pulse period measurement mode)

Symbol	Parameter	Stan	Standard	
	Falameter		Max.	Unit
tc(TB)	TBiin input cycle time	400		ns
tw(TBH)	TBil input HIGH pulse width	200		ns
tw(TBL)	TBin input LOW pulse width	200		ns

Table 1.21.15. Timer B input (pulse width measurement mode)

Symbol	Parameter		dard	Unit
			Max.	Offic
tc(TB)	TBiin input cycle time	400		ns
tw(TBH)	TBil input HIGH pulse width	200		ns
tw(TBL)	ТВіім input LOW pulse width	200		ns

Table 1.21.16. A-D trigger input

Symbol	Parameter	Stan	dard	Unit	
	Symbol	Falameter		Max.	Offic
	tc(AD)	ADTRG input cycle time (trigger able minimum)	1000		ns
	tw(ADL)	ADTRG input LOW pulse width	125		ns

Table 1.21.17. Serial I/O

Symbol	Parameter	Star	Unit	
Symbol	Farameter		Max.	Offic
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input HIGH pulse width	100		ns
tw(CKL)	CLKi input LOW pulse width	100		ns
td(C-Q)	TxDi output delay time		80	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	30		ns
th(C-D)	RxDi input hold time	90		ns

Table 1.21.18. External interrupt INTi inputs

Symbol	Parameter	Stan	dard	Unit
	raidilletei		Max.	Offic
tw(INH)	INTi input HIGH pulse width	250		ns
tw(INL)	INTi input LOW pulse width	250		ns



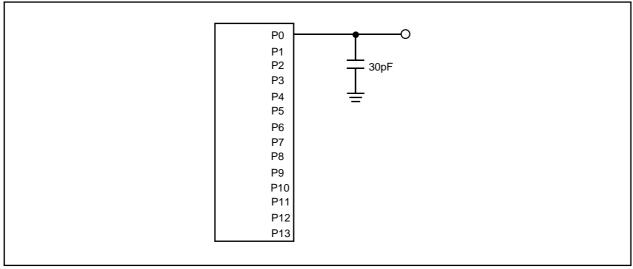


Figure 1.21.1. Port P0 to P13 measurement circuit

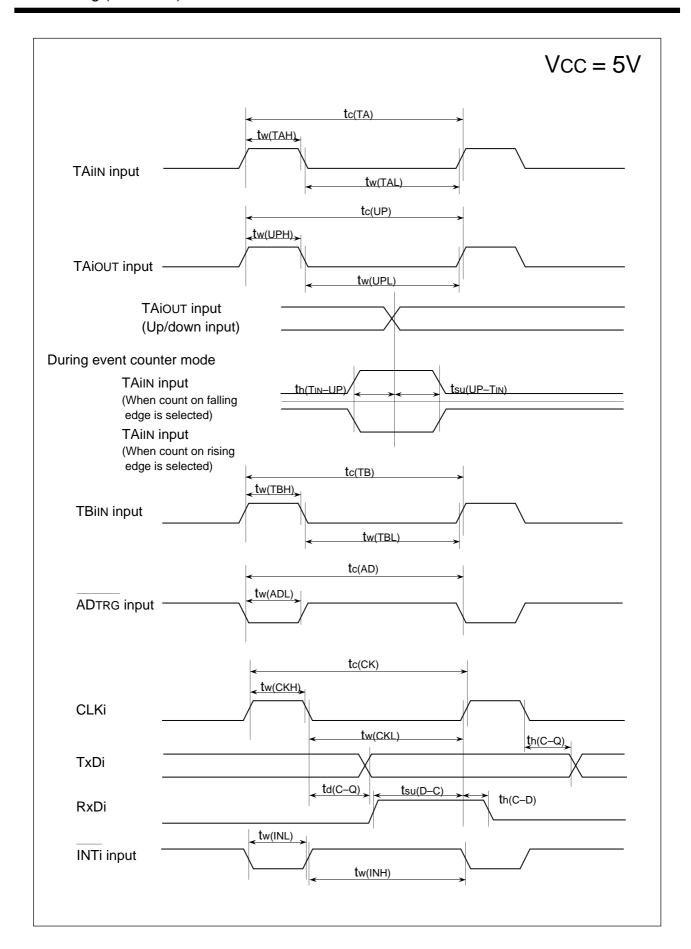




Table 1.21.19. Electrical characteristics (referenced to VCC = 3V, VSS = 0V at Ta = 25°C, f(XIN) = 7MHz, with wait)

					5	Standa	rd	1 1 - 4
Symbol		Parameter	•	Measuring condition	Min	Тур.	Max.	Unit
Vон	HIGH output voltage	P00 to P07, P100 P110 to P117, P1		Іон= –20µА	2.0			V
Vон	HIGH output voltage	P40 to P47, P50 t	o P27, P30 to P35, o P57, P60 to P67, o P87, P90 to P97,	IOH= -1mA	2.5			V
Vон	HIGH output	Хоит	HIGHPOWER	Iон= -0.1mA	2.5			V
	voltage	7,001	LOWPOWER	Іон= −50µА	2.5			•
Voн	HIGH output	t Хсоит	HIGHPOWER	With no load applied		3.0		V
	voltage	7.000.	LOWPOWER	With no load applied		1.6		
Vol	LOW output voltage	P30 to P35, P40 t		IoL=1mA			0.5	V
Vol	LOW output	Хоит	HIGHPOWER	IoL=0.1mA			0.5	V
.01	voltage	7.001	LOWPOWER	loL=50µA			0.5	v
Vol	LOW output	Vacut	HIGHPOWER	With no load applied		0		.,
VOL	voltage	ACOUT	LOWPOWER	With no load applied		0		V
VT+-VT-	Hysteresis	TA0IN to TA7IN, TINTO to INT5, AD CTS1, CLK0, CLK TA20UT to TA40IKIO to KI15 (Note)	TRG, CTS0, K1, NMI, UT, TA70UT,		0.2		0.8	V
VT+-VT-	Hysteresis	RESET			0.2		1.8	V
lін	HIGH input current	P30 to P35, P40 t P60 to P67, P70 t P90 to P97, P100 P110 to P117, P1		VI=3V			4.0	μA
lıL	LOW input current	P30 to P35, P40 t P60 to P67, P70 t P90 to P97, P100 P110 to P117, P1		VI=0V			-4.0	μА
RPULLUP	Pull-up resistance	P30 to P35, P40 t	o P17, P20 to P27, o P47, P50 to P57, o P76, P80 to P87, to P107, 20 to P127,	VI=0V	66.0	120.0	500.0	kΩ
RfXIN	Feedback res	sistance XIN				3.0		МΩ
RfXCIN	Feedback res	sistance Xcin				10.0		ΜΩ
VRAM	RAM retention	n voltage		When clock is stopped	2.0			V

Note: Has no effect during intermittent pullup operation.



Table 1.21.20. Electrical characteristics (referenced to VCC = 3V, VSS = 0V at Ta = 25°C, f(XIN) = 7MHz, with wait)

0	Parameter		Management and the second seco			Lloit		
Symbol			Measuri	ng condition	Min.	Typ.	Max.	Unit
			Mask ROM, flash memory versions	f(XIN)=7MHz Square wave, no division		6.0	15.0	mA
			Mask ROM version	f(Xcin)=32kHz Square wave		40.0		μA
			Flash memory version	f(Xcin)=32kHz Square wave		150.0		μA
Icc		I/o pin is no load applied		f(XCIN)=32kHz When a WAIT instruction is executed Oscillation capacity High (Note)		2.8		μA
				f(XCIN)=32kHz When a WAIT instruction is executed Oscillation capacity Low (Note 1)		0.9		μA
				When clock is stopped Ta=25 °C			1.0	
				When clock is stopped Ta=85 °C			20.0	μA
VL3	Supply voltage (VL3) (Note	2)	When charge-pump	not used	2.7		6.5	V
VL1	Supply voltage (VL1)		When charge-pump	used	1.3	1.7	2.1	V
IL1	Power supply current (VL1)		VL1=1.7V, f(LCDCK)=	200Hz		3.0	6.0	μA

Note 1: With one timer operated using fc32. Note 2: Rating: VL1=-0.3 V to VL2, VL2=VL1 to VL3, VL3=VL2 to 6.5V.

Table 1.21.21. A-D conversion characteristics (referenced to VCC = AVCC = VREF = 3V, VSS = AVSS = 0V at Ta = 25°C, f(XIN) = 7MHz, with wait unless otherwise specified)

Cymbol	Parameter		Measuring condition	S	Unit		
Symbol		Parameter	weasuming condition	Min.	Тур.	Max.	
_	Resolution	on	VREF =VCC			10	Bits
_	Absolute accuracy Sample & hold function not available (8bit)		VREF=VCC = 3V, ØAD=fAD/2			±2	LSB
RLADDER	Ladder re	esistance	VREF =VCC	10		40	kΩ
tconv	Conversi	ion time(8bit)		14.0			μS
VREF	Reference	ce voltage		2.7		Vcc	V
VIA	Analog i	nput voltage		0		VREF	V

Table 1.21.22. D-A conversion characteristics (referenced to VCC = AVCC= VREF= 3V, VSS = AVSS = 0V, at Ta = 25°C, f(XIN) = 7MHz unless otherwise specified)

			S			
Symbol	Parameter	Measuring condition	Min.	Тур.	Max.	Unit
-	Resolution				8	Bits
_	Absolute accuracy				1.0	%
t su	Setup time				3	μs
Ro	Output resistance		4	10	20	kΩ
Ivref	Reference power supply input current	(Note)			1.0	mA

Note: This applies when using one D-A converter, with the D-A register for the unused D-A converter set to "0016". The A-D converter's ladder resistance is not included.

Also, when the Vref is unconnected at the A-D control register, IVREF is sent.



Timing requirements (referenced to VCC = 3V, VSS = 0V at Ta = 25°C unless otherwise specified)

Table 1.21.23. External clock input

Symbol	December	Standa	ndard	I In it	
	Parameter	Min.	Max.	Unit	
tc	External clock input cycle time	143		ns	
tw(H)	External clock input HIGH pulse width	60		ns	
tw(L)	External clock input LOW pulse width	60		ns	
tr	External clock rise time		18	ns	
tf	External clock fall time		18	ns	

Table 1.21.24. Timer A input (counter input in event counter mode)

0 1 1	_	Standard Min. Max.		
Symbol	Parameter	Min.	Max.	Unit
tc(TA)	TAil input cycle time	150		ns
tw(TAH)	TAin input HIGH pulse width	60		ns
tw(TAL)	TAilN input LOW pulse width	60		ns

Table 1.21.25. Timer A input (gating input in timer mode)

		Stan	dard	
Symbol	Parameter	Min.	Max.	Unit
tc(TA)	TAil input cycle time	600		ns
tw(TAH)	TAin input HIGH pulse width	300		ns
tw(TAL)	TAin input LOW pulse width	300		ns

Table 1.21.26. Timer A input (external trigger input in one-shot timer mode)

Symbol	Parameter	Standard Min. Max. 300	Unit	
	Farameter	Min.		Offic
tc(TA)	TAil input cycle time	300		ns
tw(TAH)	TAil input HIGH pulse width	150		ns
tw(TAL)	TAin input LOW pulse width	150		ns

Table 1.21.27. Timer A input (external trigger input in pulse width modulation mode)

O: male al	Dozomotov	Stan	dard	l loit
Symbol	Parameter	Min.	Max.	Unit
tw(TAH)	TAil input HIGH pulse width	150		ns
tw(TAL)	TAil input LOW pulse width	150		ns

Table 1.21.28. Timer A input (up/down input in event counter mode)

Committee of	Deventer	Stan	Standard	1.1:4
Symbol	Parameter	Min.	Max.	Unit
tc(UP)	TAiout input cycle time	3000		ns
tw(UPH)	TAiout input HIGH pulse width	1500		ns
tw(UPL)	TAiout input LOW pulse width	1500		ns
tsu(UP-TIN)	TAiout input setup time	600		ns
th(TIN-UP)	TAiout input hold time	600		ns



Timing requirements (referenced to VCC = 3V, VSS = 0V at Ta = 25°C unless otherwise specified)

Table 1.21.29. Timer B input (counter input in event counter mode)

Symbol	Parameter	Stan	dard	Unit
	Parameter	Min.	Max.	Unit
tc(TB)	TBiin input cycle time (counted on one edge)	150		ns
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	60		ns
tw(TBL)	TBiin input LOW pulse width (counted on one edge)	60		ns
tc(TB)	TBin input cycle time (counted on both edges)	300		ns
tw(TBH)	TBiin input HIGH pulse width (counted on both edges)	160		ns
tw(TBL)	TBin input LOW pulse width (counted on both edges)	160		ns

Table 1.21.30. Timer B input (pulse period measurement mode)

Cumbal	Parameter	Stan	Max.	Lloit
Symbol	rarameter	Min.	Max.	Unit
tc(TB)	TBiin input cycle time	600		ns
tw(TBH)	TBiin input HIGH pulse width	300		ns
tw(TBL)	TBin input LOW pulse width	300		ns

Table 1.21.31. Timer B input (pulse width measurement mode)

Symbol	Parameter	Stan	Standard Min. Max. 600	Unit
Symbol	T arameter	Min.	Max.	
tc(TB)	TBil input cycle time	600		ns
tw(TBH)	TBiln input HIGH pulse width	300		ns
tw(TBL)	TBil input LOW pulse width	300		ns

Table 1.21.32. A-D trigger input

Symbol	Parameter	Stan	dard	Unit
Syllibol	Falametei	Min.	Max.	Offic
tc(AD)	ADTRG input cycle time (trigger able minimum)	1500		ns
tw(ADL)	ADTRG input LOW pulse width	200		ns

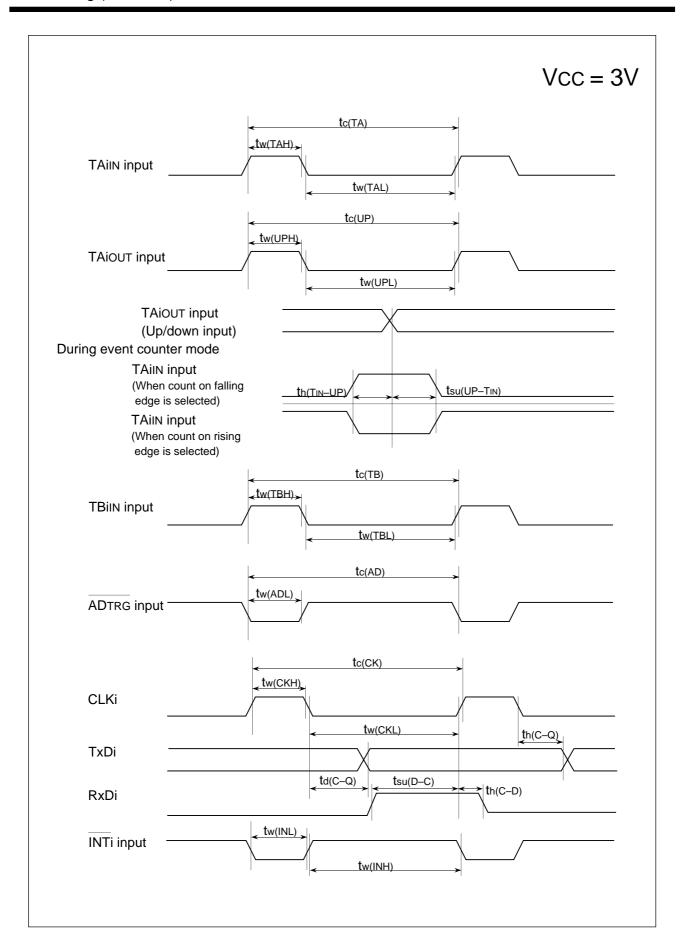
Table 1.21.33. Serial I/O

Symbol	Parameter	Standard	ndard	Unit
Symbol	raidilletei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	300		ns
tw(CKH)	CLKi input HIGH pulse width	150		ns
tw(CKL)	CLKi input LOW pulse width	150		ns
td(C-Q)	TxDi output delay time		160	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	50		ns
th(C-D)	RxDi input hold time	90		ns

Table 1.21.34. External interrupt INTi inputs

Symbol	Parameter	Stan	Max.	Unit
Symbol	i didilietei	Min.	Max.	Offic
tw(INH)	INTi input HIGH pulse width	380		ns
tw(INL)	INTi input LOW pulse width	380		ns





GZZ-SH56-83B <97B0>

MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30220MA-XXXGP/RP MASK ROM CONFIRMATION FORM

Mask ROM number	
-----------------	--

	Date :	
t .	Section head signature	Supervisor signature
Receipt		
<u></u>		

Note: Please complete all items marked %.

		0		TFI	TEL		Submitted by	Supervisor
%	Customer	Company name		()	iance iature		
^^ `	Customer	Date issued	Date :			Issu sign		

*1. Check sheet

Name the product you order, and choose which to give in, EPROMs or floppy disks. If you order by means of EPROMs, three sets of EPROMs are required per pattern. If you order by means of floppy disks, one floppy disk is required per pattern.

☐ In the case of EPROMs

Mitsubishi will create the mask using the data on the EPROMs supplied, providing the data is the same on at least two of those sets. Mitsubishi will, therefore, only accept liability if there is any discrepancy between the data on the EPROM sets and the ROM data written to the product. Please carefully check the data on the EPROMs being submitted to Mitsubishi.

Microcomputer type No. :	(GP	□ N	/13022	20MA-XXXI	RF
Checksum code for total EPROM area :				(hex)	

FPROM type:

LFROM type.	
□ 27C201	□ 27C401
Address 0000016 Product : Area containing ASCII code for M30220MA - 0001016 27FFF16 2800016 ROM(96K) 3FFFF16	Address 0000016

- (1) Write "FF16" to the lined area.
- (2) The area from 0000016 to 0000F16 is for storing data on the product type name.

The ASCII code for 'M30220MA-' is shown at right. The data in this table must be written to address 0000016 to 0000F16.

Both address and data are shown in hex.

Address		
0000016	'M '	= 4D ₁₆
0000116	'3'	= 3316
0000216	'0'	= 3016
0000316	'2'	= 3216
0000416	'2'	= 3216
0000516	'0'	= 3016
0000616	'M '	= 4D ₁₆
0000716	'A'	= 4116

Address	
0000816	'' = 2D ₁₆
0000916	FF ₁₆
0000A ₁₆	FF ₁₆
0000B ₁₆	FF ₁₆
0000C ₁₆	FF ₁₆
0000D ₁₆	FF ₁₆
0000E ₁₆	FF ₁₆
0000F ₁₆	FF ₁₆



GZZ-SH56-83B <97B0>

MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30220MA-XXXGP/RP MASK ROM CONFIRMATION FORM

Mask ROM number	

The ASCII code for the type No. can be written to EPROM addresses 0000016 to 0000F16 by specifying the pseudo-instructions for the respective EPROM type shown in the following table at the beginning of the assembler source program.

EDBOM turns	27	C201		270404	
EPROM type		C201 SCIICODE, ROM DATA	^ SEC	27C401 FION△ ASCIICODE, ROM DATA	
Code entered in				△ 080000H	
source program			△ .BYTE △ ' M30220MA- '		
Note: The ROM of in the check	·	I if the type No. written to		OM does not match the type No.	
\square In the case	of floppy disks				
the floppy disk there is any dis products we pr	s you give in to us, a screpancy between to roduce. Check thoro	and forms them into mas the contents of these ma ughly the contents of the	ks. Hence ask files ar e mask file	ration utilities out of those held on e, we assume liability provided that not the ROM data to be burned into es you give in. e mask file in a floppy disk.	
Microcompo	uter type No. :	☐ M30220MA-XXXG	iP [☐ M30220MA-XXXRP	
File code :				(hex)	
Mask file na	ame :			.MSK (alpha-numeric 8-digit)	
the separate m for submission For the M3022	cification differs acco nark specification sho to Mitsubishi.	eet (for each package), it the 144PFB mark spe	attach tha	r entering the mark specification on t sheet to this masking check sheet sheet. For the M30220MA-XXXGP,	
	ions				
For our referenthe the products yo		our products, please rep	ly to the fo	ollowing questions about the usage of	
(1) Which I	kind of XIN-XOUT osc	cillation circuit is used?			
	Ceramic resonator	☐ Quartz-crystal	oscillator		
□ _[External clock input	\square Other ()		
What fr	equency do you use	?			
f(X	IN) = (NI	MH7			



GZZ-SH56-83B <97B0>

MITSUBISHI ELECTRIC SINGLE-CHIP 16-BIT MICROCOMPUTER M30220MA-XXXGP/RP MASK ROM CONFIRMATION FORM

Mask ROM number	

(2) Which kind of XCIN-XCOUT oscillation circuit is used?			
☐ Ceramic resonator	☐Quartz-crystal oscilla	tor	
☐ External clock input	☐ Other ()	
What frequency do you use?			
f(XCIN) = kHz			
(3) Which operating ambient temper	ature do you use?		
10 °C to 75 °C	20 °C to 75 °C		40 °C to 75 °C
□-10 °C to 85 °C	□–20 °C to 85 °C		□–40 °C to 85 °C
(4) Which operating supply voltage of	do you use?		
☐ 2.7V to 3.2V	☐3.2V to 3.7V		☐ 3.7V to 4.2V
☐ 4.2V to 4.7V	☐ 4.7V to 5.2V		☐ 5.2V to 5.5V
(5) Do you use I ² C (Inter IC) bus fund	ction?		
☐ Not use	□Use		
(6) Do you use IE (Inter Equipment) b	ous function?		
☐ Not use	□Use		
Thank you cooperation.			
* 4. Special item (Indicate none if there is n	o specified item)		



Outline Performance

Table 1.22.1 shows the outline performance of the M30220 (flash memory version).

Table 1.22.1. Outline performance of the M30220 (flash memory version)

Item		Performance
Power supply voltage		VCC=2.7V to 5.5 V (Note 1) VCC=2.7V to 3.6 V (Note 2)
Program/erase	voltage	$VPP=5.0V \pm 10\%$
Flash memory	operation mode	Three modes (parallel I/O, standard serial I/O, CPU rewrite)
Erase block		See Figure 1.22.1
division	Boot ROM area	No division (8 K bytes) (Note 3)
Program meth	od	In units of words
Erase method		Collective erase/block erase
Program/erase	e control method	Program/erase control by software command
Number of commands		6 commands
Program/erase count		100 times
ROM code protect		Parallel I/O and standard serial I/O modes are supported.

Note 1: Use a 4.5 - 5.5 V power supply voltage when program/erase.

Note 2: Use a 3.0 - 3.6 V power supply voltage when program/erase.

Note 3: The boot ROM area contains a standard serial I/O mode control program which is stored in it when shipped from the factory. This area can be erased and programmed in only parallel I/O mode.



Flash Memory

The M30220 (flash memory version) has an internal new DINOR (DIvided bit line NOR) flash memory that can be rewritten with a single power source when Vcc is 4.5 to 5.5 V, and 2 power sources when Vcc is 2.7 to 4.5 V.

For this flash memory, three flash memory modes are available in which to read, program, and erase: parallel I/O and standard serial I/O modes in which the flash memory can be manipulated using a programmer and a CPU rewrite mode in which the flash memory can be manipulated by the Central Processing Unit (CPU). Each mode is detailed in the pages to follow.

The flash memory is divided into several blocks as shown in Figure 1.22.1, so that memory can be erased one block at a time.

In addition to the ordinary user ROM area to store a microcomputer operation control program, the flash memory has a boot ROM area that is used to store a program to control rewriting in CPU rewrite and standard serial I/O modes. This boot ROM area has had a standard serial I/O mode control program stored in it when shipped from the factory. However, the user can write a rewrite control program in this area that suits the user's application system. This boot ROM area can be rewritten in only parallel I/O mode.

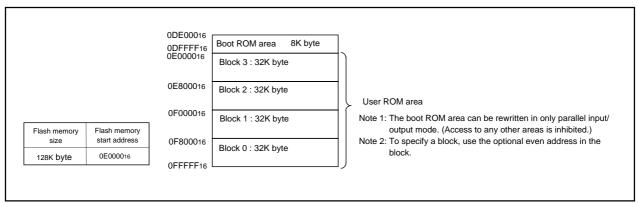


Figure 1.22.1. Block diagram of flash memory version

CPU Rewrite Mode

In CPU rewrite mode, the on-chip flash memory can be operated on (read, program, or erase) under control of the Central Processing Unit (CPU).

In CPU rewrite mode, only the user ROM area shown in Figure 1.22.1 can be rewritten; the boot ROM area cannot be rewritten. Make sure the program and block erase commands are issued for only the user ROM area and each block area.

The control program for CPU rewrite mode can be stored in either user ROM or boot ROM area. In the CPU rewrite mode, because the flash memory cannot be read from the CPU, the rewrite control program must be transferred to any area other than the internal flash memory before it can be executed.

Microcomputer Mode and Boot Mode

The control program for CPU rewrite mode must be written into the user ROM or boot ROM area in parallel I/O mode beforehand. (If the control program is written into the boot ROM area, the standard serial I/O mode becomes unusable.)

See Figure 1.22.1 for details about the boot ROM area.

Normal microcomputer mode is entered when the microcomputer is reset with pulling CNVss pin low. In this case, the CPU starts operating using the control program in the user ROM area.

When the microcomputer is reset by pulling the P74 (\overline{CE}) pin high, the CNVss pin high, the CPU starts operating using the control program in the boot ROM area (program start address is DE00016 fixation). This mode is called the "boot" mode.

Block Address

Block addresses refer to the optional even address of each block. These addresses are used in the block erase command.



Outline Performance (CPU Rewrite Mode)

In the CPU rewrite mode, the CPU erases, programs and reads the internal flash memory as instructed by software commands. This rewrite control program must be transferred to internal RAM before it can be excuted.

The CPU rewrite mode is accessed by applying $5V \pm 10\%$ to the CNVss pin and writing "1" for the CPU rewrite mode select bit (bit 1 in address 03B416). Software commands are accepted once the mode is accessed.

In the CPU rewrite mode, write to and read from software commands and data into even-numbered address ("0" for byte address A0) in 16-bit units. Always write 8-bit software commands into even-numbered address. Commands are ignored with odd-numbered addresses.

Use software commands to control program and erase operations. Whether a program or erase operation has terminated normally or in error can be verified by reading the status register.

Figure 1.23.1 shows the flash memory control register.

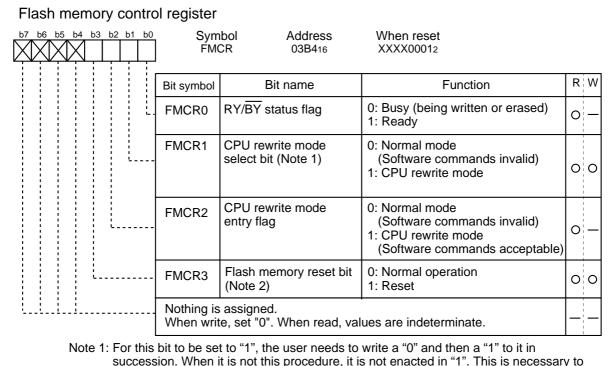
Bit 0 is the RY/BY status flag used exclusively to read the operating status of the flash memory. During programming and erase operations, it is "0". Otherwise, it is "1".

Bit 1 is the CPU rewrite mode select bit. When this bit is set to "1" and $5V \pm 10\%$ are applied to the CNVss pin, the M30220 accesses the CPU rewrite mode. Software commands are accepted once the mode is accessed. In CPU rewrite mode, the CPU becomes unable to access the internal flash memory directly. Therefore, use the control program in RAM for write to bit 1. To set this bit to "1", it is necessary to write "0" and then write "1" in succession. The bit can be set to "0" by only writing a "0".

Bit 2 is the CPU rewrite mode entry flag. This bit can be read to check whether the CPU rewrite mode has been entered or not.

Bit 3 is the flash memory reset bit used to reset the control circuit of the internal flash memory. This bit is used when exiting CPU rewrite mode and when flash memory access has failed. When the CPU rewrite mode select bit is "1", writing "1" for this bit resets the control circuit. To release the reset, it is necessary to set this bit to "0". If the control circuit is reset while erasing is in progress, a 5 ms wait is needed so that the flash memory can restore normal operation. Figure 1.23.2 shows a flowchart for setting/releasing the CPU rewrite mode.





Note 1: For this bit to be set to "1", the user needs to write a "0" and then a "1" to it in succession. When it is not this procedure, it is not enacted in "1". This is necessary to ensure that no interrupt or DMA transfer will be executed during the interval. Use the control program in the RAM for write to this bit.

Note 2: Effective only when the CPU rewrite mode select bit = 1. Set this bit to 0 subsequently after setting it to 1 (reset).

Figure 1.23.1. Flash memory control registers

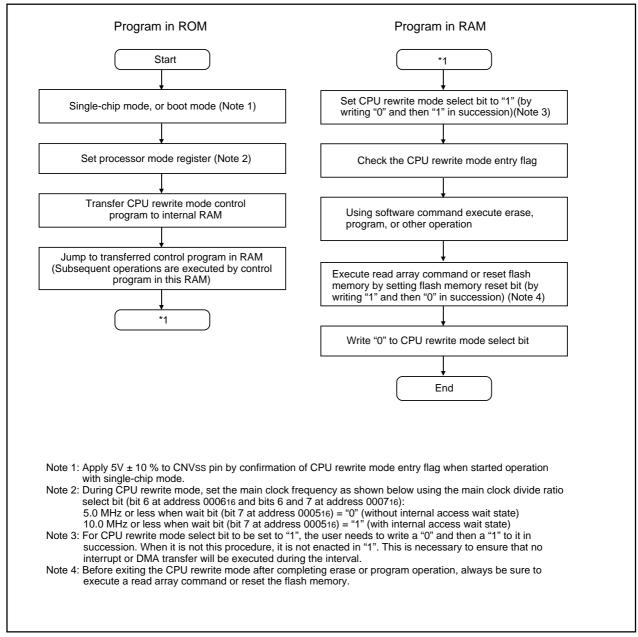


Figure 1.23.2. CPU rewrite mode set/reset flowchart

Precautions on CPU Rewrite Mode

Described below are the precautions to be observed when rewriting the flash memory in CPU rewrite mode.

(1) Operation speed

During CPU rewrite mode, set the main clock frequency as shown below using the main clock divide ratio select bit (bit 6 at address 000616 and bits 6 and 7 at address 000716):

5.0 MHz or less when wait bit (bit 7 at address 000516) = 0 (without internal access wait state)

10.0 MHz or less when wait bit (bit 7 at address 000516) = 1 (with internal access wait state)

(2) Instructions inhibited against use

The instructions listed below cannot be used during CPU rewrite mode because they refer to the internal data of the flash memory:

UND instruction, INTO instruction, JMPS instruction, JSRS instruction, and BRK instruction

(3) Interrupts inhibited against use

The NMI, address match, and watchdog timer interrupts cannot be used during CPU rewrite mode because they refer to the internal data of the flash memory. If interrupts have their vector in the variable vector table, they can be used by transferring the vector into the RAM area.

(4) Reset

If the control circuit is reset while erasing is in progress, a 5 ms wait is needed so that the flash memory can restore normal operation. Set a 5 ms wait to release the reset operation.

Also, when the reset has been released, the program execute start address is automatically set to 0DE00016, therefore program so that the execute start address of the boot ROM is 0DE00016.

(5) Writing in the user ROM area

If power is lost while rewriting blocks that contain the flash rewrite program with the CPU rewrite mode, those blocks may not be correctly rewritten and it is possible that the flash memory can no longer be rewritten after that. Therefore, it is recommended to use the standard serial I/O mode or parallel I/O mode to rewrite these blocks.



Software Commands

Table 1.23.1 lists the software commands available with the M30220 (flash memory version).

After setting the CPU rewrite mode select bit to 1, write a software command to specify an erase or program operation. Note that when entering a software command, the upper byte (D8 to D15) is ignored. The content of each software command is explained below.

Table 1.23.1. List of software commands (CPU rewrite mode)

Command	Cycle number	First bus cycle			Second bus cycle		
		Mode	Address	Data (D ₀ to D ₇)	Mode	Address	Data (D ₀ to D ₇)
Read array	1	Write	X (Note 5)	FF16			
Read status register	2	Write	Х	7016	Read	Х	SRD (Note 2)
Clear status register	1	Write	Х	5016			
Program (Note 3)	2	Write	Х	4016	Write	WA (Note 3)	WD (Note 3)
Erase all block	2	Write	Х	2016	Write	Х	2016
Block erase	2	Write	Х	2016	Write	BA (Note 4)	D016

Note 1: When a software command is input, the high-order byte of data (D8 to D15) is ignored.

Note 2: SRD = Status Register Data

Note 3: WA = Write Address, WD = Write Data

Note 4: BA = Block Address (Enter the optional address of each block that is an even address.)

Note 5: X denotes a given address in the user ROM area (that is an even address).

Read Array Command (FF16)

The read array mode is entered by writing the command code "FF16" in the first bus cycle. When an even address to be read is input in one of the bus cycles that follow, the content of the specified address is read out at the data bus (D0–D15), 16 bits at a time.

The read array mode is retained intact until another command is written.

Read Status Register Command (7016)

When the command code "7016" is written in the first bus cycle, the content of the status register is read out at the data bus (D0–D7) by a read in the second bus cycle.

The status register is explained in the next section.

Clear Status Register Command (5016)

This command is used to clear the bits SR4 to SR5 of the status register after they have been set. These bits indicate that operation has ended in an error. To use this command, write the command code "5016" in the first bus cycle.



Program Command (4016)

Program operation starts when the command code "4016" is written in the first bus cycle. Then, if the address and data to program are written in the 2nd bus cycle, program operation (data programming and verification) will start.

Whether the write operation is completed can be confirmed by reading the status register or the RY/ \overline{BY} status flag. When the program starts, the read status register mode is accessed automatically and the content of the status register is read into the data bus (D0 - D7). The status register bit 7 (SR7) is set to 0 at the same time the write operation starts and is returned to 1 upon completion of the write operation. In this case, the read status register mode remains active until the Read Array command (FF16) is written.

The RY/BY status flag is 0 during write operation and 1 when the write operation is completed as is the status register bit 7.

At program end, program results can be checked by reading the status register.

Erase All Blocks Command (2016/2016)

By writing the command code "2016" in the first bus cycle and the confirmation command code "2016" in the second bus cycle that follows, the system starts erase all blocks(erase and erase verify).

Whether the erase all blocks command is terminated can be confirmed by reading the status register or the RY/BY status flag. When the erase all blocks operation starts, the read status register mode is accessed automatically and the content of the status register can be read out. The status register bit 7 (SR7) is set to 0 at the same time the erase operation starts and is returned to 1 upon completion of the erase operation. In this case, the read status register mode remains active until the Read Array command (FF16) is written.

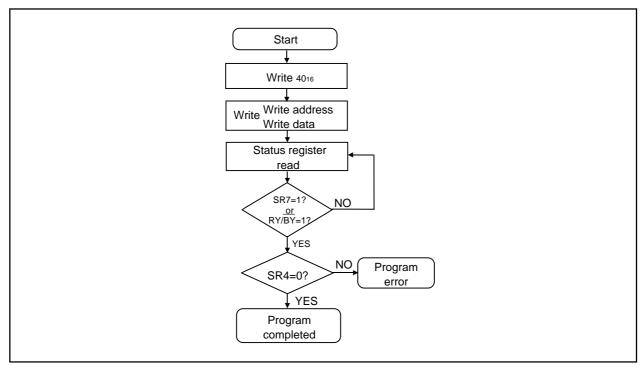


Figure 1.23.3. Program flowchart



The RY/BY status flag is 0 during erase operation and 1 when the erase operation is completed as is the status register bit 7.

At erase all blocks end, erase results can be checked by reading the status register. For details, refer to the section where the status register is detailed.

Block Erase Command (2016/D016)

By writing the command code "2016" in the first bus cycle and the confirmation command code "D016" in the second bus cycle that follows to the block address of a flash memory block, the system initiates a block erase (erase and erase verify) operation.

Whether the block erase operation is completed can be confirmed by reading the status register or the RY/BY status flag. At the same time the block erase operation starts, the read status register mode is automatically entered, so the content of the status register can be read out. The status register bit 7 (SR7) is set to 0 at the same time the block erase operation starts and is returned to 1 upon completion of the block erase operation. In this case, the read status register mode remains active until the Read Array command (FF16).

The RY/BY status flag is 0 during block erase operation and 1 when the block erase operation is completed as is the status register bit 7.

After the block erase operation is completed, the status register can be read out to know the result of the block erase operation. For details, refer to the section where the status register is detailed.

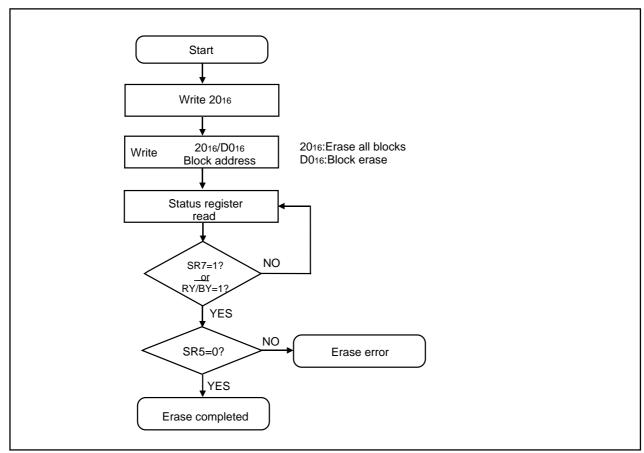


Figure 1.23.4. Erase flowchart



Status Register

The status register shows the operating state of the flash memory and whether erase operations and programs ended successfully or in error. It can be read in the following ways.

- (1) By reading an arbitrary address from the user ROM area after writing the read status register command (7016)
- (2) By reading an arbitrary address from the user ROM area in the period from when the program starts or erase operation starts to when the read array command (FF16) is input

Table 1.23.2 shows the status register.

Also, the status register can be cleared in the following way.

(1) By writing the clear status register command (5016)

After a reset, the status register is set to "8016".

Each bit in this register is explained below.

Sequencer status (SR7)

After power-on, the sequencer status is set to 1(ready).

The sequencer status indicates the operating status of the device. This status bit is set to 0 (busy) during write or erase operation and is set to 1 upon completion of these operations.

Erase status (SR5)

The erase status informs the operating status of erase operation to the CPU. When an erase error occurs, it is set to 1.

The erase status is reset to 0 when cleared.

Program status (SR4)

The program status informs the operating status of write operation to the CPU. When a write error occurs, it is set to 1.

The program status is reset to 0 when cleared.

If "1" is written for any of the SR5 or SR4 bits, the program, erase all blocks, and block erase commands are not accepted. Before executing these commands, execute the clear status register command (5016) and clear the status register.

Also, any commands are not correct, both SR5 and SR4 are set to 1.



	ıabı	e '	1.2	3.2.	Definition	Of	each	bit	ın	status	registe	r
Γ												

Each bit of	_	Definition			
SRD	Status name	"1"	"0"		
SR7 (bit7)	Sequencer status	Ready	Busy		
SR6 (bit6)	Reserved	-	-		
SR5 (bit5)	Erase status	Terminated in error	Terminated normally		
SR4 (bit4)	Program status	Terminated in error	Terminated normally		
SR3 (bit3)	Reserved	-	-		
SR2 (bit2)	Reserved	-	-		
SR1 (bit1)	Reserved	-	-		
SR0 (bit0)	Reserved	-	-		

Full Status Check

By performing full status check, it is possible to know the execution results of erase and program operations. Figure 1.23.5 shows a full status check flowchart and the action to be taken when each error occurs.

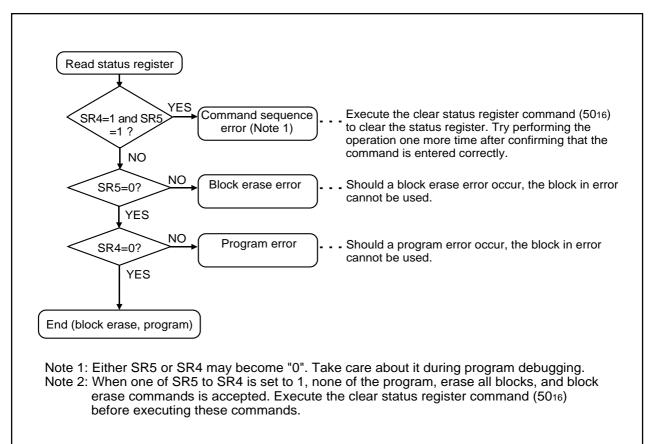


Figure 1.23.5. Full status check flowchart and remedial procedure for errors



Functions To Inhibit Rewriting Flash Memory Version

To prevent the contents of the flash memory version from being read out or rewritten easily, the device incorporates a ROM code protect function for use in parallel I/O mode and an ID code check function for use in standard serial I/O mode.

ROM code protect function

The ROM code protect function is used to prohibit reading out or modifying the contents of the flash memory during parallel I/O mode and is set by using the ROM code protect control address register (0FFFFF16). Figure 1.23.6 shows the ROM code protect control address (0FFFFF16). (This address exists in the user ROM area.)

If one of the pair of ROM code protect bits is set to 0, ROM code protect is turned on, so that the contents of the flash memory version are protected against readout and modification. ROM code protect is implemented in two levels. If level 2 is selected, the flash memory is protected even against readout by a shipment inspection LSI tester, etc. When an attempt is made to select both level 1 and level 2, level 2 is selected by default.

If both of the two ROM code protect reset bits are set to "00," ROM code protect is turned off, so that the contents of the flash memory version can be read out or modified. Once ROM code protect is turned on, the contents of the ROM code protect reset bits cannot be modified in parallel I/O mode. Use the serial I/O or some other mode to rewrite the contents of the ROM code protect reset bits.

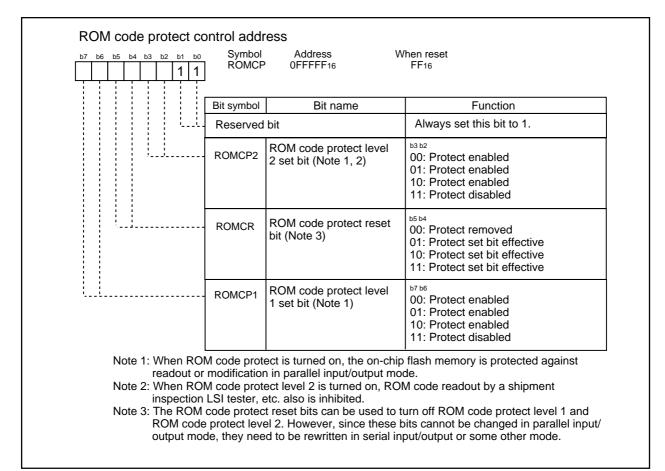


Figure 1.23.6. ROM code protect control address



ID Code Check Function

Use this function in standard serial I/O mode. When the contents of the flash memory are not blank, the ID code sent from the peripheral unit is compared with the ID code written in the flash memory to see if they match. If the ID codes do not match, the commands sent from the peripheral unit are not accepted. The ID code consists of 8-bit data, the areas of which, beginning with the first byte, are 0FFFDF16, 0FFFE316, 0FFFE316, 0FFFEB16, 0FFFEB16. Write a program which has had the ID code preset at these addresses to the flash memory.

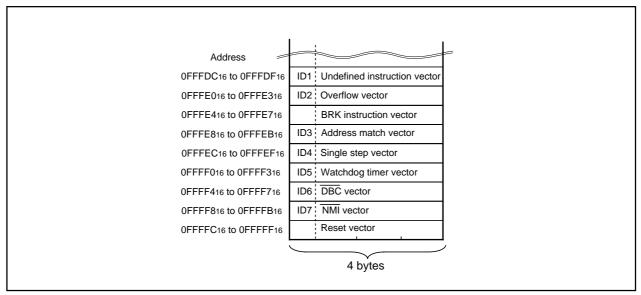


Figure 1.23.7. ID code store addresses



Parallel I/O Mode

The parallel I/O mode inputs and outputs the software commands, addresses and data needed to operate (read, program, erase, etc.) the internal flash memory. This I/O is parallel.

Use an exclusive programer supporting M30220 (flash memory version).

Refer to the instruction manual of each programer maker for the details of use.

User ROM and Boot ROM Areas

In parallel I/O mode, the user ROM and boot ROM areas shown in Figure 1.22.1 can be rewritten. Both areas of flash memory can be operated on in the same way.

Program and block erase operations can be performed in the user ROM area. The user ROM area and its blocks are shown in Figure 1.22.1.

The boot ROM area is 8 Kbytes in size. In parallel I/O mode, it is located at addresses 0DE00016 through 0DFFFF16. Make sure program and block erase operations are always performed within this address range. (Access to any location outside this address range is prohibited.)

In the boot ROM area, an erase block operation is applied to only one 8 Kbyte block. The boot ROM area has had a standard serial I/O mode control program stored in it when shipped from the Mitsubishi factory. Therefore, using the device in standard serial input/output mode, you do not need to write to the boot ROM area.



Pin functions (Flash memory standard serial I/O mode) (Note 1)

,	•		
Pin	Name	I/O	Description
Vcc,Vss	Power input		Apply a 3.0 - 3.6 V (Note 2) or 4.5 - 5.5 V (Note 3) voltage on the Vcc pin, and 0 V voltage on the Vss pin.
CNVss	CNVss	I	Connect to VCC when VCC = 4.5 V to 5.5 V. Connect to Vpp (= 4.5 V to 5.5 V) when VCC = 3.0 V to 3.6 V.
RESET	Reset input	I	Reset input pin. While reset is "L" level, a 20 cycle or longer clock must be input to XIN pin.
XIN	Clock input	1	Connect a ceramic resonator or crystal oscillator between XIN and
Хоит	Clock output	0	XOUT pins. To input an externally generated clock, input it to XIN pin and open XOUT pin.
XCIN	Sub-clock input	I	Connect a crystal oscillator between XCIN and XCOUT pins. To input an externally generated clock, input it to XCIN pin and open XCOUT
Хсоит	Sub-clock output	0	pin.
AVcc, AVss	Analog power supply input		Connect AVss to Vss and AVcc to Vcc, respectively.
VREF	Reference voltage input	I	Enter the reference voltage for AD from this pin.
P00 to P07	Input port P0	ı	Input "H" or "L" level signal or open.
P10 to P17	Input port P1	I	Input "H" or "L" level signal or open.
P20 to P27	Input port P2	I	Input "H" or "L" level signal or open.
P30 to P35	Input port P3	ı	Input "H" or "L" level signal or open.
P40 to P47	Input port P4	I	Input "H" or "L" level signal or open.
P50 to P57	Input port P5	I	Input "H" or "L" level signal or open.
P60	BUSY output	0	Standard serial mode 1: BUSY signal output pin Standard serial mode 2: Monitors the program operation check
P61	SCLK input	I	Standard serial mode 1: Serial clock input pin Standard serial mode 2: Input "L".
P62	RxD input	I	Serial data input pin
P63	TxD output	0	Serial data output pin
P64 to P67	Input port P6	I	Input "H" or "L" level signal or open.
P70 to P73, P75, P76	Input port P7	I	Input "H" or "L" level signal or open.
P74	CE input	I	Input "H" level signal.
P77	NMI input	I	Connect this pin to Vcc.
P80 to P87	Input port P8	I	Input "H" or "L" level signal or open.
P90 to P97	Input port P9	I	Input "H" or "L" level signal or open.
P100 to P107	Input port P10	I	Input "H" or "L" level signal or open.
P110 to P117	Input port P11	I	Input "H" or "L" level signal or open.
P120 to P127	Input port P12	I	Input "H" or "L" level signal or open.
P130 to P132	Input port P13	I	Input "H" or "L" level signal or open.
SEG0 to SEG15	Segment output	0	Open when not used LCD control circuit.
COMo to COM3	Common output	0	Open when not used LCD control circuit.
VL3 to VL1	Power supply input for LCD		Input LCD power source. However, do not input the power when the power supply voltages for Vcc and LCD are different.
C1 to C2	Charge-pump capacitor		Connect a condenser between C1 and C2 when used LCD charge-

Note 1: About the unused pins, see the example of processing for unused pins in the single-chip mode. Note 2: The power supply voltage is Vcc=2.7 - 3.6 V in the single-chip mode. Note 3: The power supply voltage is Vcc=2.7 - 5.5 V in the single-chip mode.



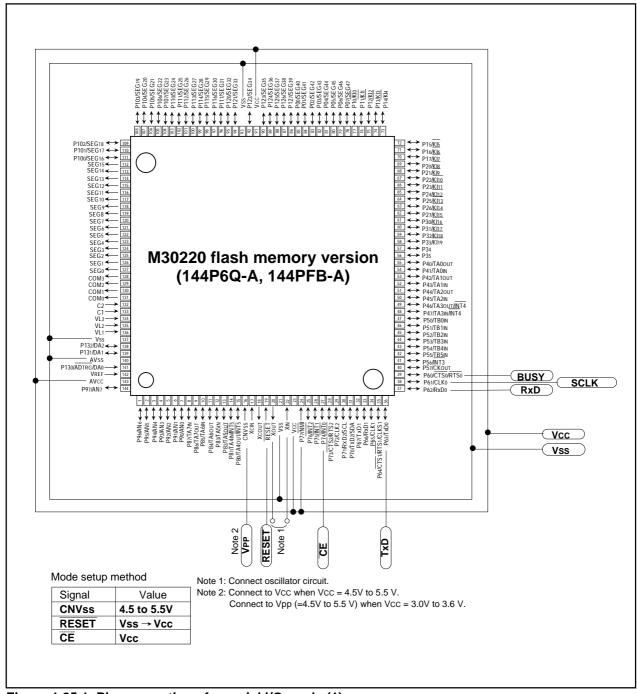


Figure 1.25.1. Pin connections for serial I/O mode (1)

Standard serial I/O mode

The standard serial I/O mode inputs and outputs the software commands, addresses and data needed to operate (read, program, erase, etc.) the internal flash memory. This I/O is serial. There are actually two standard serial I/O modes: mode 1, which is clock synchronized, and mode 2, which is asynchronized. Both modes require a purpose-specific peripheral unit.

The standard serial I/O mode is different from the parallel I/O mode in that the CPU controls flash memory rewrite (uses the CPU's rewrite mode), rewrite data input and so forth. The standard serial I/O mode is started by connecting "H" to the P74 (\overline{CE}) pin and "H" to the CNVss pin (when Vcc = 4.5 V to 5.5 V, connect to Vcc; when Vcc = 2.7 V to 4.5 V, supply 4.5 V to 5.5 V to Vpp from an external source), and releasing the reset operation. (In the ordinary command mode, set CNVss pin to "L" level.)

This control program is written in the boot ROM area when the product is shipped from Mitsubishi. Accordingly, make note of the fact that the standard serial I/O mode cannot be used if the boot ROM area is rewritten in the parallel I/O mode. Figure 1.25.1 shows the pin connections for the standard serial I/O mode. Serial data I/O uses UART0 and transfers the data serially in 8-bit units. Standard serial I/O switches between mode 1 (clock synchronized) and mode 2 (clock asynchronized) according to the level of CLK0 pin when the reset is released.

To use standard serial I/O mode 1 (clock synchronized), set the CLKo pin to "H" level and release the reset. The operation uses the four UARTO pins CLKo, RxDo, TxDo and RTSo (BUSY). The CLKo pin is the transfer clock input pin through which an external transfer clock is input. The TxDo pin is for CMOS output. The RTSo (BUSY) pin outputs an "L" level when ready for reception and an "H" level when reception starts.

To use standard serial I/O mode 2 (clock asynchronized), set the CLKo pin to "L" level and release the reset. The operation uses the two UARTO pins RxDo and TxDo.

In the standard serial I/O mode, only the user ROM area indicated in Figure 1.22.1 can be rewritten. The boot ROM cannot.

In the standard serial I/O mode, a 7-byte ID code is used. When there is data in the flash memory, commands sent from the peripheral unit (programmer) are not accepted unless the ID code matches.



Overview of standard serial I/O mode 1 (clock synchronized)

In standard serial I/O mode 1, software commands, addresses and data are input and output between the MCU and peripheral units (serial programer, etc.) using 4-wire clock-synchronized serial I/O (UART0). Standard serial I/O mode 1 is engaged by releasing the reset with the P61 (CLK0) pin "H" level.

In reception, software commands, addresses and program data are synchronized with the rise of the transfer clock that is input to the CLKo pin, and are then input to the MCU via the RxDo pin. In transmission, the read data and status are synchronized with the fall of the transfer clock, and output from the TxDo pin.

The TxDo pin is for CMOS output. Transfer is in 8-bit units with LSB first.

When busy, such as during transmission, reception, erasing or program execution, the RTS₀ (BUSY) pin is "H" level. Accordingly, always start the next transfer after the RTS₀ (BUSY) pin is "L" level.

Also, data and status registers in memory can be read after inputting software commands. Status, such as the operating state of the flash memory or whether a program or erase operation ended successfully or not, can be checked by reading the status register. Here following are explained software commands, status registers, etc.



Software Commands

Table 1.25.1 lists software commands. In the standard serial I/O mode 1, erase operations, programs and reading are controlled by transferring software commands via the RxDo pin. Software commands are explained here below.

Table 1.25.1. Software commands (Standard serial I/O mode 1)

	Control command	1st byte transfer	2nd byte	3rd byte	4th byte	5th byte	6th byte		When ID is not verified
1	Page read	FF ₁₆	Address (middle)	Address (high)	Data output	Data output	Data output	Data output to 259th byte	Not acceptable
2	Page program	41 ₁₆	Address (middle)	Address (high)	Data input	Data input	Data input	Data input to 259th byte	Not acceptable
3	Block erase	2016	Address (middle)	Address (high)	D0 ₁₆				Not acceptable
4	Erase all blocks	A7 ₁₆	D0 ₁₆						Not acceptable
5	Read status register	7016	SRD output	SRD1 output					Acceptable
6	Clear status register	5016							Not acceptable
7	ID check function	F5 ₁₆	Address (low)	Address (middle)	Address (high)	ID size	ID1	To ID7	Acceptable
8	Download function	FA ₁₆	Size (low)	Size (high)	Check- sum	Data input	To required number of times		Not acceptable
9	Version data output function	FB ₁₆	Version data output	Version data output	Version data output	Version data output	Version data output	Version data output to 9th byte	Acceptable
10	Boot ROM area output function	FC ₁₆	Address (middle)	Address (high)	Data output	Data output	Data output	Data output to 259th byte	Not acceptable
11	Read check data	FD ₁₆	Check data (low)	Check data (high)					Not acceptable

Note 1: Shading indicates transfer from flash memory microcomputer to peripheral unit. All other data is transferred from the peripheral unit to the flash memory microcomputer.



Note 2: SRD refers to status register data. SRD1 refers to status register 1 data.

Note 3: All commands can be accepted when the flash memory is totally blank.

Page Read Command

This command reads the specified page (256 bytes) in the flash memory sequentially one byte at a time. Execute the page read command as explained here following.

- (1) Transfer the "FF16" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, data (D0–D7) for the page (256 bytes) specified with addresses A8 to A23 will be output sequentially from the smallest address first in sync with the fall of the clock.

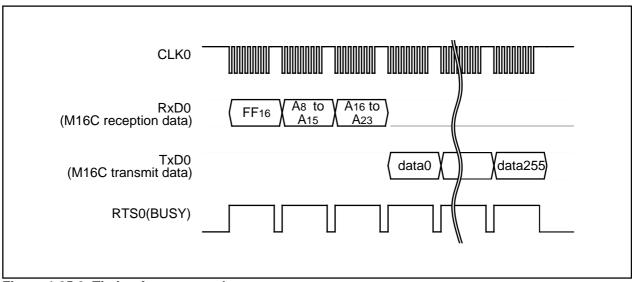


Figure 1.25.2. Timing for page read

Read Status Register Command

This command reads status information. When the "7016" command code is sent with the 1st byte, the contents of the status register (SRD) specified with the 2nd byte and the contents of status register 1 (SRD1) specified with the 3rd byte are read.

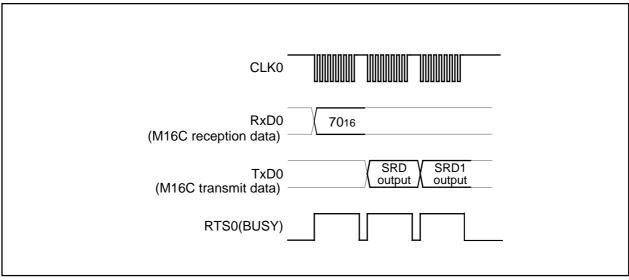


Figure 1.25.3. Timing for reading the status register



Clear Status Register Command

This command clears the bits (SR4–SR5) which are set when the status register operation ends in error. When the "5016" command code is sent with the 1st byte, the aforementioned bits are cleared. When the clear status register operation ends, the RTS0 (BUSY) signal changes from the "H" to the "L" level.

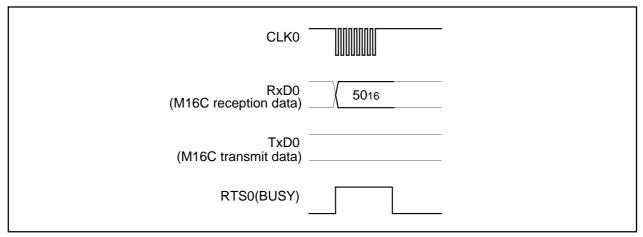


Figure 1.25.4. Timing for clearing the status register

Page Program Command

This command writes the specified page (256 bytes) in the flash memory sequentially one byte at a time. Execute the page program command as explained here following.

- (1) Transfer the "4116" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, as write data (D0–D7) for the page (256 bytes) specified with addresses A8 to A23 is input sequentially from the smallest address first, that page is automatically written.

When reception setup for the next 256 bytes ends, the RTSo (BUSY) signal changes from the "H" to the "L" level. The result of the page program can be known by reading the status register. For more information, see the section on the status register.

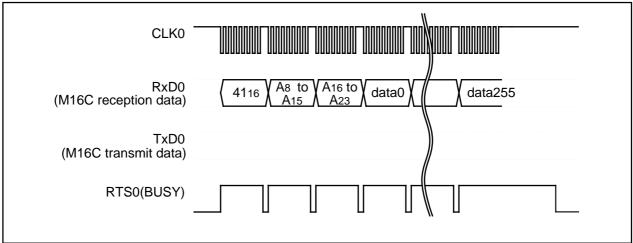


Figure 1.25.5. Timing for the page program



Block Erase Command

This command erases the data in the specified block. Execute the block erase command as explained here following.

- (1) Transfer the "2016" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) Transfer the verify command code "D016" with the 4th byte. With the verify command code, the erase operation will start for the specified block in the flash memory. Write the optional even address of the specified block for addresses A8 to A23.

When block erasing ends, the RTSo (BUSY) signal changes from the "H" to the "L" level. After block erase ends, the result of the block erase operation can be known by reading the status register. For more information, see the section on the status register.

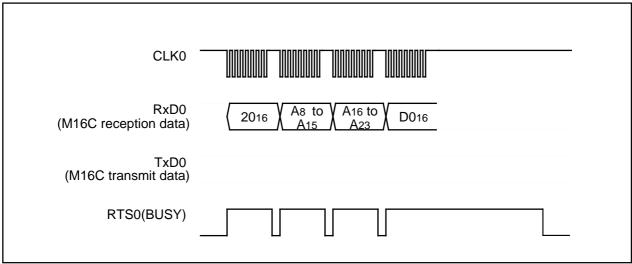


Figure 1.25.6. Timing for block erasing

Erase All Blocks Command

This command erases the content of all blocks. Execute the erase all blocks command as explained here following.

- (1) Transfer the "A716" command code with the 1st byte.
- (2) Transfer the verify command code "D016" with the 2nd byte. With the verify command code, the erase operation will start and continue for all blocks in the flash memory.

When block erasing ends, the RTS0 (BUSY) signal changes from the "H" to the "L" level. The result of the erase operation can be known by reading the status register.

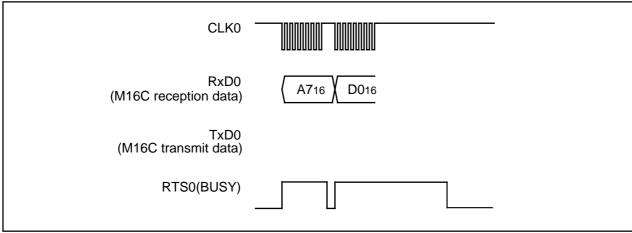


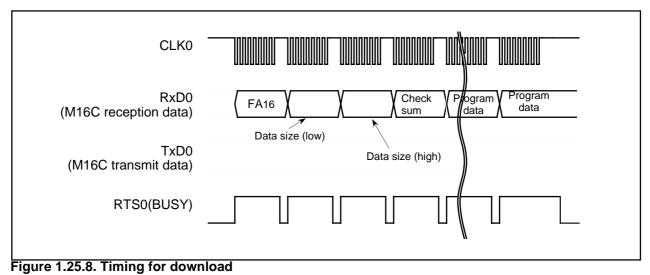
Figure 1.25.7. Timing for erasing all blocks

Download Command

This command downloads a program to the RAM for execution. Execute the download command as explained here following.

- (1) Transfer the "FA16" command code with the 1st byte.
- (2) Transfer the program size with the 2nd and 3rd bytes.
- (3) Transfer the check sum with the 4th byte. The check sum is added to all data sent with the 5th byte onward.
- (4) The program to execute is sent with the 5th byte onward.

When all data has been transmitted, if the check sum matches, the downloaded program is executed. The size of the program will vary according to the internal RAM.





Version Information Output Command

This command outputs the version information of the control program stored in the boot area. Execute the version information output command as explained here following.

- (1) Transfer the "FB16" command code with the 1st byte.
- (2) The version information will be output from the 2nd byte onward. This data is composed of 8 ASCII code characters.

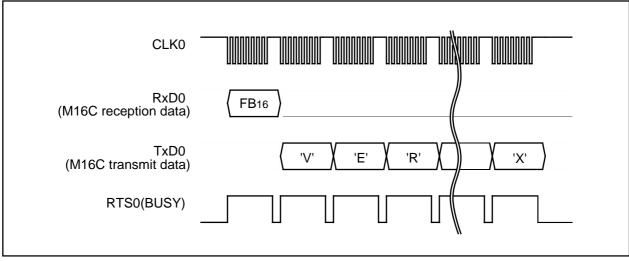


Figure 1.25.9. Timing for version information output

Boot ROM Area Output Command

This command outputs the control program stored in the boot ROM area in one page blocks (256 bytes). Execute the boot ROM area output command as explained here following.

- (1) Transfer the "FC16" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, data (D0–D7) for the page (256 bytes) specified with addresses A8 to A23 will be output sequentially from the smallest address first, in sync with the fall of the clock.

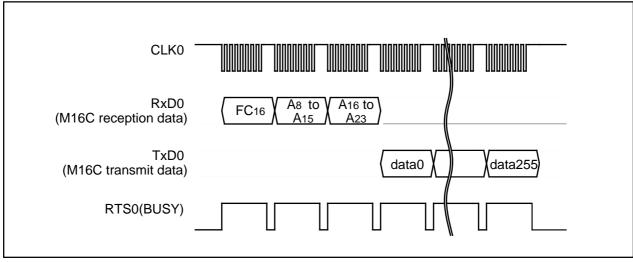


Figure 1.25.10. Timing for boot ROM area output



ID Check

This command checks the ID code. Execute the boot ID check command as explained here following.

- (1) Transfer the "F516" command code with the 1st byte.
- (2) Transfer addresses A₀ to A₇, A₈ to A₁₅ and A₁₆ to A₂₃ of the 1st byte of the ID code with the 2nd, 3rd and 4th bytes respectively.
- (3) Transfer the number of data sets of the ID code with the 5th byte.
- (4) The ID code is sent with the 6th byte onward, starting with the 1st byte of the code.

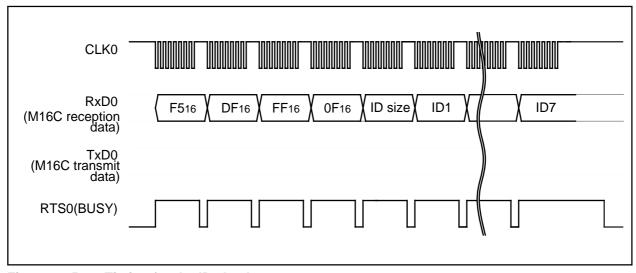


Figure 1.25.11. Timing for the ID check

ID Code

When the flash memory is not blank, the ID code sent from the peripheral units and the ID code written in the flash memory are compared to see if they match. If the codes do not match, the command sent from the peripheral units is not accepted. An ID code contains 8 bits of data. Area is, from the 1st byte, addresses 0FFFDF16, 0FFFE316, 0FFFEB16, 0FFFEF16, 0FFFF316, 0FFFF716 and 0FFFFB16. Write a program into the flash memory, which already has the ID code set for these addresses.

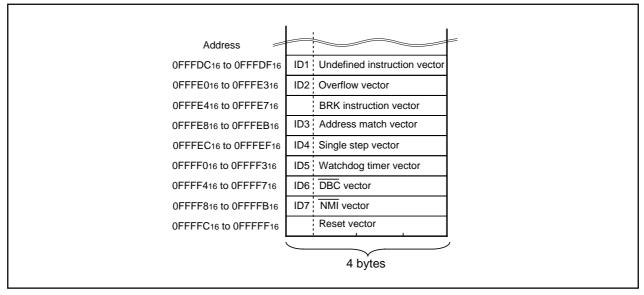


Figure 1.25.12. ID code storage addresses



Read Check Data

This command reads the check data that confirms that the write data, which was sent with the page program command, was successfully received.

- (1) Transfer the "FD16" command code with the 1st byte.
- (2) The check data (low) is received with the 2nd byte and the check data (high) with the 3rd.

To use this read check data command, first execute the command and then initialize the check data. Next, execute the page program command the required number of times. After that, when the read check command is executed again, the check data for all of the read data that was sent with the page program command during this time is read. Check data adds write data in 1 byte units and obtains the two's-compliment of the insignificant 2 bytes of the accumulated data.

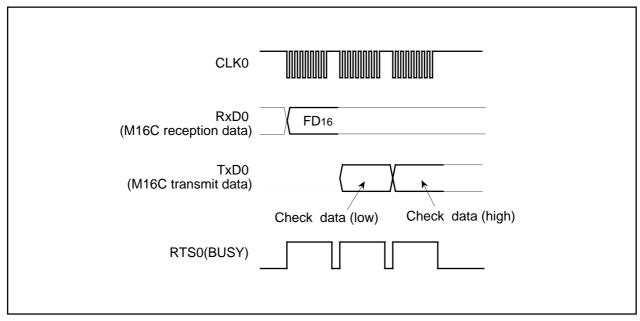


Figure 1.25.13. Timing for the read check data

Status Register (SRD)

The status register indicates operating status of the flash memory and status such as whether an erase operation or a program ended successfully or in error. It can be read by writing the read status register command (7016). Also, the status register is cleared by writing the clear status register command (5016). Table 1.25.2 gives the definition of each status register bit. After clearing the reset, the status register outputs "8016".

Table 1.25.2. Status register (SRD)

000011	0	Defini	inition	
SRD0 bits	Status name	"1"	"0"	
SR7 (bit7)	Sequencer status	Ready	Busy	
SR6 (bit6)	Reserved	-	-	
SR5 (bit5)	Erase status	Terminated in error	Terminated normally	
SR4 (bit4)	Program status	Terminated in error	Terminated normally	
SR3 (bit3)	Reserved	-	-	
SR2 (bit2)	Reserved	-	-	
SR1 (bit1)	Reserved	-	-	
SR0 (bit0)	Reserved	-	-	

Sequencer status (SR7)

After power-on, the sequencer status is set to 1(ready).

The sequencer status indicates the operating status of the device. This status bit is set to 0 (busy) during write or erase operation and is set to 1 upon completion of these operations.

Erase Status (SR5)

The erase status reports the operating status of the auto erase operation. If an erase error occurs, it is set to "1". When the erase status is cleared, it is set to "0".

Program Status (SR4)

The program status reports the operating status of the auto write operation. If a write error occurs, it is set to "1". When the program status is cleared, it is set to "0".



Status Register 1 (SRD1)

Status register 1 indicates the status of serial communications, results from ID checks and results from check sum comparisons. It can be read after the SRD by writing the read status register command (7016). Also, status register 1 is cleared by writing the clear status register command (5016).

Table 1.25.3 gives the definition of each status register 1 bit. "0016" is output when power is turned ON and the flag status is maintained even after the reset.

Table 1.25.3. Status register 1 (SRD1)

CDD4 bits	01-1	Def	finition		
SRD1 bits	Status name	"1"	"0"		
SR15 (bit7)	Boot update completed bit	Update completed	Not update		
SR14 (bit6)	Reserved	-	-		
SR13 (bit5)	Reserved	-	-		
SR12 (bit4)	Check sum match bit	Match	Mismatch		
SR11 (bit3)	ID check completed bits		verified		
SR10 (bit2)			ication mismatch		
(3.1.2)		10 Reserved 11 Verified			
		TT VEIII	ieu		
SR9 (bit1) Data receive time out		Time out	Normal operation		
SR8 (bit0)	Reserved	-	-		

Boot Update Completed Bit (SR15)

This flag indicates whether the control program was downloaded to the RAM or not, using the download function.

Check Sum Match Bit (SR12)

This flag indicates whether the check sum matches or not when a program, is downloaded for execution using the download function.

ID Check Completed Bits (SR11 and SR10)

These flags indicate the result of ID checks. Some commands cannot be accepted without an ID check.

Data Receive Time Out (SR9)

This flag indicates when a time out error is generated during data reception. If this flag is attached during data reception, the received data is discarded and the microcomputer returns to the command wait state.



Full Status Check

Results from executed erase and program operations can be known by running a full status check. Figure 1.25.14 shows a flowchart of the full status check and explains how to remedy errors which occur.

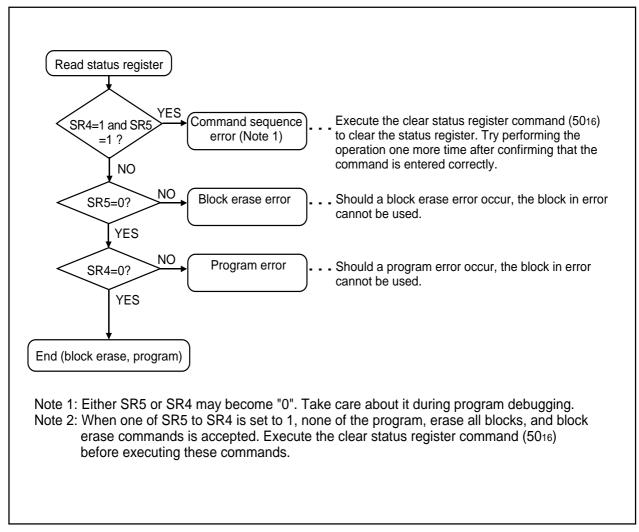


Figure 1.25.14. Full status check flowchart and remedial procedure for errors

Example Circuit Application for The Standard Serial I/O Mode 1

The below figure shows a circuit application for the standard serial I/O mode 1. Control pins will vary according to programmer, therefore see the peripheral unit manual for more information.

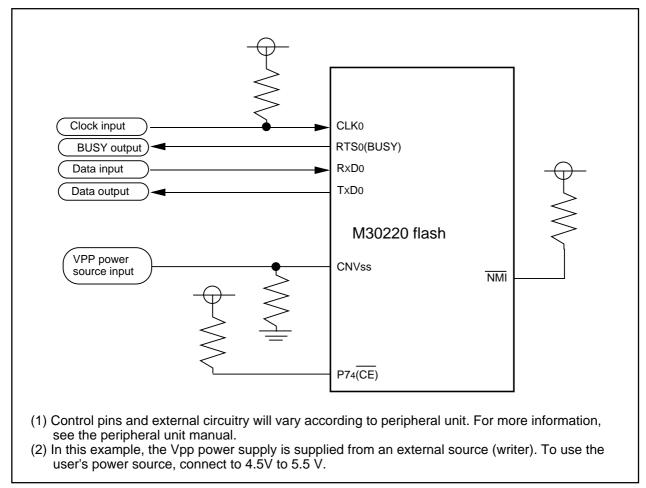


Figure 1.25.15. Example circuit application for the standard serial I/O mode 1

Overview of standard serial I/O mode 2 (clock asynchronized)

In standard serial I/O mode 2, software commands, addresses and data are input and output between the MCU and peripheral units (serial programer, etc.) using 2-wire clock-asynchronized serial I/O (UART0). Standard serial I/O mode 2 is engaged by releasing the reset with the P61 (CLK0) pin "L" level.

The TxDo pin is for CMOS output. Data transfer is in 8-bit units with LSB first, 1 stop bit and parity OFF. After the reset is released, connections can be established at 9,600 bps when initial communications (Figure 1.25.16) are made with a peripheral unit. However, this requires a main clock with a minimum 2 MHz input oscillation frequency. Baud rate can also be changed from 9,600 bps to 19,200, 38,400 or 57,600 bps by executing software commands. However, communication errors may occur because of the oscillation frequency of the main clock. If errors occur, change the main clock's oscillation frequency and the baud rate.

After executing commands from a peripheral unit that requires time to erase and write data, as with erase and program commands, allow a sufficient time interval or execute the read status command and check how processing ended, before executing the next command.

Data and status registers in memory can be read after transmitting software commands. Status, such as the operating state of the flash memory or whether a program or erase operation ended successfully or not, can be checked by reading the status register. Here following are explained initial communications with peripheral units, how frequency is identified and software commands.

Initial communications with peripheral units

After the reset is released, the bit rate generator is adjusted to 9,600 bps to match the oscillation frequency of the main clock, by sending the code as prescribed by the protocol for initial communications with peripheral units (Figure 1.25.16).

- (1) Transmit "B016" from a peripheral unit. If the oscillation frequency input by the main clock is 10 MHz, the MCU with internal flash memory outputs the "B016" check code. If the oscillation frequency is anything other than 10 MHz, the MCU does not output anything.
- (2) Transmit "0016" from a peripheral unit 16 times. (The MCU with internal flash memory sets the bit rate generator so that "0016" can be successfully received.)
- (3) The MCU with internal flash memory outputs the "B016" check code and initial communications end successfully *1. Initial communications must be transmitted at a speed of 9,600 bps and a transfer interval of a minimum 15 ms. Also, the baud rate at the end of initial communications is 9,600 bps.
- *1. If the peripheral unit cannot receive "B016" successfully, change the oscillation frequency of the main clock.

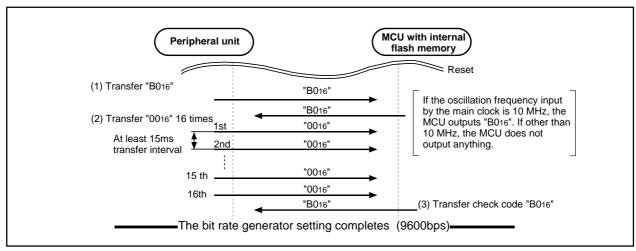


Figure 1.25.16. Peripheral unit and initial communication



How frequency is identified

When "0016" data is received 16 times from a peripheral unit at a baud rate of 9,600 bps, the value of the bit rate generator is set to match the operating frequency (2 - 10 MHz). The highest speed is taken from the first 8 transmissions and the lowest from the last 8. These values are then used to calculate the bit rate generator value for a baud rate of 9,600 bps.

Baud rate cannot be attained with some operating frequencies. Table 1.25.4 gives the operation frequency and the baud rate that can be attained for.

Table 1.25.4 Operation frequency and the baud rate

Operation frequency (MHz)	Baud rate 9,600bps	Baud rate 19,200bps	Baud rate 38,400bps	Baud rate 57,600bps
10MHz	V	V	_	√
8MHz	$\sqrt{}$	V	_	√
7.3728MHz	$\sqrt{}$	V	$\sqrt{}$	√
6MHz	$\sqrt{}$	V	$\sqrt{}$	_
5MHz	V	V	_	_
4.5MHz	V	V	_	√
4.194304MHz	V	V	V	_
4MHz	$\sqrt{}$	V	_	_
3.58MHz	V	V	√	√
3MHz	V	V	√	_
2MHz	V	_	_	_

^{√:} Communications possible



^{-:} Communications not possible

Software Commands

Table 1.25.5 lists software commands. In the standard serial I/O mode 2, erase operations, programs and reading are controlled by transferring software commands via the RxDo pin. Standard serial I/O mode 2 adds four transmission speed commands - 9,600, 19,200, 38,400 and 57,600 bps - to the software commands of standard serial I/O mode 1. Software commands are explained here below.

Table 1.25.5. Software commands (Standard serial I/O mode 2)

	Control command	1st byte transfer	2nd byte	3rd byte	4th byte	5th byte	6th byte		When ID is not verified
1	Page read	FF ₁₆	Address (middle)	Address (high)	Data output	Data output	Data output	Data output to 259th byte	Not acceptable
2	Page program	41 ₁₆	Address (middle)	Address (high)	Data input	Data input	Data input	Data input to 259th byte	Not acceptable
3	Block erase	20 ₁₆	Address (middle)	Address (high)	D0 ₁₆				Not acceptable
4	Erase all unlocked blocks	A7 ₁₆	D0 ₁₆						Not acceptable
5	Read status register	7016	SRD output	SRD1 output					Acceptable
6	Clear status register	5016							Not acceptable
7	ID check function	F5 ₁₆	Address (low)	Address (middle)	Address (high)	ID size	ID1	To ID7	Acceptable
8	Download function	FA ₁₆	Size (low)	Size (high)	Check- sum	Data input	To required number of times		Not acceptable
9	Version data output function	FB ₁₆	Version data output	Version data output	Version data output	Version data output	Version data output	Version data output to 9th byte	Acceptable
10	Boot ROM area output function	FC ₁₆	Address (middle)	Address (high)	Data output	Data output	Data output	Data output to 259th byte	Not acceptable
11	Read check data	FD ₁₆	Check data (low)	Check data (high)					Not acceptable
12	Baud rate 9600	B0 ₁₆	B0 ₁₆						Acceptable
13	Baud rate 19200	B1 ₁₆	B1 ₁₆						Acceptable
14	Baud rate 38400	B2 ₁₆	B2 ₁₆						Acceptable
15	Baud rate 57600	B3 ₁₆	B3 ₁₆						Acceptable

Note 1: Shading indicates transfer from flash memory microcomputer to peripheral unit. All other data is transferred from the peripheral unit to the flash memory microcomputer.

Note 2: SRD refers to status register data. SRD1 refers to status register 1 data.

Note 3: All commands can be accepted when the flash memory is totally blank.



Page Read Command

This command reads the specified page (256 bytes) in the flash memory sequentially one byte at a time. Execute the page read command as explained here following.

- (1) Transfer the "FF16" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, data (D0–D7) for the page (256 bytes) specified with addresses A8 to A23 will be output sequentially from the smallest address first.

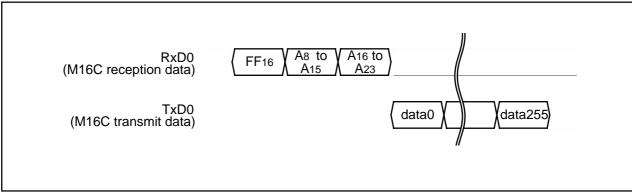


Figure 1.25.17. Timing for page read

Read Status Register Command

This command reads status information. When the "7016" command code is sent with the 1st byte, the contents of the status register (SRD) specified with the 2nd byte and the contents of status register 1 (SRD1) specified with the 3rd byte are read.

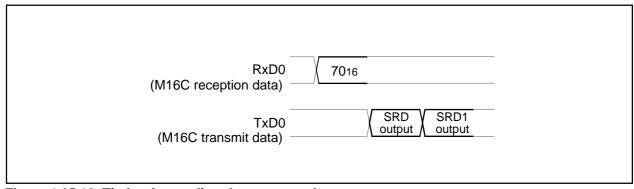


Figure 1.25.18. Timing for reading the status register



Clear Status Register Command

This command clears the bits (SR4–SR5) which are set when the status register operation ends in error. When the "5016" command code is sent with the 1st byte, the aforementioned bits are cleared.

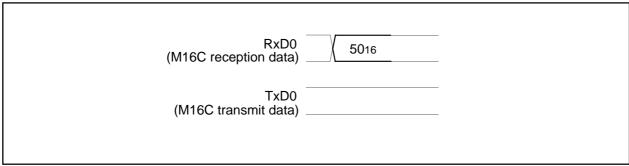


Figure 1.25.19. Timing for clearing the status register

Page Program Command

This command writes the specified page (256 bytes) in the flash memory sequentially one byte at a time. Execute the page program command as explained here following.

- (1) Transfer the "4116" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, as write data (D0–D7) for the page (256 bytes) specified with addresses A8 to A23 is input sequentially from the smallest address first, that page is automatically written.

The result of the page program can be known by reading the status register. For more information, see the section on the status register.

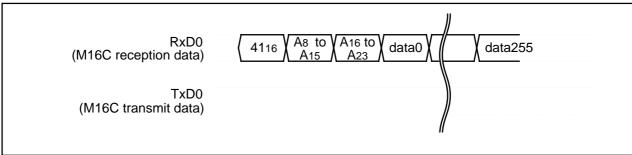


Figure 1.25.20. Timing for the page program



Block Erase Command

This command erases the data in the specified block. Execute the block erase command as explained here following.

- (1) Transfer the "2016" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) Transfer the verify command code "D016" with the 4th byte. With the verify command code, the erase operation will start for the specified block in the flash memory. Write the optional even address of the specified block for addresses A8 to A23.

After block erase ends, the result of the block erase operation can be known by reading the status register. For more information, see the section on the status register.

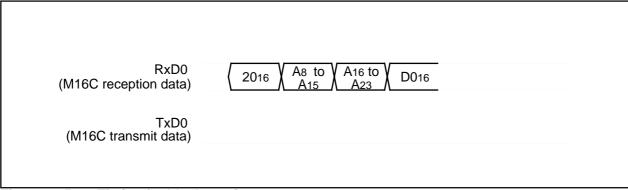


Figure 1.25.21. Timing for block erasing

Erase All Blocks Command

This command erases the content of all blocks. Execute the erase all blocks command as explained here following.

- (1) Transfer the "A716" command code with the 1st byte.
- (2) Transfer the verify command code "D016" with the 2nd byte. With the verify command code, the erase operation will start and continue for all blocks in the flash memory.

The result of the erase operation can be known by reading the status register.

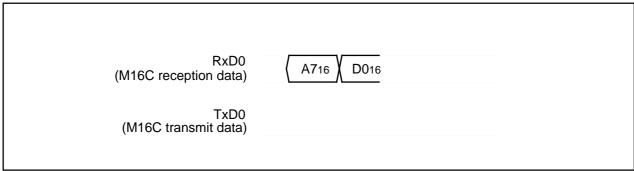


Figure 1.25.22. Timing for erasing all blocks



Download Command

This command downloads a program to the RAM for execution. Execute the download command as explained here following.

- (1) Transfer the "FA16" command code with the 1st byte.
- (2) Transfer the program size with the 2nd and 3rd bytes.
- (3) Transfer the check sum with the 4th byte. The check sum is added to all data sent with the 5th byte onward.
- (4) The program to execute is sent with the 5th byte onward.

When all data has been transmitted, if the check sum matches, the downloaded program is executed. The size of the program will vary according to the internal RAM.

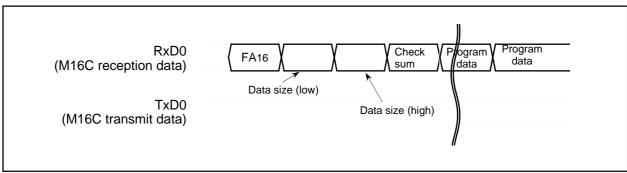


Figure 1.25.23. Timing for download



Version Information Output Command

This command outputs the version information of the control program stored in the boot area. Execute the version information output command as explained here following.

- (1) Transfer the "FB16" command code with the 1st byte.
- (2) The version information will be output from the 2nd byte onward. This data is composed of 8 ASCII code characters.

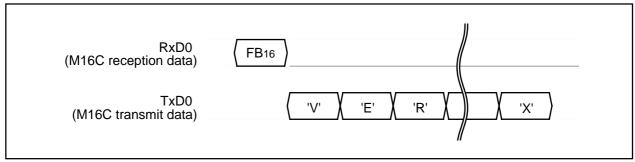


Figure 1.25.24. Timing for version information output

Boot ROM Area Output Command

This command outputs the control program stored in the boot ROM area in one page blocks (256 bytes). Execute the boot ROM area output command as explained here following.

- (1) Transfer the "FC16" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, data (D0–D7) for the page (256 bytes) specified with addresses A8 to A23 will be output sequentially from the smallest address first.

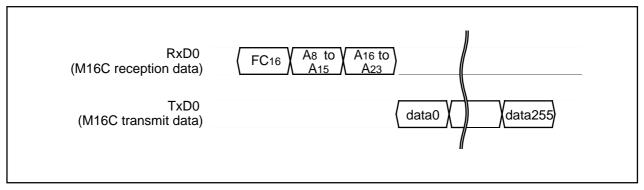


Figure 1.25.25. Timing for boot ROM area output

ID Check

This command checks the ID code. Execute the boot ID check command as explained here following.

- (1) Transfer the "F516" command code with the 1st byte.
- (2) Transfer addresses A₀ to A₇, A₈ to A₁₅ and A₁₆ to A₂₃ of the 1st byte of the ID code with the 2nd, 3rd and 4th bytes respectively.
- (3) Transfer the number of data sets of the ID code with the 5th byte.
- (4) The ID code is sent with the 6th byte onward, starting with the 1st byte of the code.

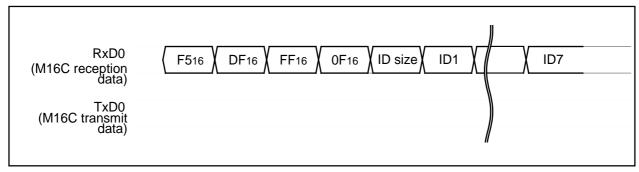


Figure 1.25.26. Timing for the ID check

ID Code

When the flash memory is not blank, the ID code sent from the peripheral units and the ID code written in the flash memory are compared to see if they match. If the codes do not match, the command sent from the peripheral units is not accepted. An ID code contains 8 bits of data. Area is, from the 1st byte, addresses 0FFFDF16, 0FFFE316, 0FFFEB16, 0FFFEF16, 0FFFF316, 0FFFF716 and 0FFFFB16. Write a program into the flash memory, which already has the ID code set for these addresses.

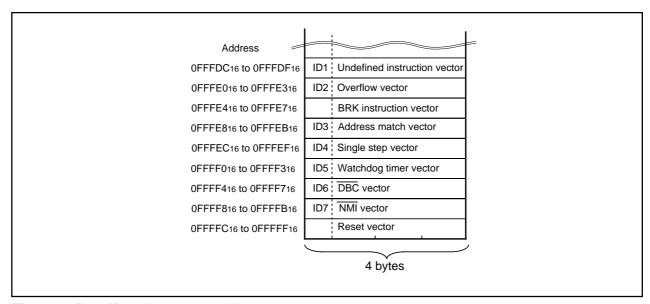


Figure 1.25.27. ID code storage addresses



Read Check Data

This command reads the check data that confirms that the write data, which was sent with the page program command, was successfully received.

- (1) Transfer the "FD16" command code with the 1st byte.
- (2) The check data (low) is received with the 2nd byte and the check data (high) with the 3rd.

To use this read check data command, first execute the command and then initialize the check data. Next, execute the page program command the required number of times. After that, when the read check command is executed again, the check data for all of the read data that was sent with the page program command during this time is read. Check data adds write data in 1 byte units and obtains the two's-compliment of the insignificant 2 bytes of the accumulated data.

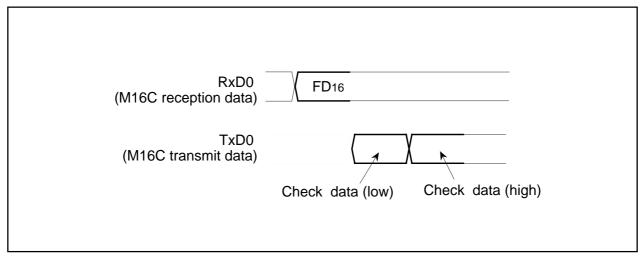


Figure 1.25.28. Timing for the read check data

Baud Rate 9600

This command changes baud rate to 9,600 bps. Execute it as follows.

- (1) Transfer the "B016" command code with the 1st byte.
- (2) After the "B016" check code is output with the 2nd byte, change the baud rate to 9,600 bps.

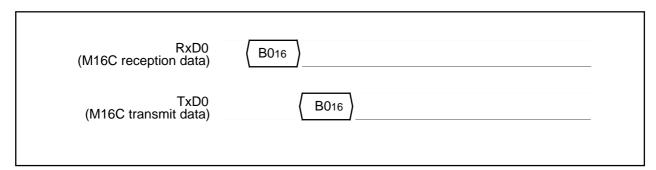


Figure 1.25.29. Timing of baud rate 9600



Baud Rate 19200

This command changes baud rate to 19,200 bps. Execute it as follows.

- (1) Transfer the "B116" command code with the 1st byte.
- (2) After the "B116" check code is output with the 2nd byte, change the baud rate to 19,200 bps.



Figure 1.25.30. Timing of baud rate 19200

Baud Rate 38400

This command changes baud rate to 38,400 bps. Execute it as follows.

- (1) Transfer the "B216" command code with the 1st byte.
- (2) After the "B216" check code is output with the 2nd byte, change the baud rate to 38,400 bps.

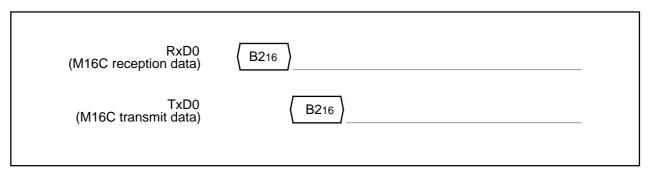


Figure 1.25.31. Timing of baud rate 38400

Baud Rate 57600

This command changes baud rate to 57,600 bps. Execute it as follows.

- (1) Transfer the "B316" command code with the 1st byte.
- (2) After the "B316" check code is output with the 2nd byte, change the baud rate to 57,600 bps.

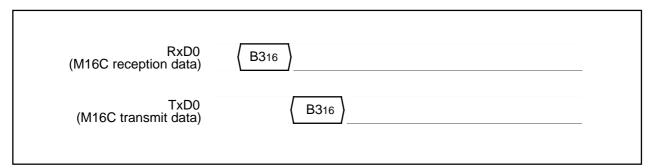


Figure 1.25.32. Timing of baud rate 57600



Example Circuit Application for The Standard Serial I/O Mode 2

The below figure shows a circuit application for the standard serial I/O mode 2.

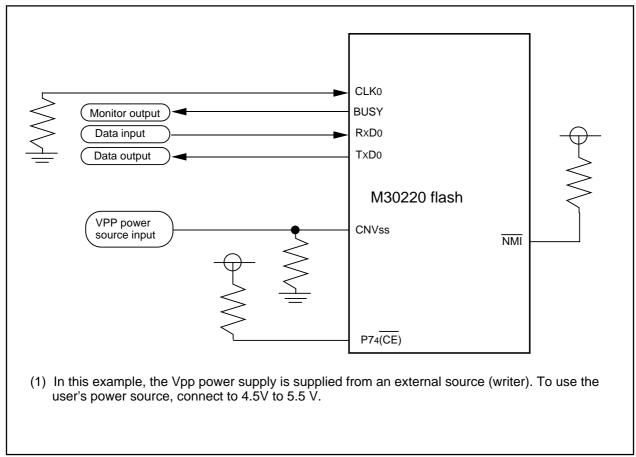


Figure 1.25.23. Example circuit application for the standard serial I/O mode 2

Absolute maximum ratings

Symbol		Parameter	Condition	Rated value	Unit
Vcc	Supply v	voltage	Vcc=AVcc	- 0.3 to 6.5	V
AVcc	Analog s	nalog supply voltage		- 0.3 to 6.5	V
Vı	Input voltage	RESET, VREF, XIN P00 to P07, P10 to P17, P20 to P27, P30 to P35,P40 to P47, P50 to P57, P60 to P67,P72 to P77, P80 to P87, P90 to P97, P100 to P107, P110 to P117, P120 to P127, P130 to P132 (Mask ROM version CNVss)		-0.3 to Vcc+0.3	V
		VL1		- 0.3 to VL2	
		VL2		VL1 to VL3	
		VL3		VL2 to 6.5	
		P70, P71, C1, C2 (Flash memory version CNVss)		- 0.3 to 6.5	
Vo	Output voltage	P10 to P17, P20 to P27, P30 to P35, P40 to P47, P50 to P57, P60 to P67, P72 to P76, P80 to P87, P90 to P97, P130 to P132, XOUT		- 0.3 to Vcc+0.3	V
	,	P0o to P07, P10o to P107,	When output port	- 0.3 to Vcc	
		P110 to P117, P120 to P127,	When segment otput	- 0.3 to VL3	
		P70, P71		- 0.3 to 6.5	
Pd	Power d	lissipation	Ta = 25 °C	300	mW
Topr	Operatir	ng ambient temperature (Note)		25±5	°C
Tstg	Storage	temperature		- 40 to 150	°C

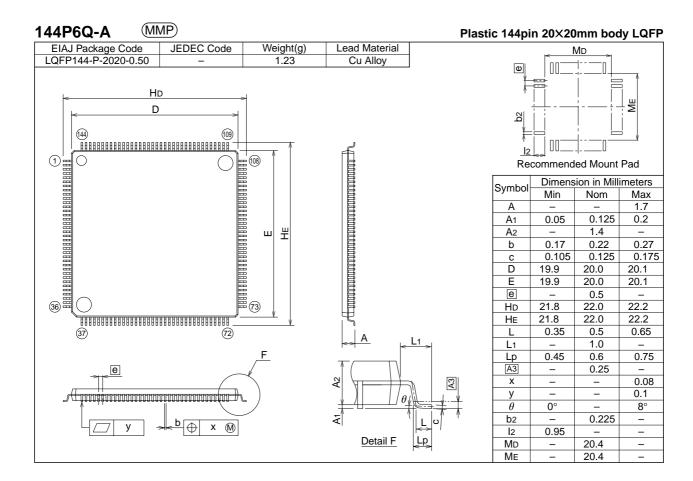
Note: It is a value in flash memory mode. Other parameter becomes same as a value in microcomputer mode.

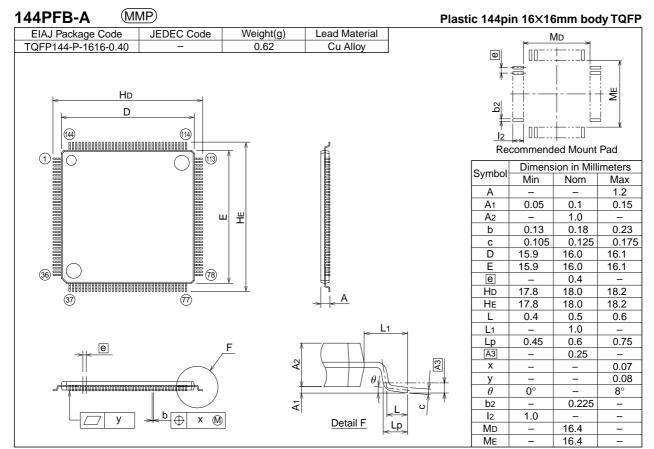


DC electrical characteristics

(referenced to VCC = 4.5V to 5.5V at Ta = 25°C unless otherwise specified)

Courada ad	Developates	Complision	Ra	1.1		
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
IPP1	VPP power supply current (at read)	VPP=VCC			100	μΑ
IPP2	VPP power supply current (at program)	VPP=Vcc			60	mA
IPP3	VPP power supply current (at erase)	VPP=VCC			30	mΑ
VPP	VPP power supply voltage		4.5		5.5	V







REVISION HISTORY

M30220 GROUP DATA SHEET

Rev. Date Description	
Page Summary	
H 01/12/17 1 Features are partly revised. Applications is partly added. 1 Page numbers of Table of Contents are partly revised. 2 Figure 1.1.1 is partly revised. 5 Figure 1.1.1 is partly revised. 5 Figure 1.1.1 is partly revised. 6 Pin description is partly revised. 7 Figure 1.1.4 is partly revised. 8 Figure 1.4.1 is partly revised. 9 Pin description is partly revised. 12 Figure 1.6.1 is partly revised. 13 Figure 1.6.3 is partly revised. 14 Figure 1.7.2 is partly revised. Note is added. 15 Figure 1.7.2 is partly revised. Note 2 is added. 16 Figure 1.7.3 is partly revised. Note 2 is added. 17 Figure 1.7.3 is partly revised. Note 3 is partly revised. 18 Processor mode register 0 in Figure 1.8.1 is partly revised. 19 Explanation of "Wait Mode" is partly revised. 20 Explanation of "Wait Mode" is partly revised. 21 Explanation of "Saving Registers is" partly revised. 22 Explanation of "Saving Registers is" partly revised. 23 Explanation of "Key Input Interrupt" is partly revised. 24 Figure 1.10.2 is partly revised. 25 Explanation of "Key Input Interrupt" is partly revised. 26 Explanation of "Key Input Interrupt" is partly revised. 27 Figure 1.10.13 is partly revised. 28 Explanation of "(3) The NMI interrupt" is partly revised. 29 Explanation of "(3) The NMI interrupt" is partly revised. 29 Explanation of "(1) Interrupt factors" is partly revised. 20 Explanation of "(1) Interrupt factors" is partly revised. 29 Explanation of "(1) Interrupt factors" is partly revised. 20 Explanation of "(1) Interrupt factors" is partly revised. 30 Figure 1.13.1 is partly revised. 31 Figure 1.13.1 is partly revised. 32 Figure 1.13.1 is partly revised. 33 Figure 1.13.1 is partly revised. 34 Figure 1.14.2 and Figure 1.14.2 and Figure 1.15.4 is partly revised. 35 Figure 1.13.1 is partly revised. 36 Figure 1.13.1 is partly revised. 37 Figure 1.13.1 is partly revised. 38 Figure 1.16.2 is partly revised. 39 Explanation of "CD Dirive Control Circuit" is partly revised. 40 Explanation of "Sample and hold" is partly revised. 41 Figure 1.16.3 is	vised. revised. Note 8 is partly re- coartly revised. lote is partly revised. d. partly revised. Note is added. y revised. Note is added. sed. Note is added. vised.



REVISION HISTORY

M30220 GROUP DATA SHEET

Rev.	Date		Description
		Page	Summary
H	01/12/17	149 150 151 153 153 154 158 163 164 168-170 171 172 173 177 178 182 183 186 187 191 193 195 200 205 207 209 214-215 216	Table 1.22.1 is partly revised. Explanation of "Flash Memory" is partly revised. Figure 1.22.1 is partly revised. Explanation of "Block Address" is partly revised. Explanation of "Writing in the user ROM area" is partly revised. Table 1.23.1 is partly revised. Note 4 is partly revised. Figure 1.23.5 is partly revised. Explanation of "ROM code protect function" is partly revised. Pin description (Flash memory standard serial I/O mode) is partly revised. Figure 1.25.1 is partly revised. Explanation of "Page Read Command" is partly revised. Explanation of "Block Erase Command" is partly revised. Explanation of "Boot ROM Area Output Command" is partly revised. Explanation of "Page Read Command" is partly revised. Explanation of "Boot ROM Area Output Command" is partly revised. Explanation of "Block Erase Command" is partly revised. Explanation of "Block Erase Command" is partly revised. Explanation of "Block Erase Command" is partly revised.



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